

Metalorganic Vapour Phase Epitaxy (MOVPE) of Nitrides and III-V Nano-heterostructures

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Outline

- Heterostructures
- MOVPE principle
- Reactor types
- In situ monitoring
- GaN epitaxy challenges
- Nanoheterostructure epitaxy (in FZU)

Compound semiconductors and heterostructures

Elements used in semiconductors

First, germanium and afterwards silicon were discovered to have semiconductor properties

	II.B	III.A	IV.A	V.A	VI.A
2		B	C	N	O
3		Al	Si	P	S
4	Zn	Ga	Ge	As	Se
5	Cd	In	Sn	Sb	Te
6	Hg	Tl	Pb	Bi	Po

Elements used in semiconductors

Later, in 60-ties and 70-ties also III-V semiconductors were prepared also in layered structures (so called heterostructures)

	II.B	III.A	IV.A	V.A	VI.A
2		B	C	N	O
3		Al	Si	P	S
4	Zn	Ga	Ge	As	Se
5	Cd	In	Sn	Sb	Te
6	Hg	Tl	Pb	Bi	Po

Elements used in semiconductors

II-VI semiconductors were discovered approx ten years later

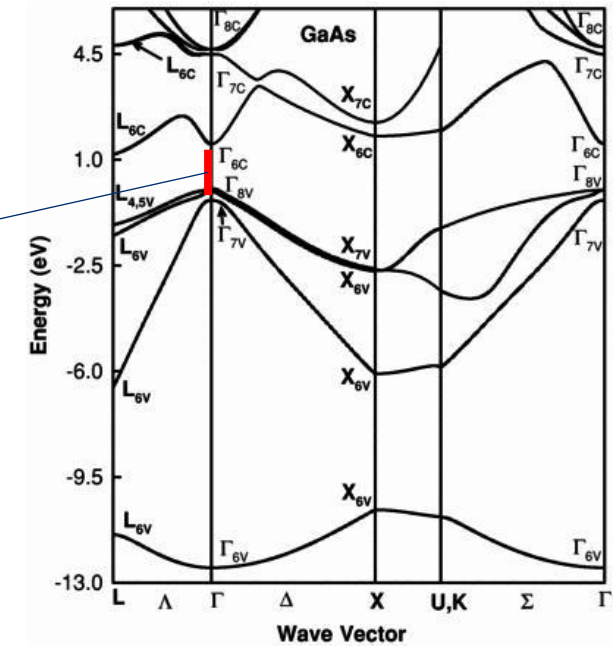
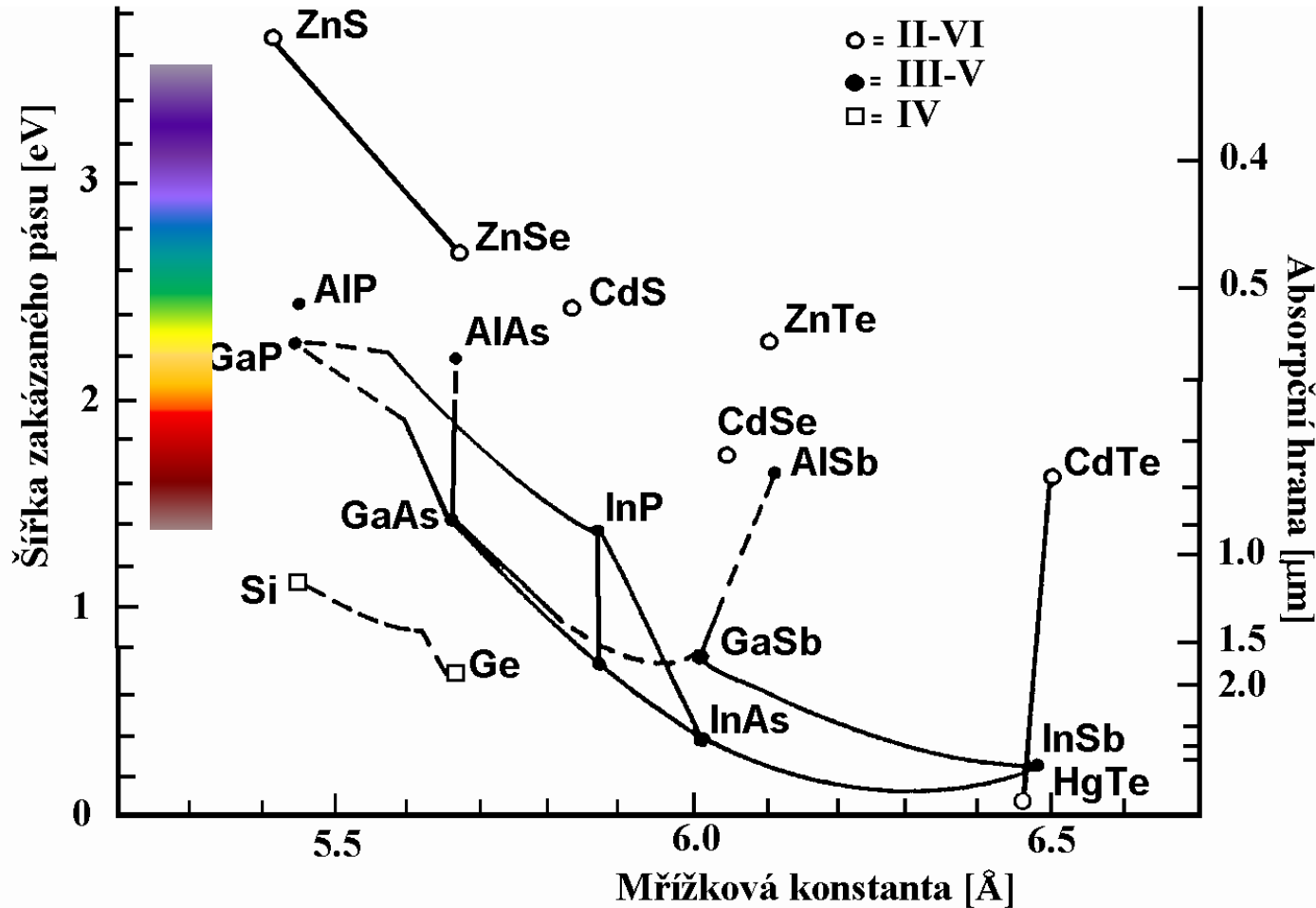
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3		Al	Si	P	S
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6	Hg	Tl	Pb	Bi	Po

Elements used in semiconductors

Finally, nowadays semiconductors employ also the small atoms in the first row with strong bounds and large band gaps

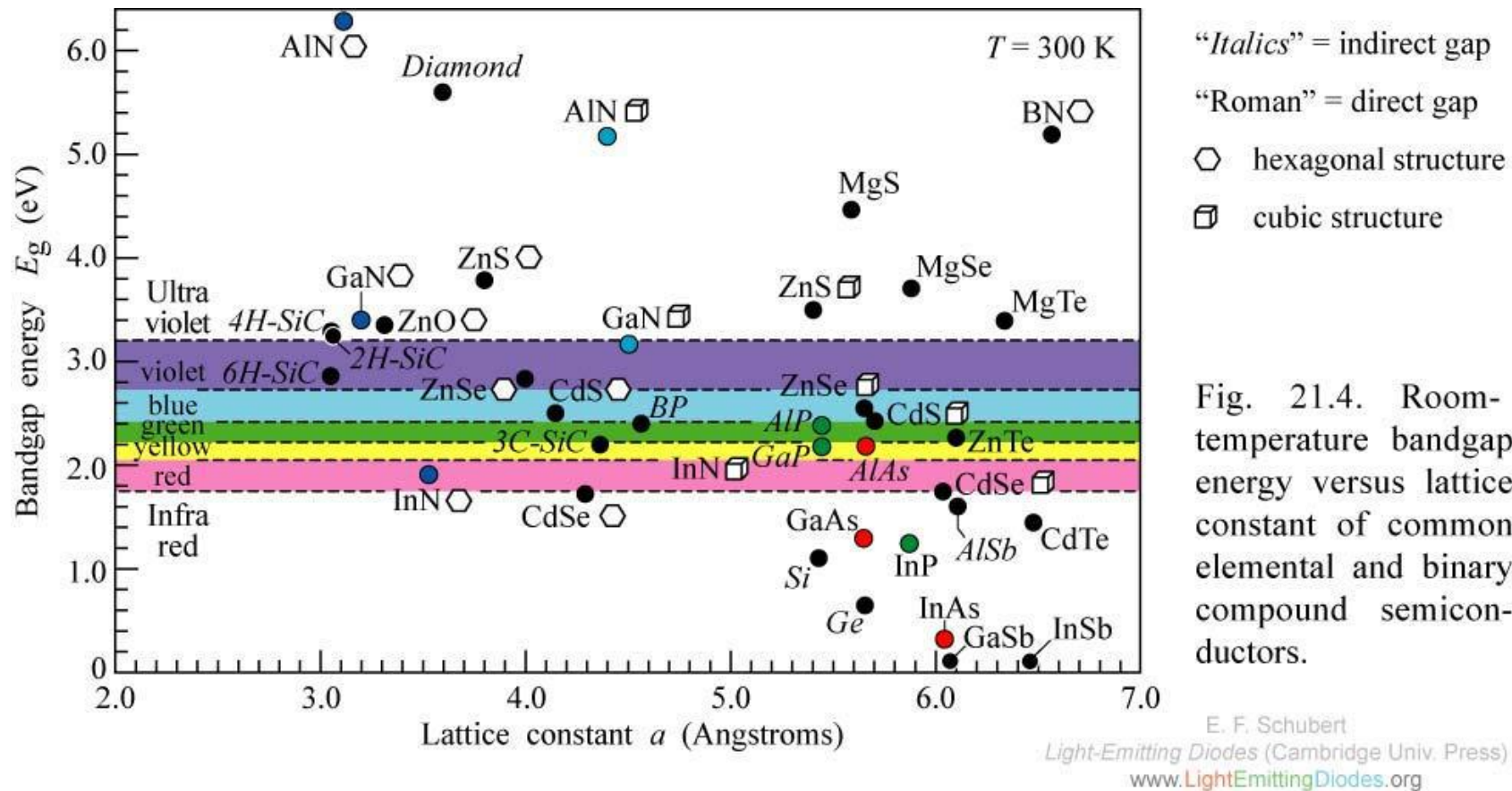
	II.B	III.A	IV.A	V.A	VI.A
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3		Al	Si	P	S
4	Zn	Ga	Ge	As	Se
5	Cd	In	Sn	Sb	Te
6	Hg	Tl	Pb	Bi	Po

Older types of binary and ternary compound semiconductors



cond. alloys – dashed lines represents
s since only semiconductors with similar

Binary and ternary compound semiconductors

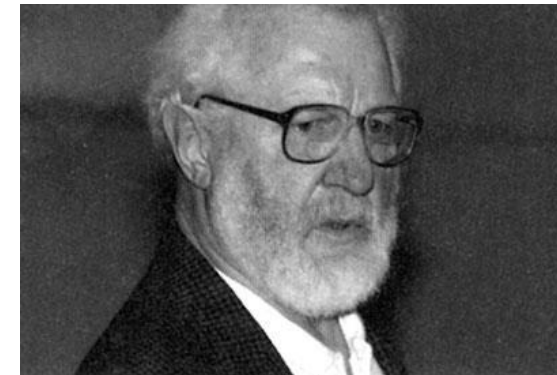
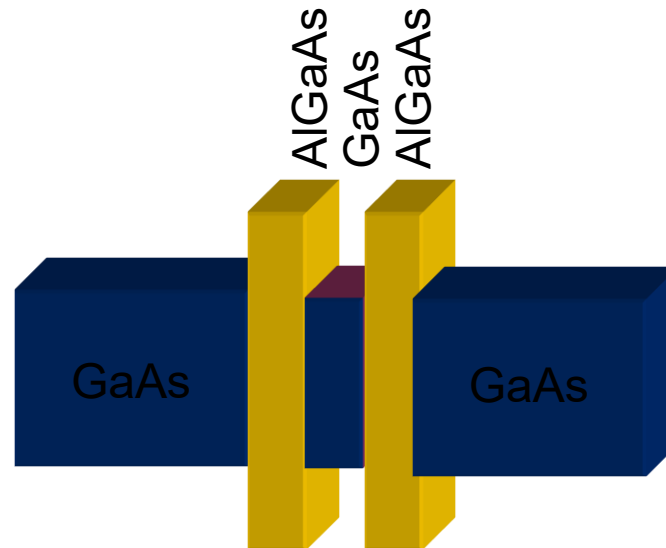


Many semiconductors are still missing in this graph .

AlGaAs/GaAs double heterosructures



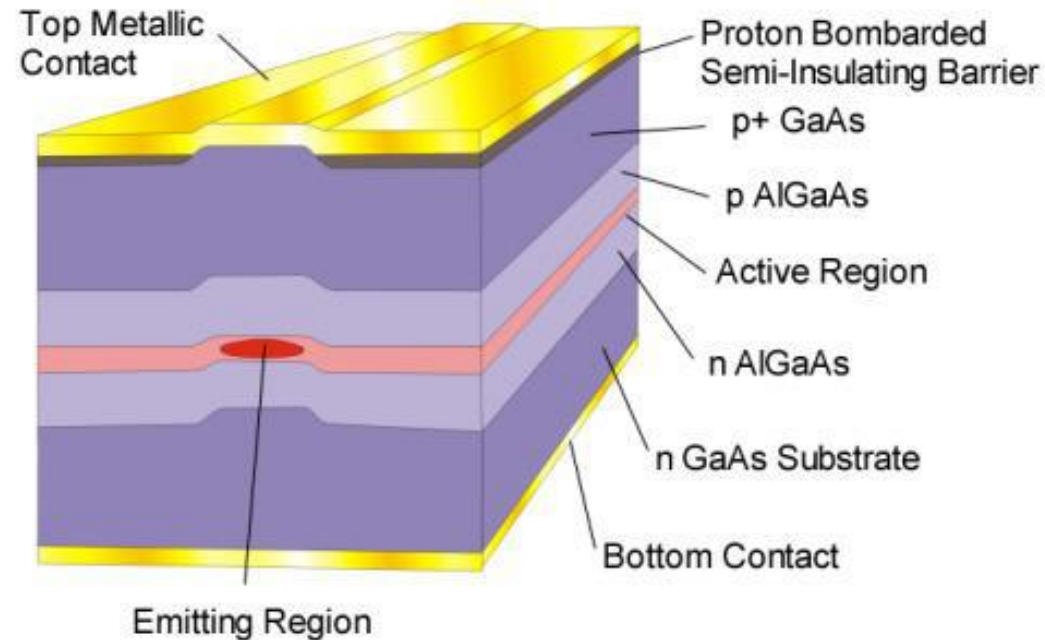
Žores Aljorov



Herbert Kroemer

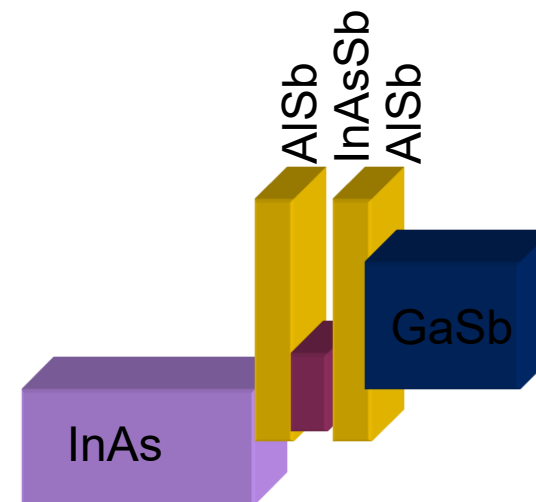
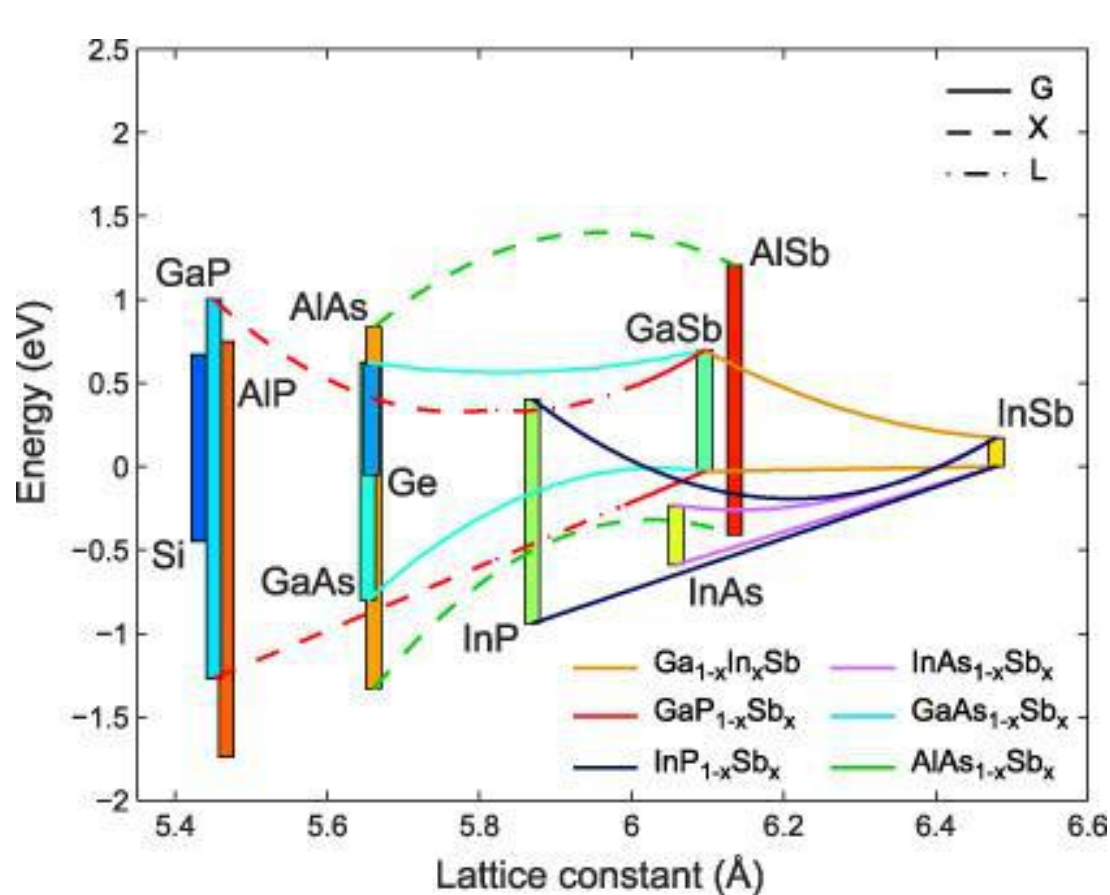
The first heterostructure was designed Ž. Alfjorov and H. Kroemer. They succeeded to substantially increased emission intensity and prepared first laser diodes. **Nobel Prize**

Separate confinement of electrons and photons



Separate confinement of electrons and photons
– another increase of emission intensity of laser diodes

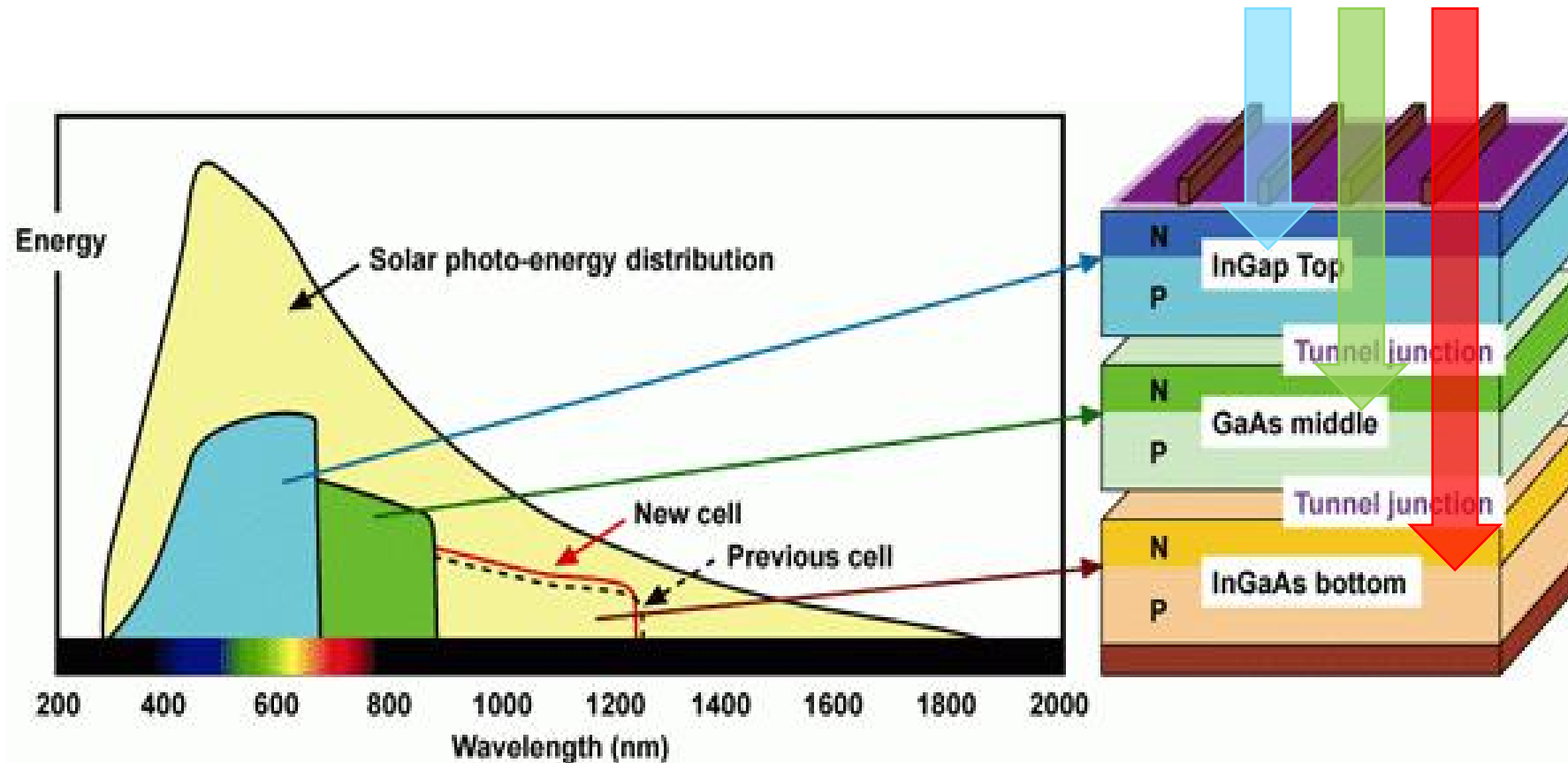
Binary and ternary compound semiconductors



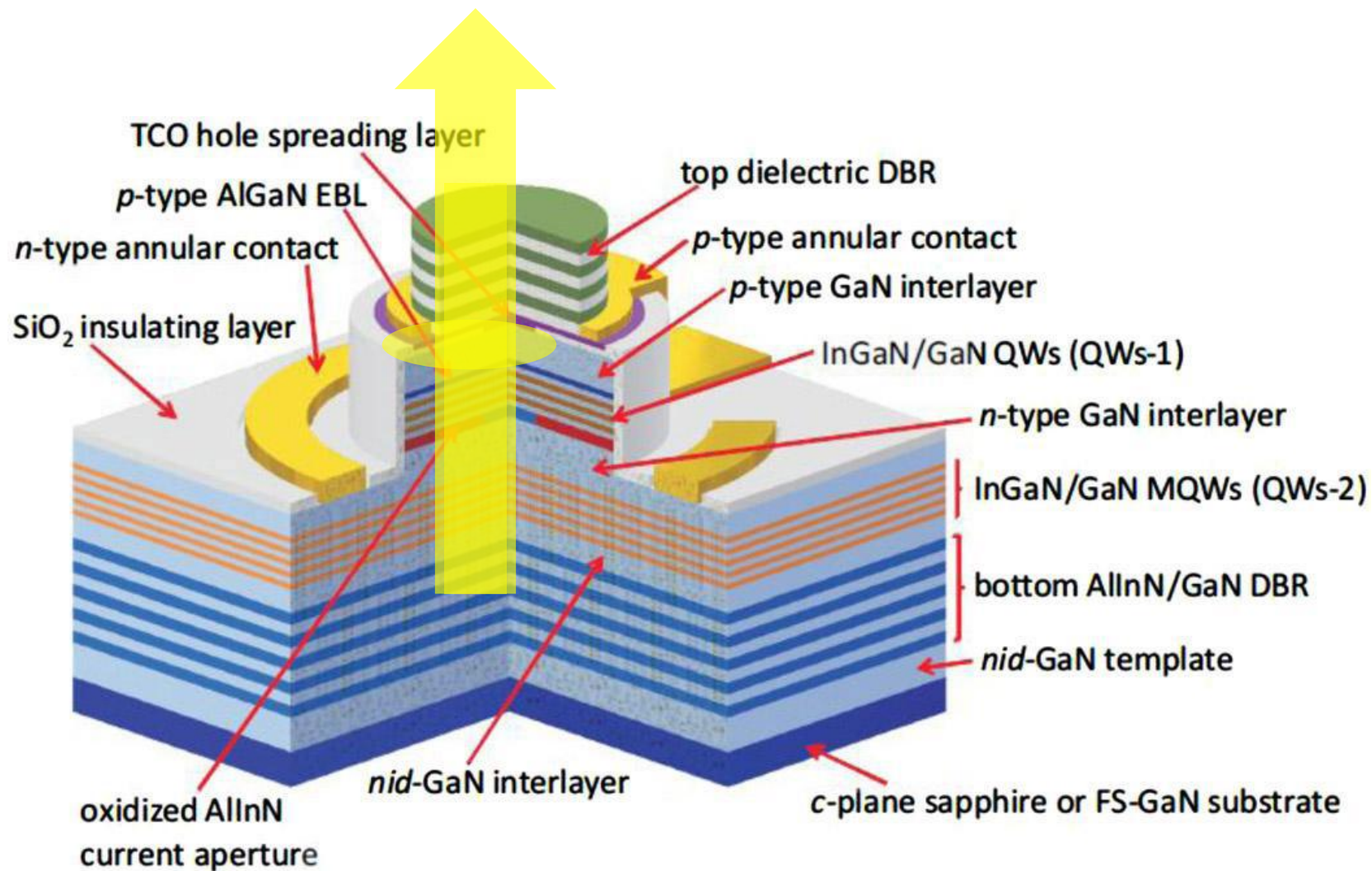
Semiconductors is a kind of toy for technologist: a set of bricks from which you can built functional heterostructure

To design properly heterostructure with required properties you have to know the properties of bricks: position of conduction and valence band, lattice parameter, polarization, effective masses...

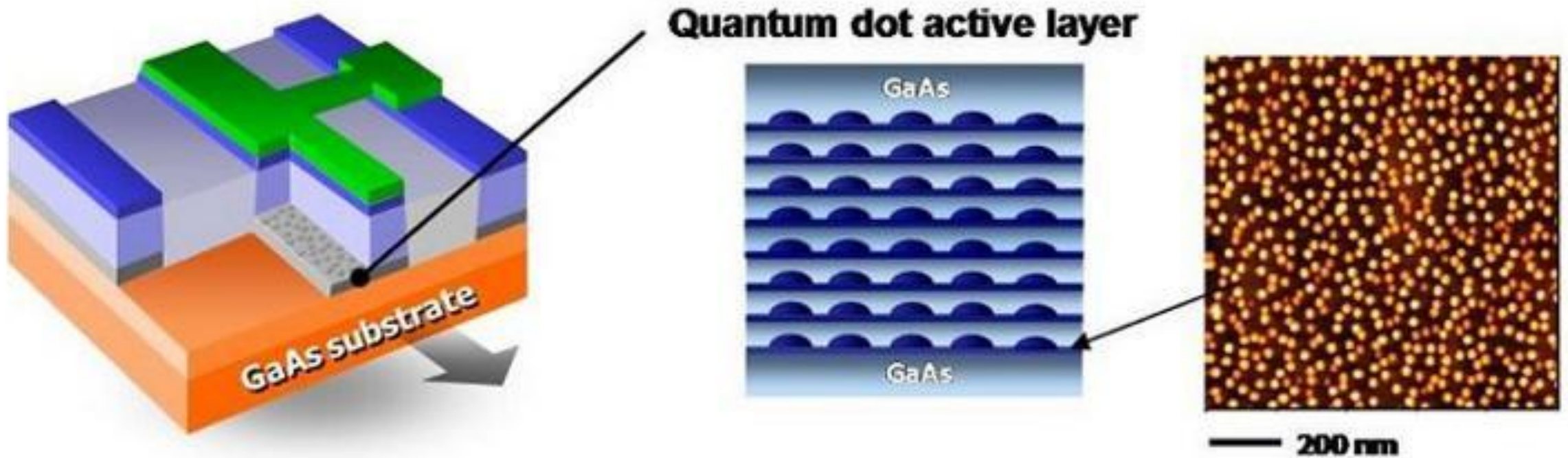
There are many other possibilities for heterostructure design and their applications such as: **Tandem solar cells**



Blue VCSEL structure



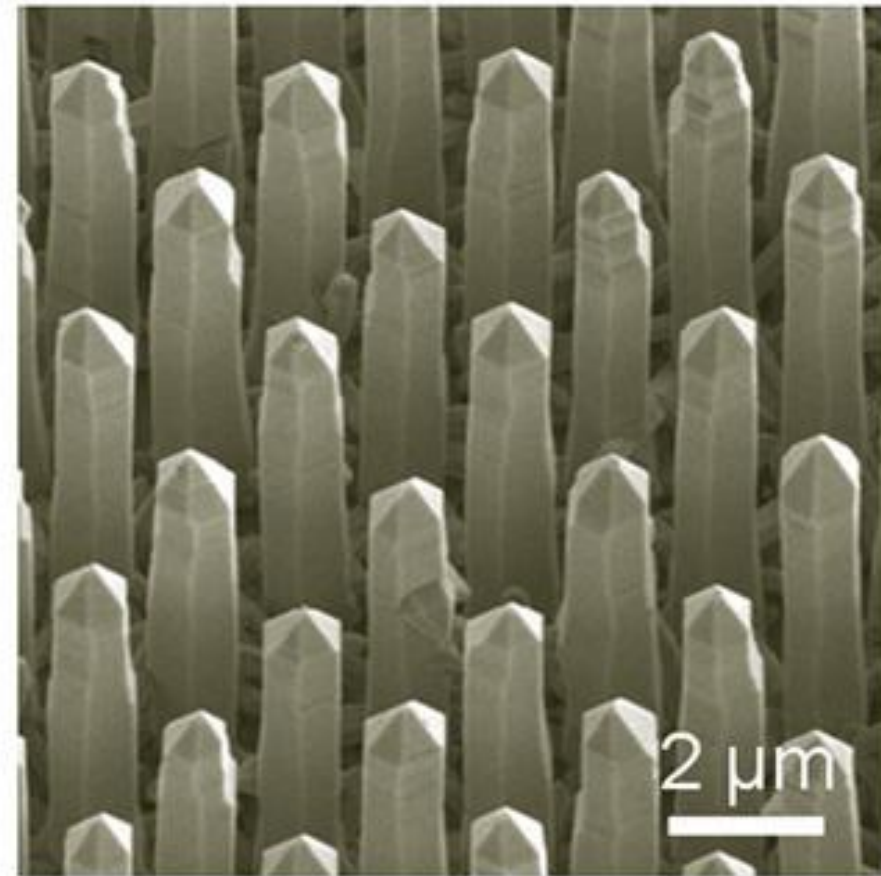
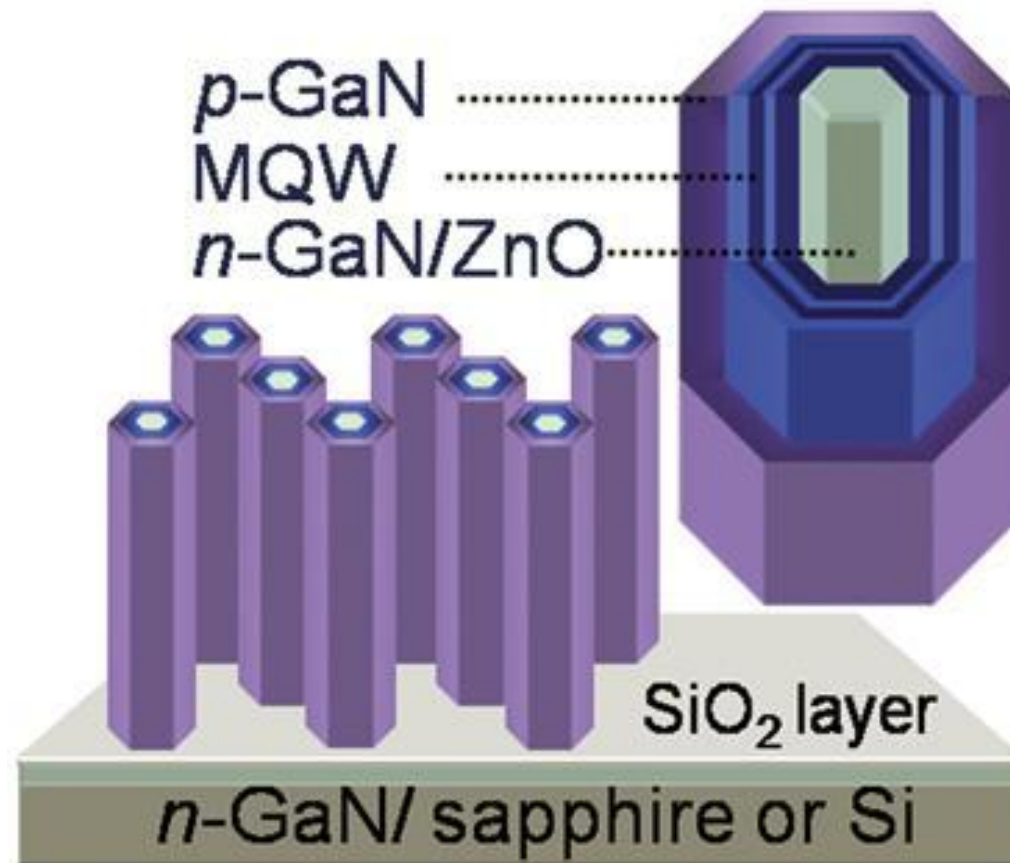
Structures with quantum dots



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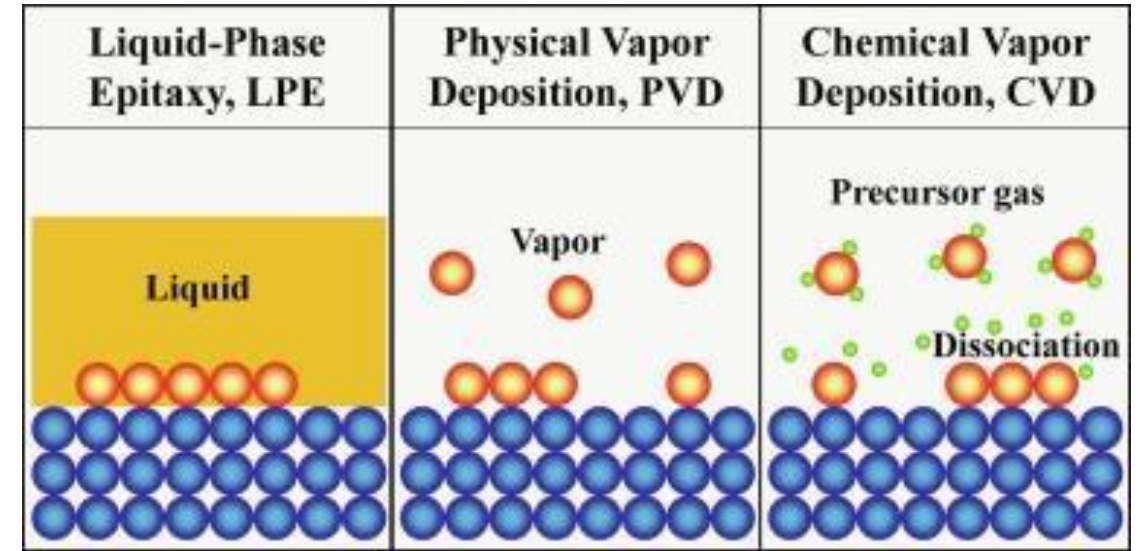
Sofisticated „core-shell“ structures



A growth of heterostructures is enabled by epitaxy

Many epitaxial techniques:

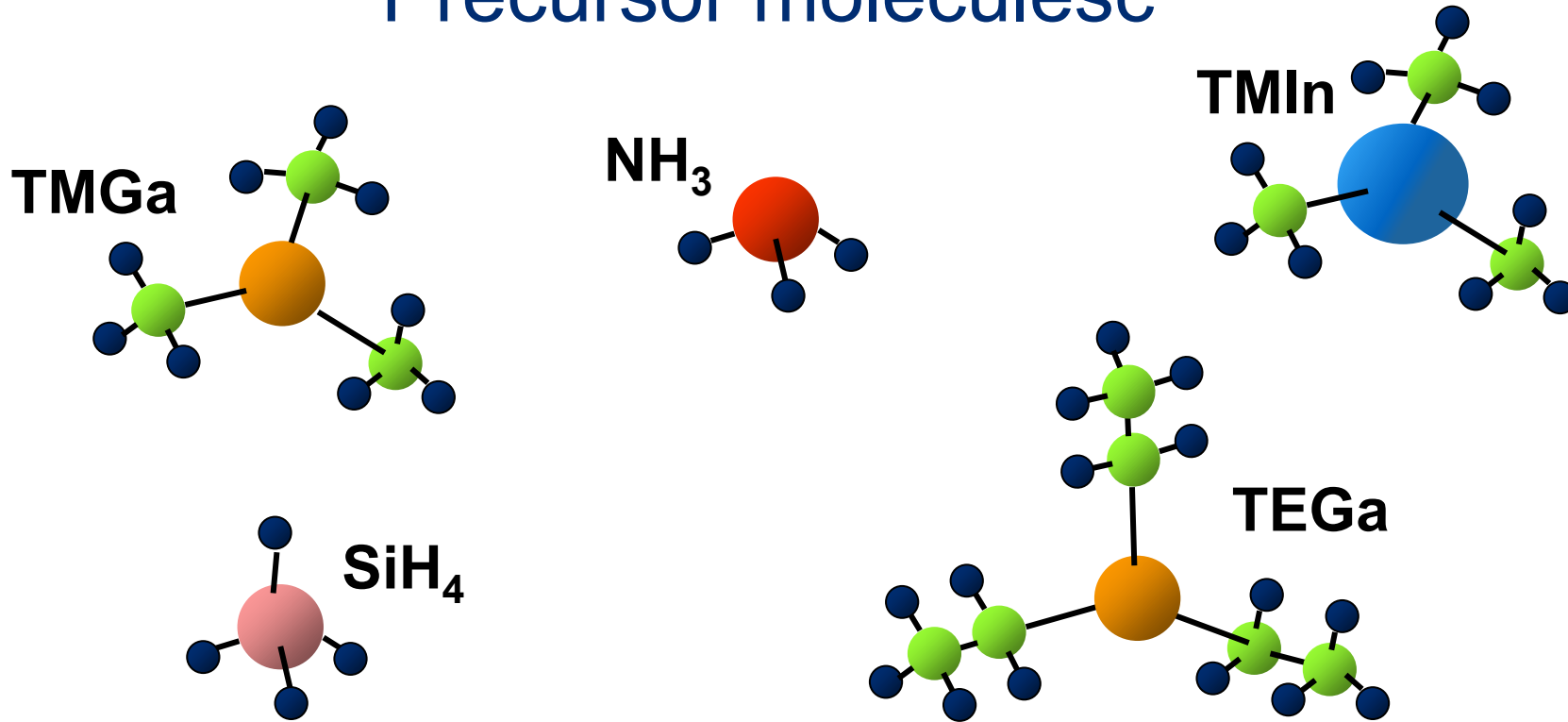
- Liquid phase epitaxy (LPE)
- Vapour phase epitaxy (HVPE, PVD, MBE, PAMBE, ALE, PECVD, **MOVPE (MOCVD)**)



MOVPE - principle

MOVPE

Precursor molecules

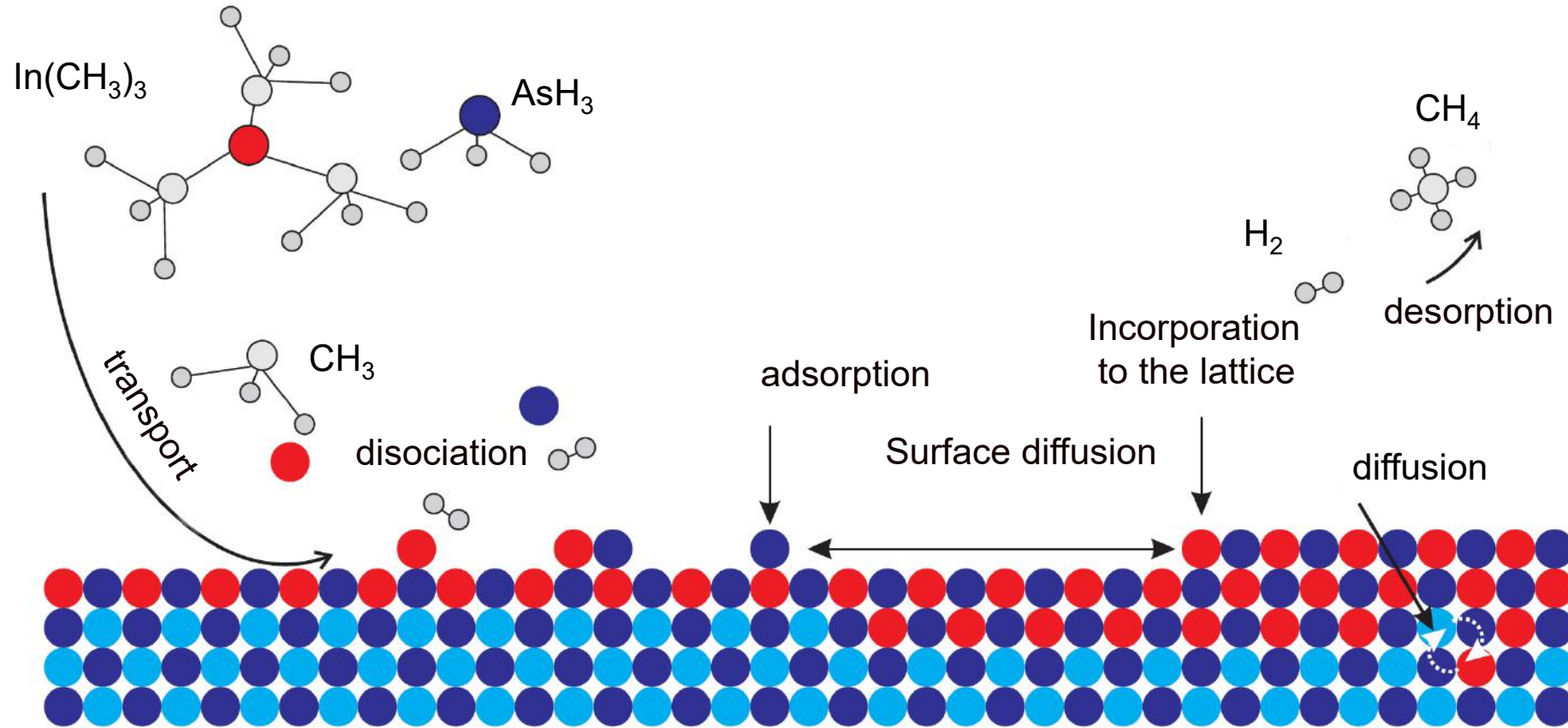


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MOVPE

Physical and chemical processes

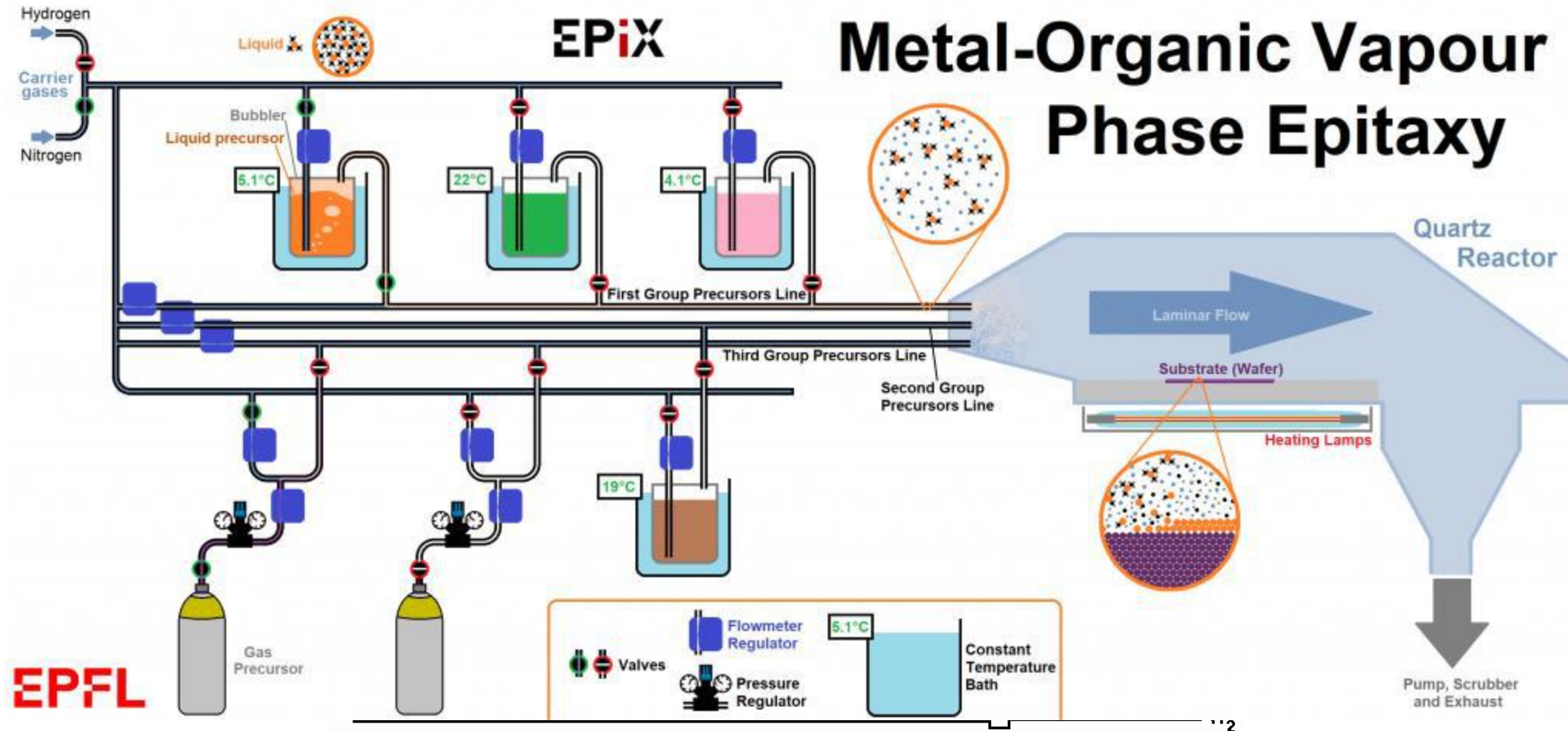


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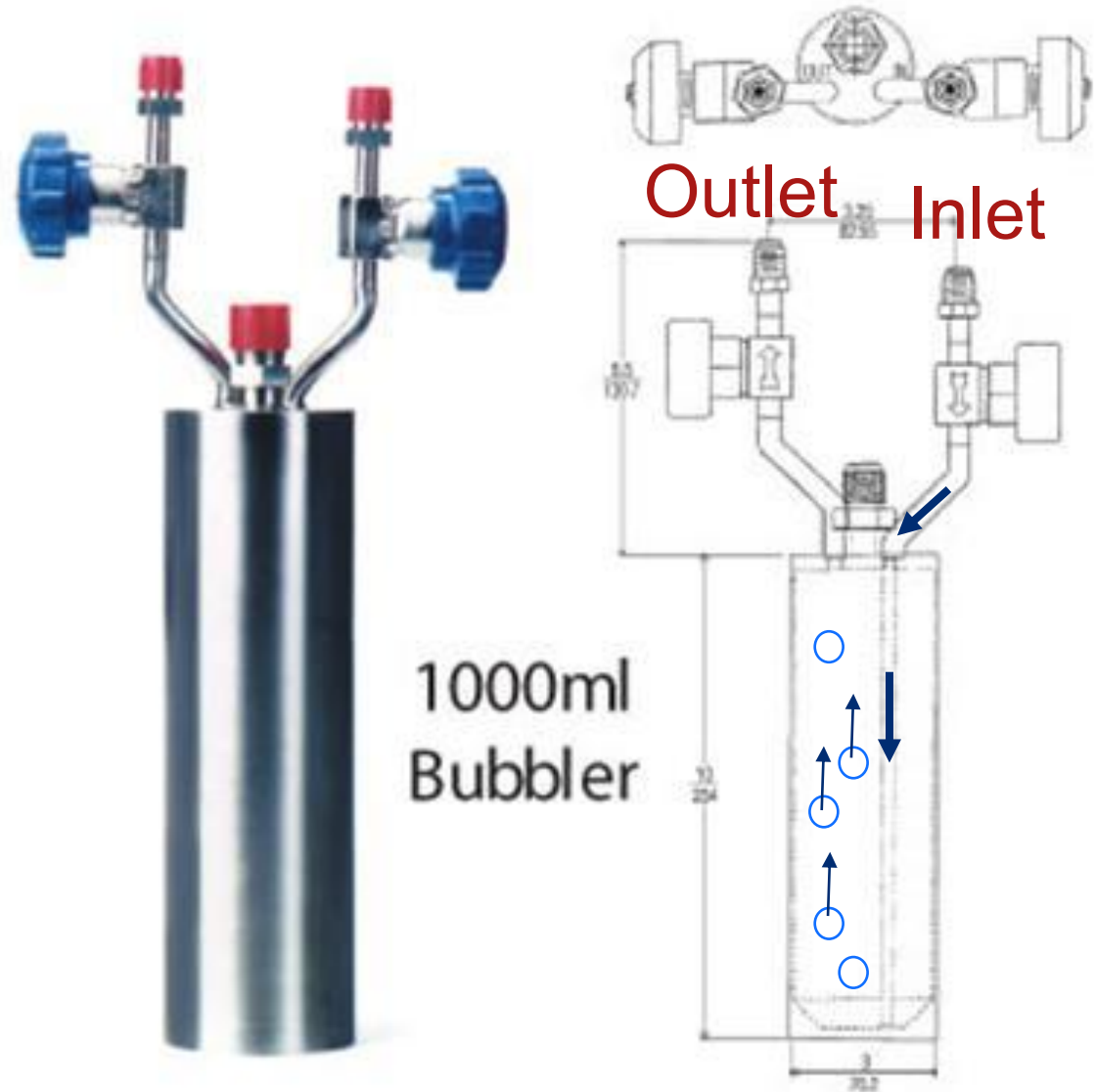
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Principal scheme of

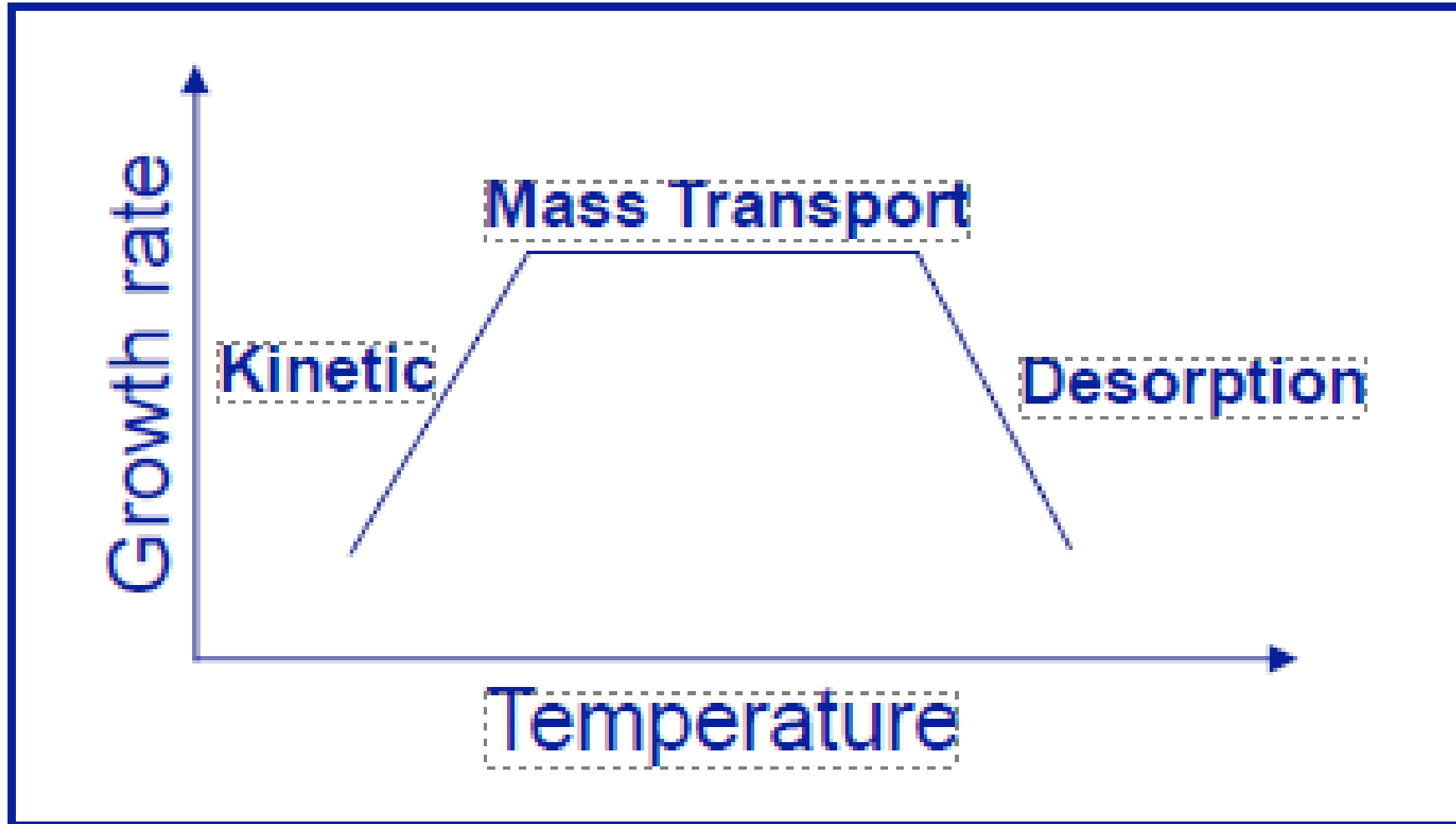
Metal-Organic Vapour Phase Epitaxy



Bubblers – containers for metalorganics



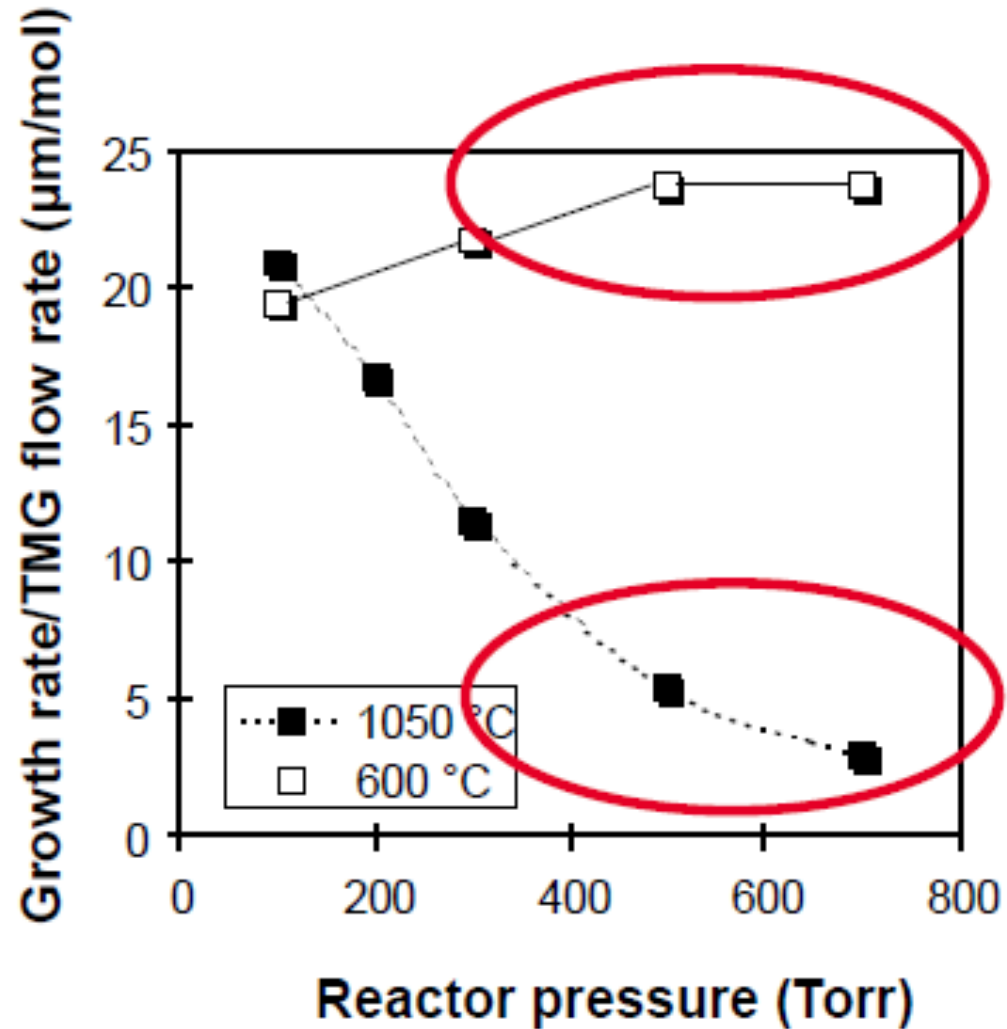
Growth temperature



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Growth temperature vs. pressure



Improved efficiency of precursor decomposition

Parasitic reaction in gas phase

Substrate orientation

- Incorporation of atoms at step edges

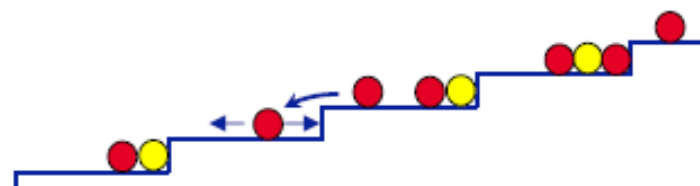
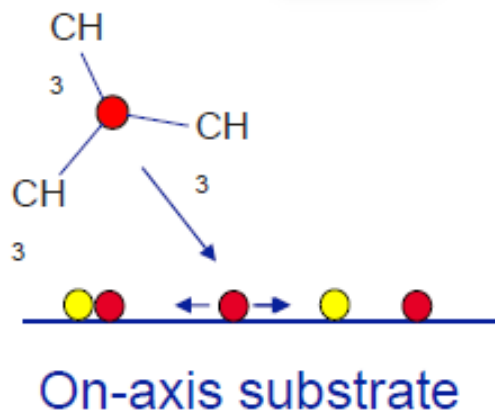
- Higher growth rates

- Higher quality films

[bez názvu]

● Gallium

● Nitrogen



Misoriented (off-cut substrate)
Net surface diffusion of atoms
from high to low steps

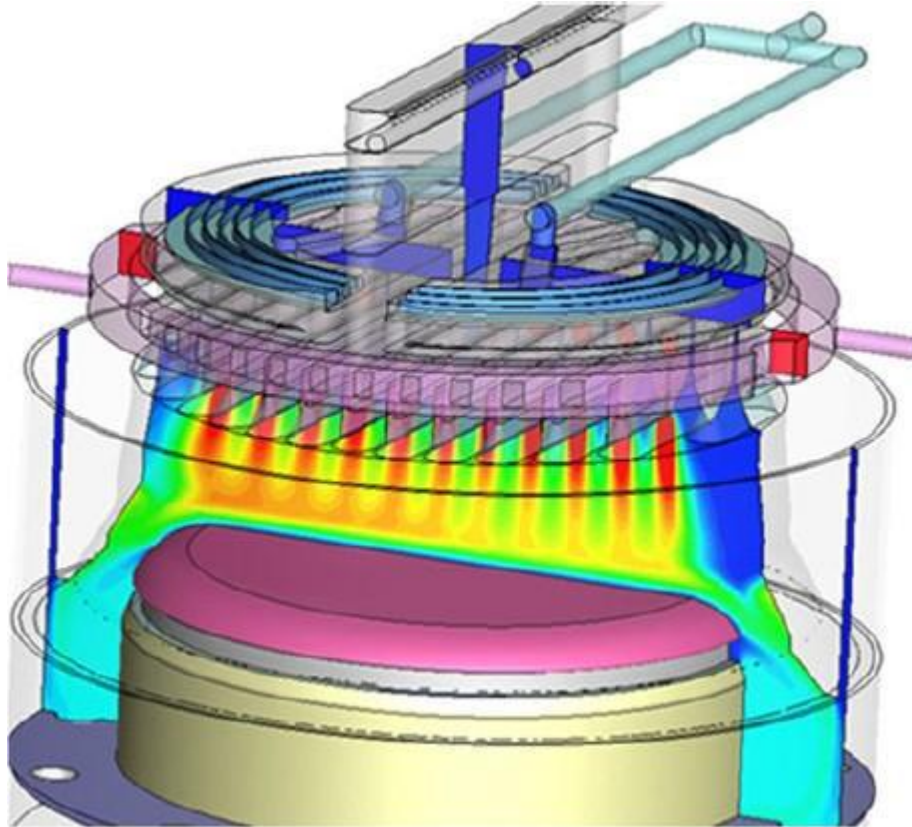
MOCVD of compound semiconductors is usually performed on substrates misoriented by 0.1 to 3 towards a certain crystallographic direction



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CCS 3x2 FlipTop reactor



Substrates are placed on the heated susceptor with pockets. The precursors are decomposed above heated substrates and the atoms are deposited on the surface.



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MOVPE is dominant technology for nitride semiconductors



MOVPE aparature Aixtron CCS 3x2



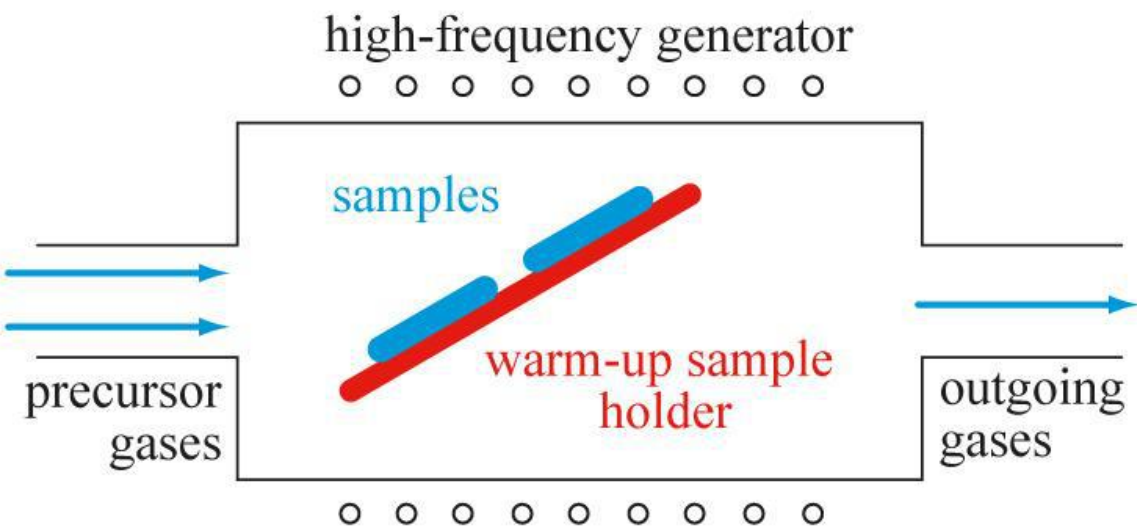
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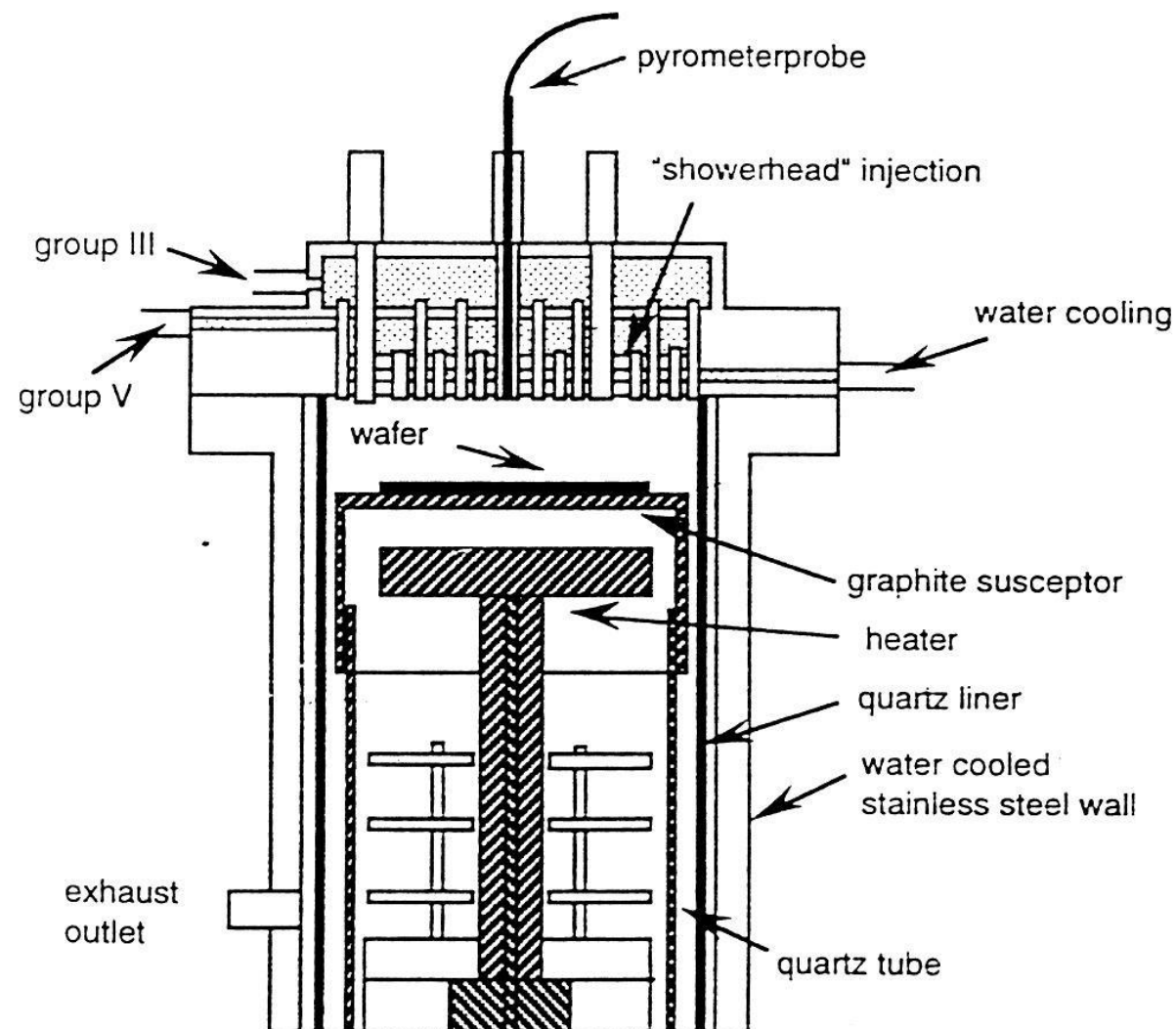
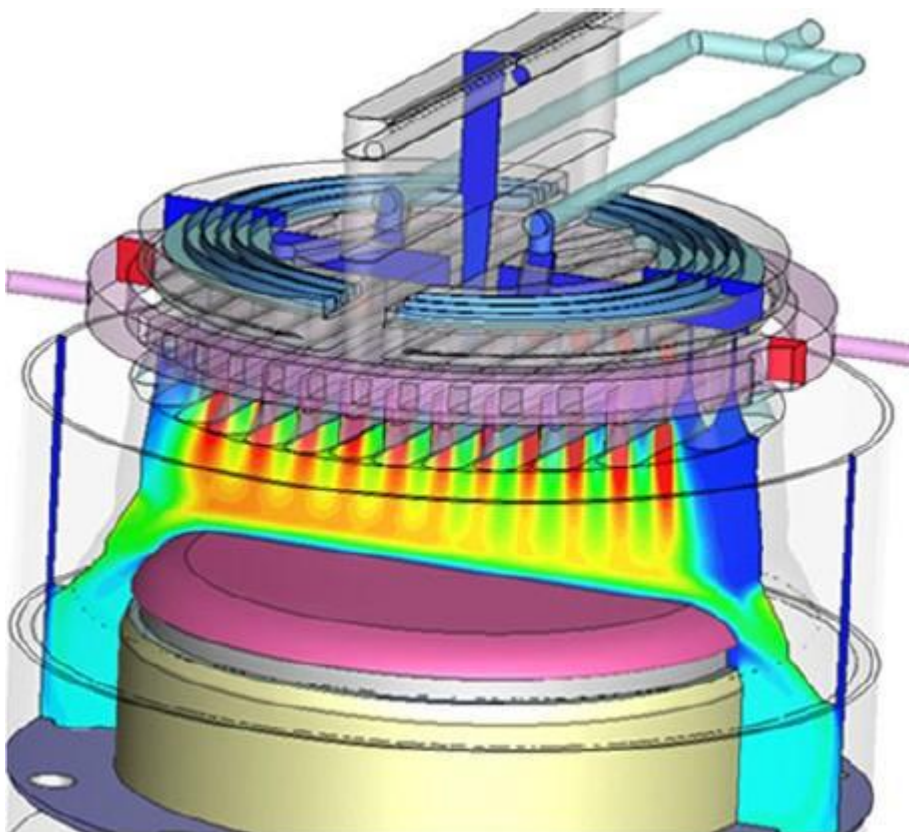
MOVPE

reactor types

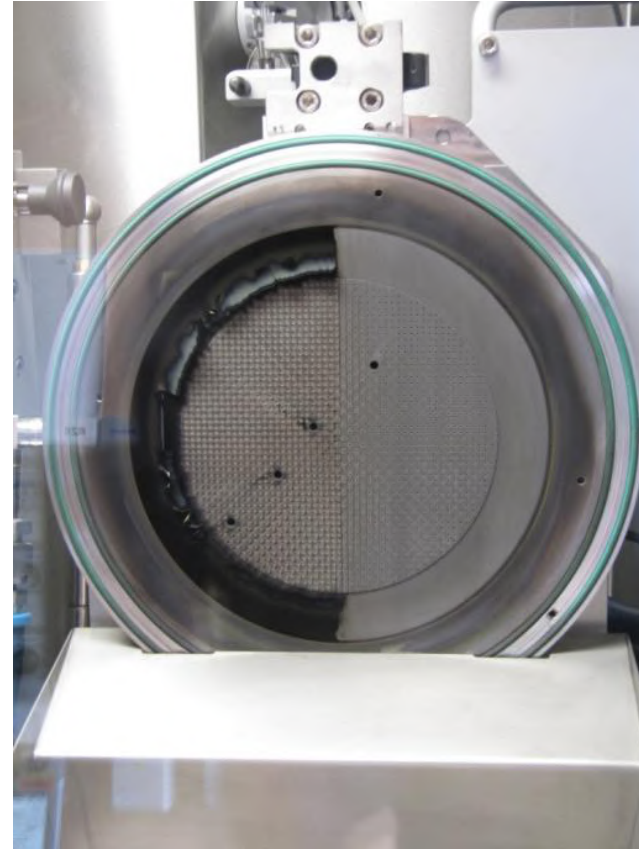
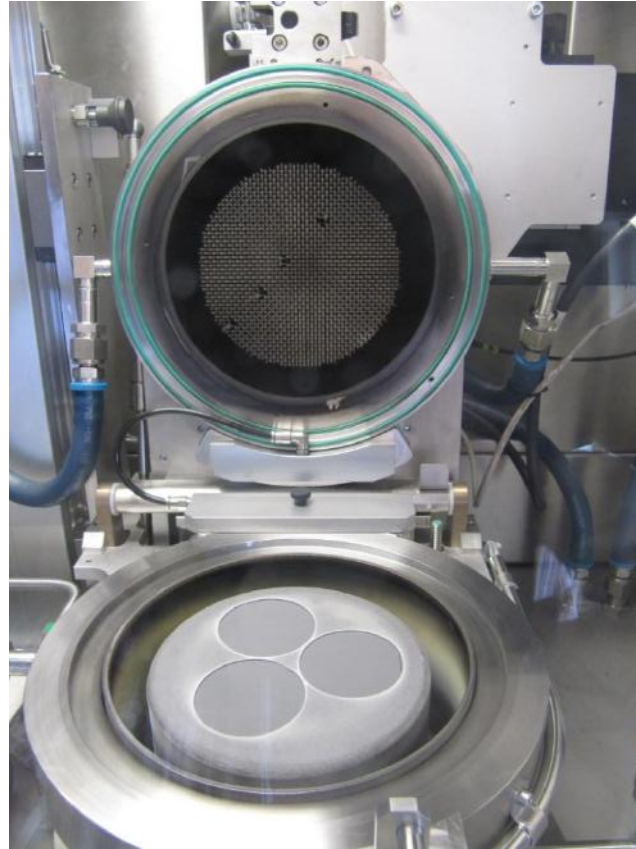
Horizontal reactors



Vertical reactor



Growth chamber after epitaxy



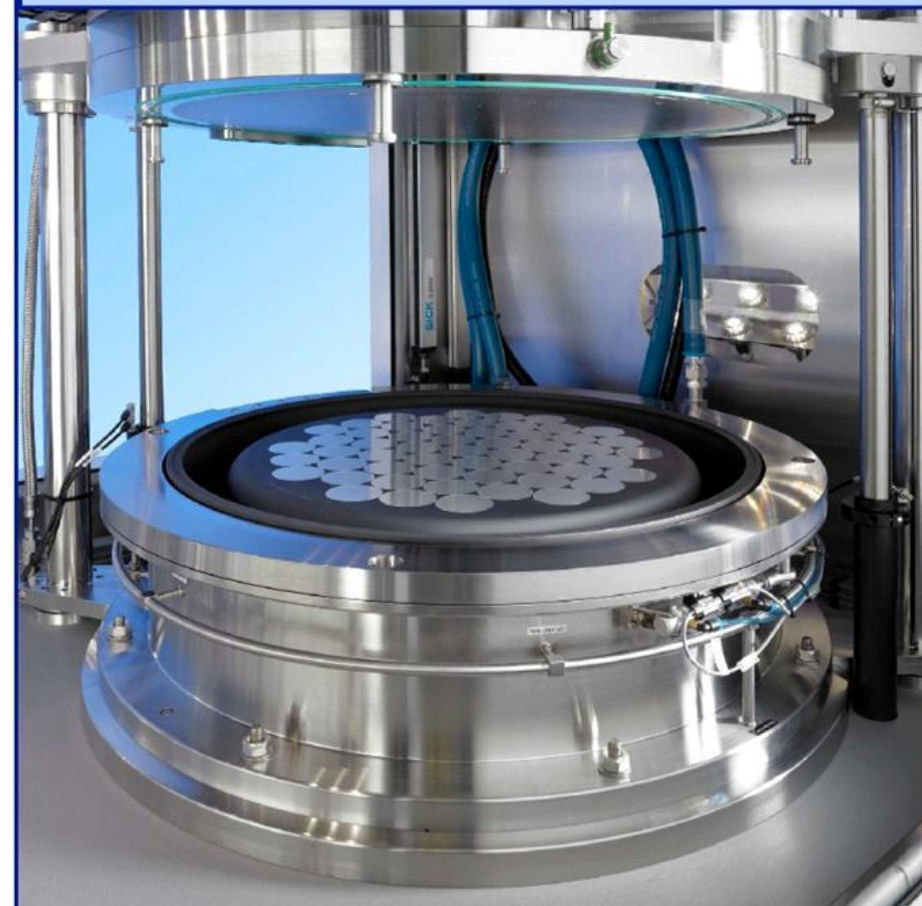
Has to be cleaned after each run

Industrial reactors

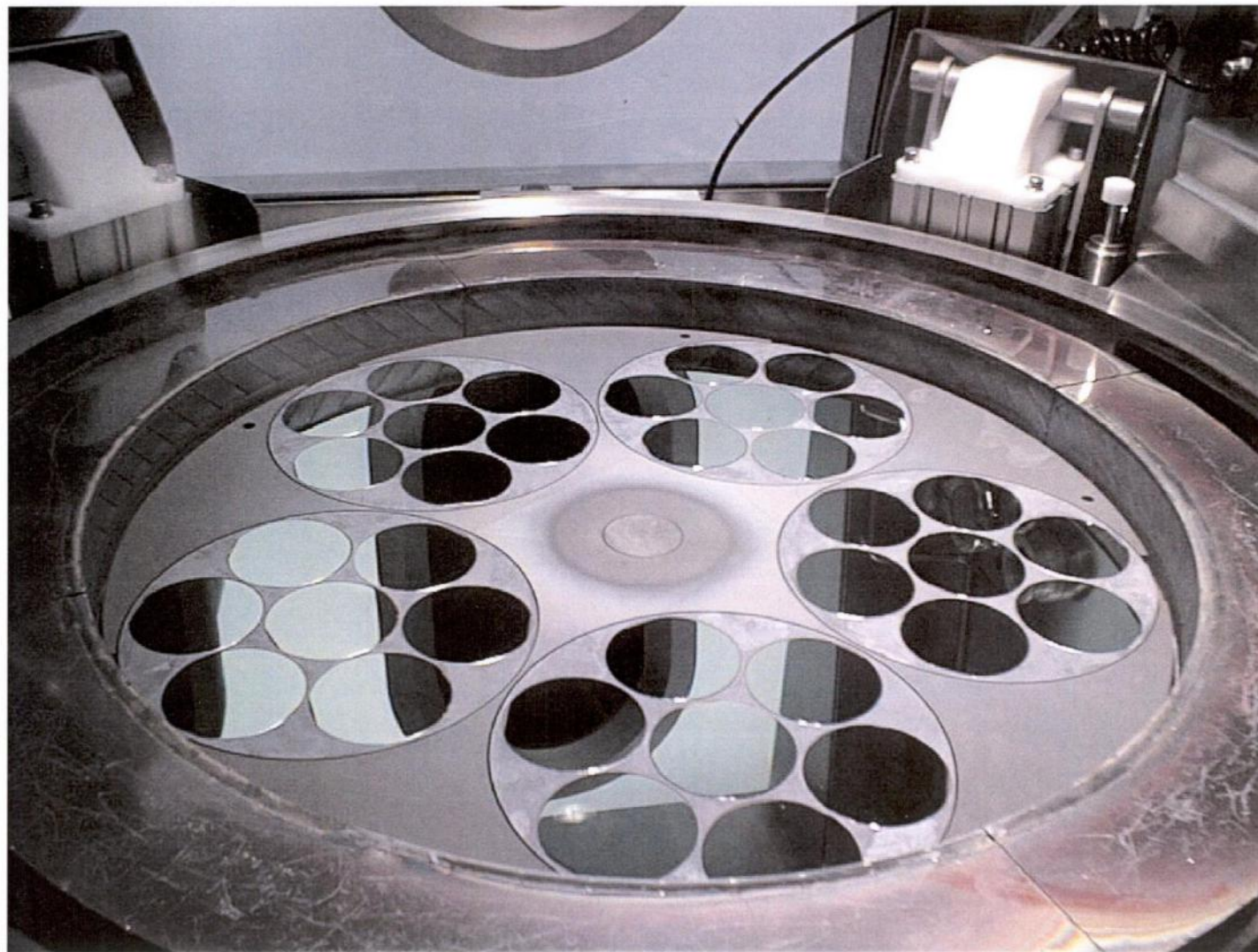
Integrated Concept System IC 2



Close Coupled Showerhead® 55x2"



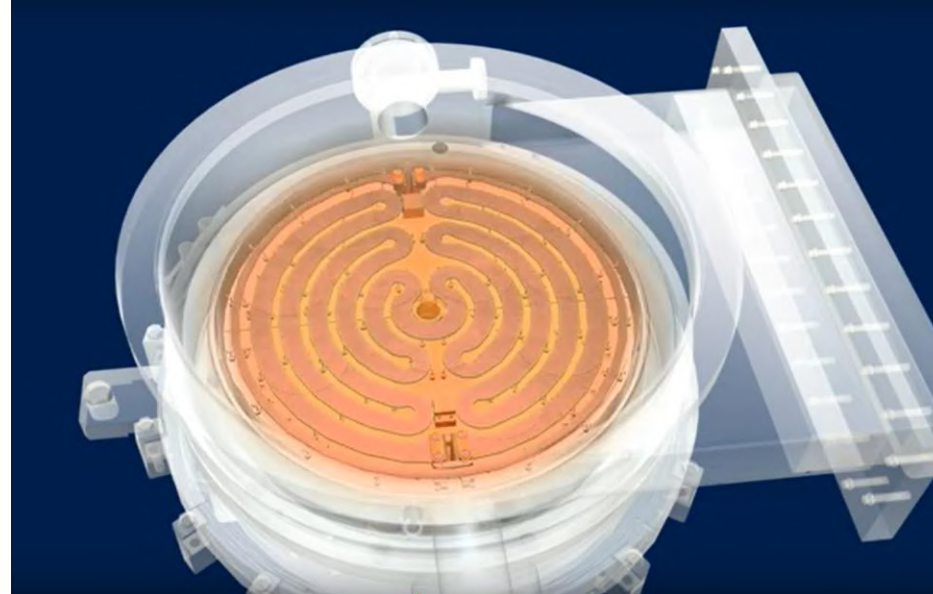
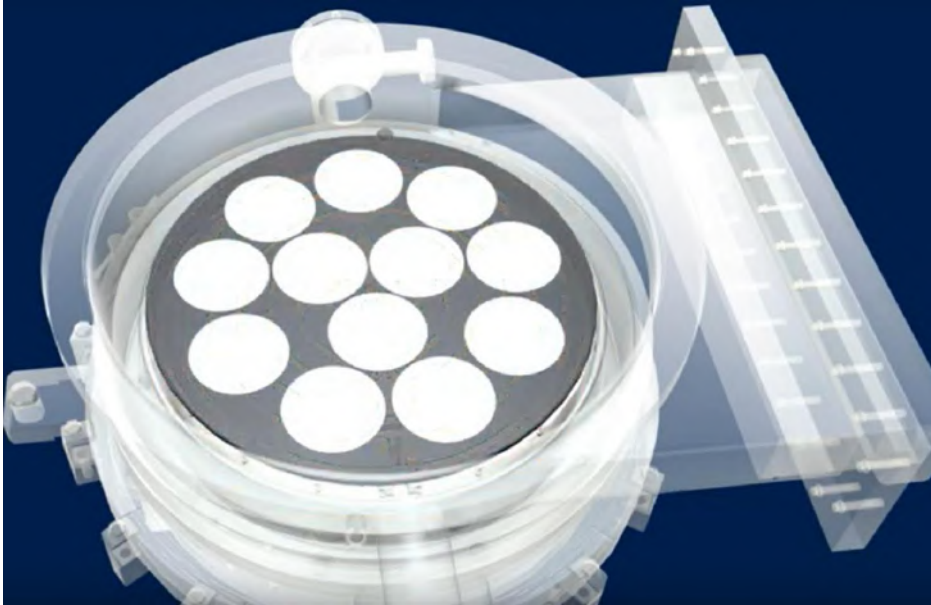
AIX 2600G3 Planetary Reactor® (35x2")



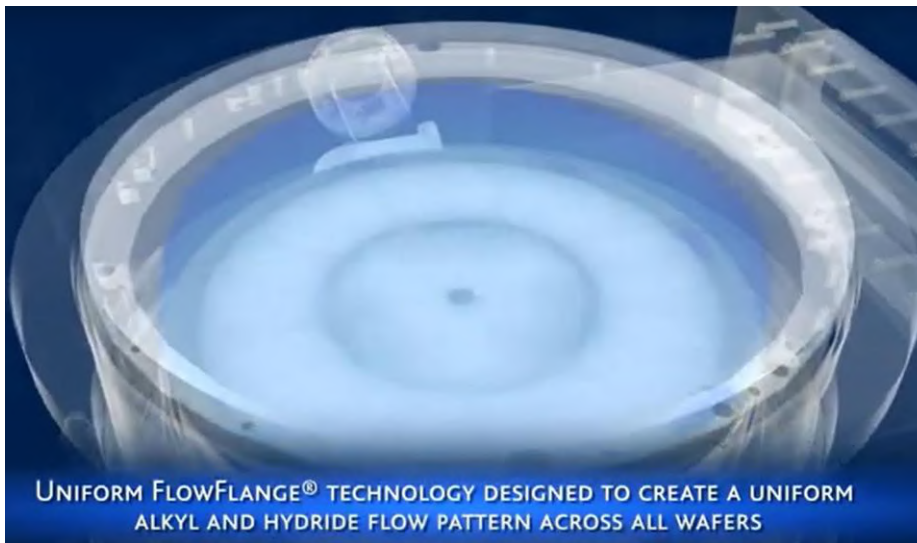
Industrial reactors – vertical Turbodisc reactor



Industrial reactors – vertical Turbodisc reactor

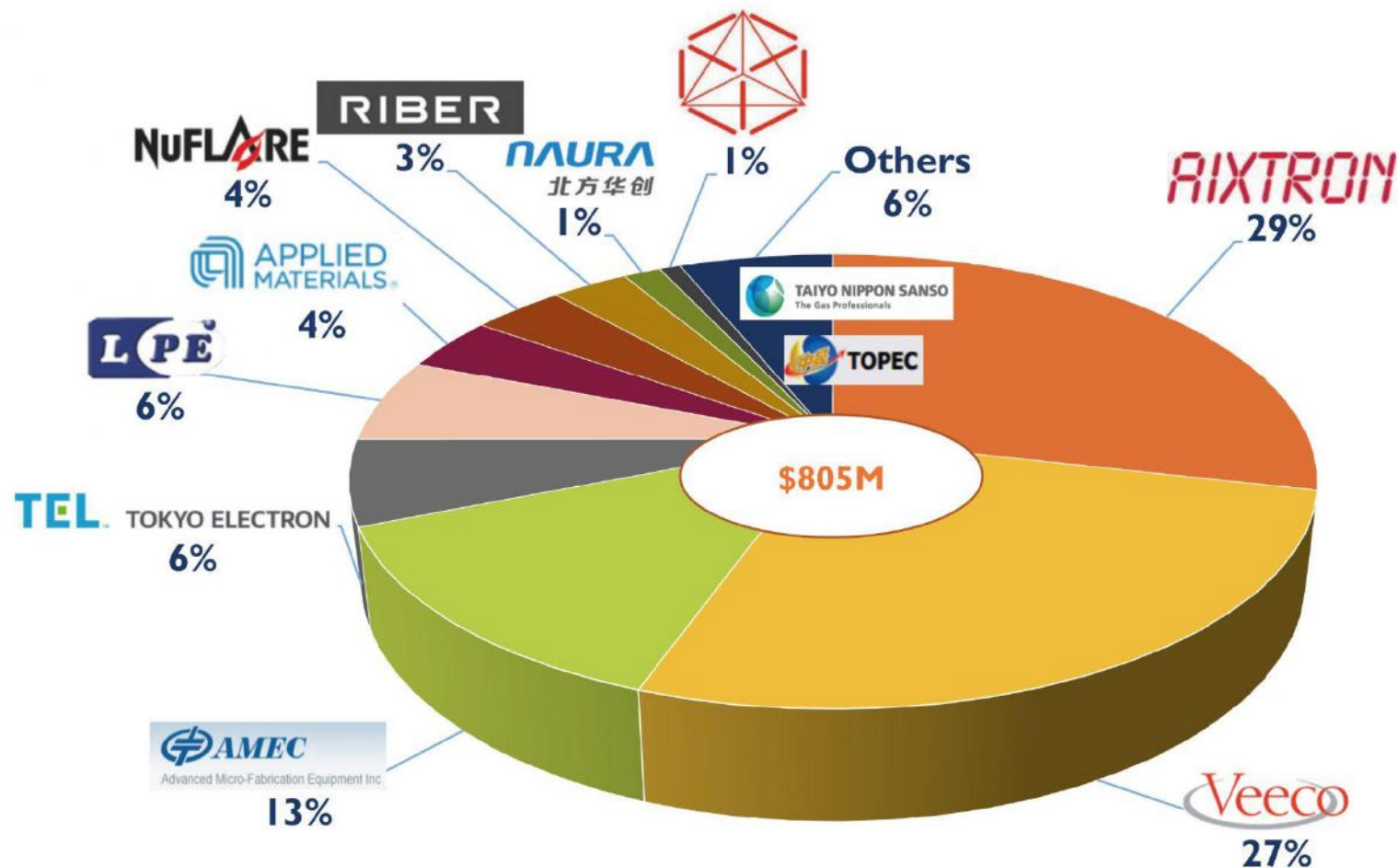


Industrial reactors – vertical Turbodisc reactor



2018 global epitaxy growth equipment market share

(Source: Epitaxy Growth Equipment for More Than Moore Devices Technology and Market Trends 2020 report, Yole Développement, 2020)



In situ monitoring

Reflectance

Curvature

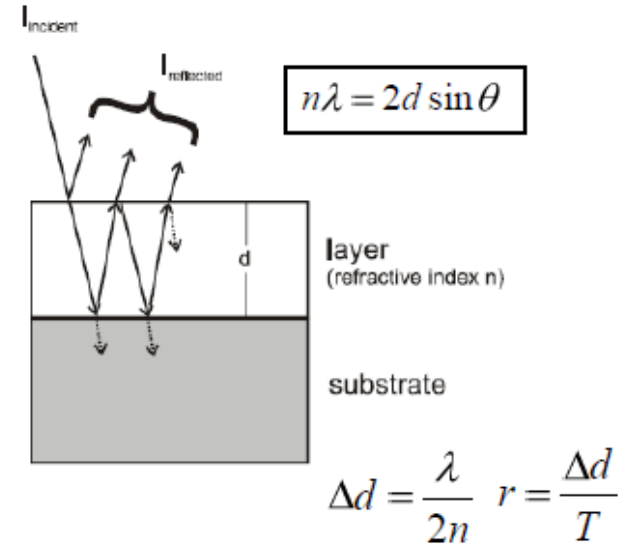
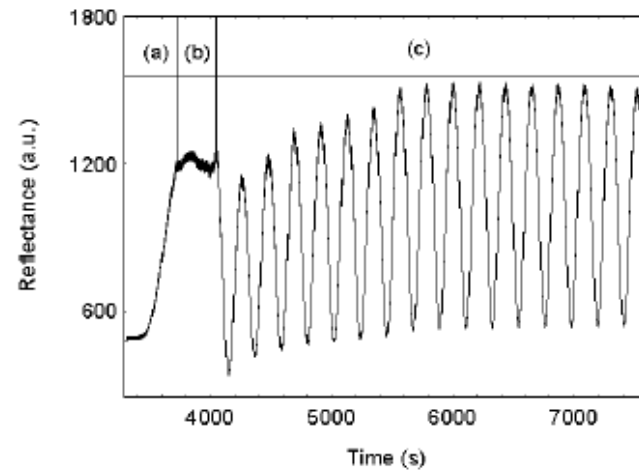
True temperature

RAS – Reflectance anisotropy spectroscopy

Reflectivity

Growth Monitoring

- Reflectance interferometry
 - Phase difference of light
 - Constructive/destructive interference
 - Fabry-Perot oscillations
 - Measurable growth rate (periodicity)



- Incident source $\sim 650\text{nm}$
 - Very low extinction coefficient
 - Reflectance artefacts due to physical alloy properties

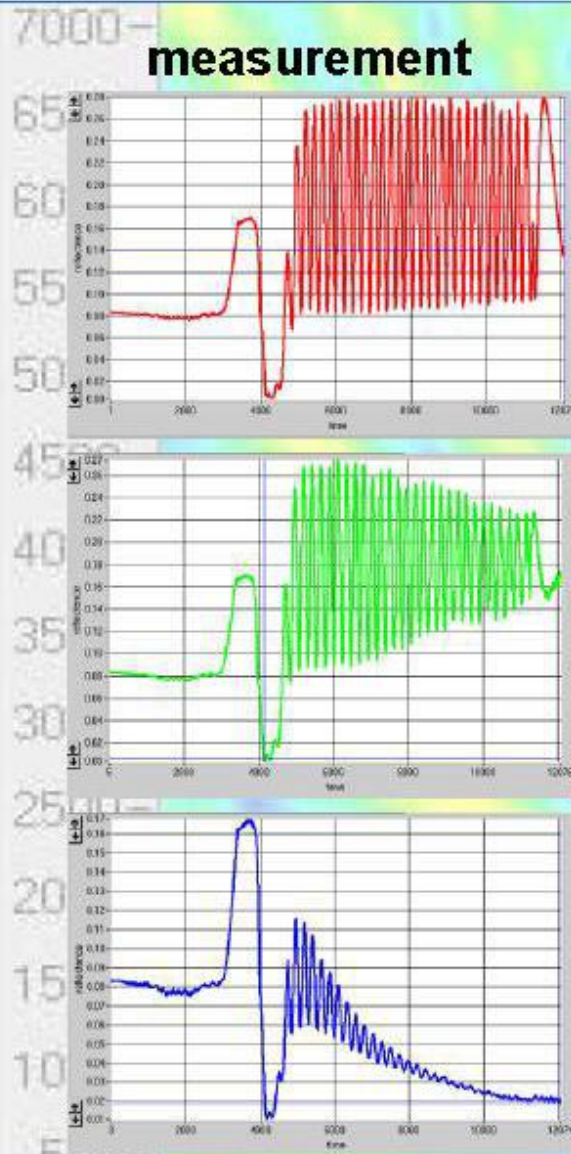


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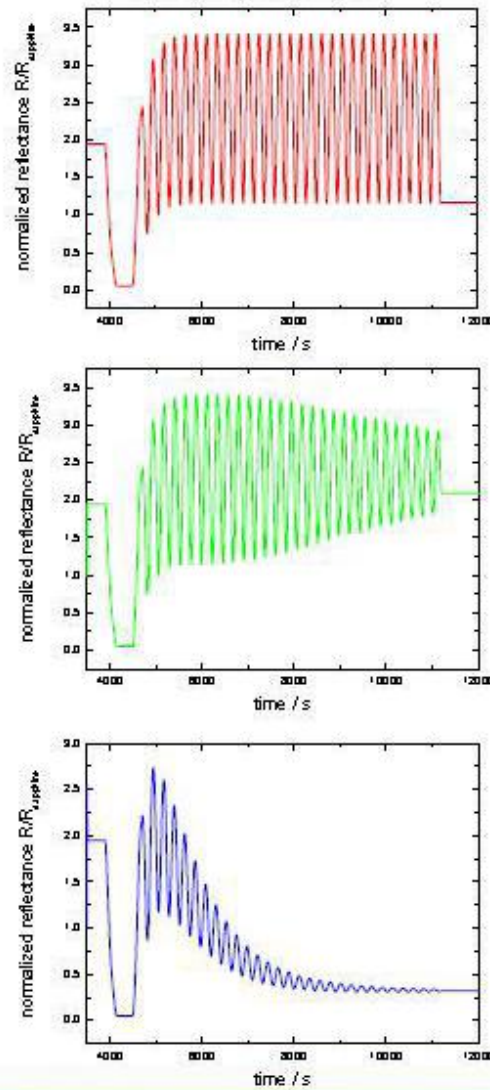
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Reflectivity

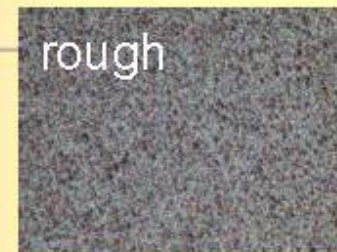
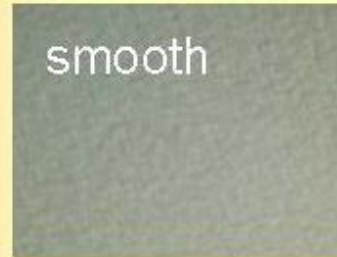
measurement



simulation

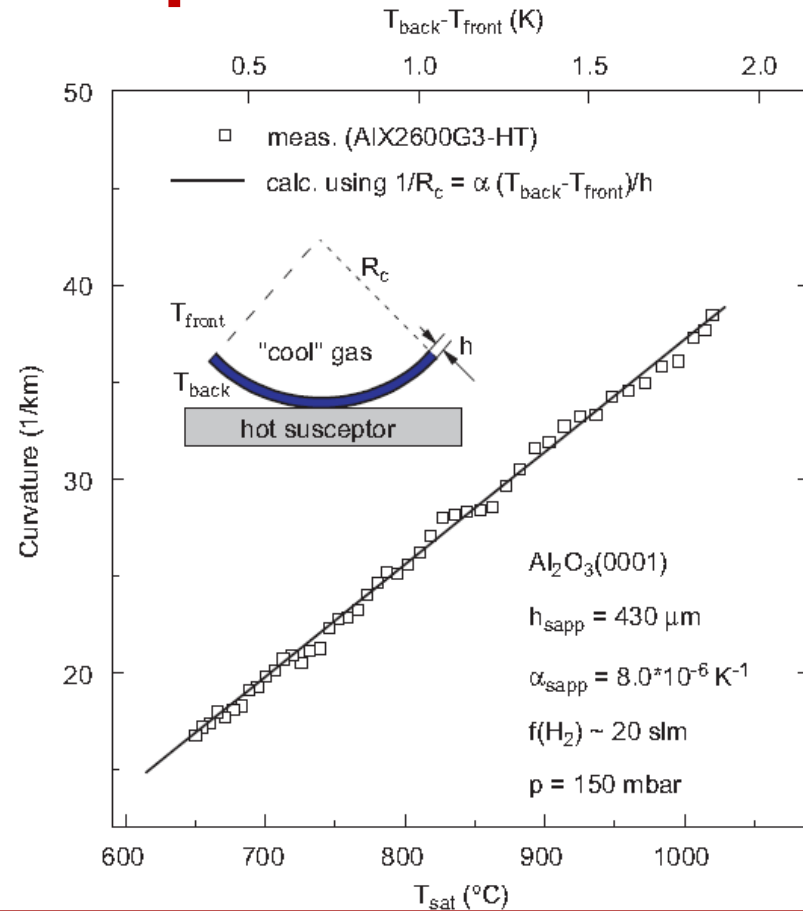


microscopy

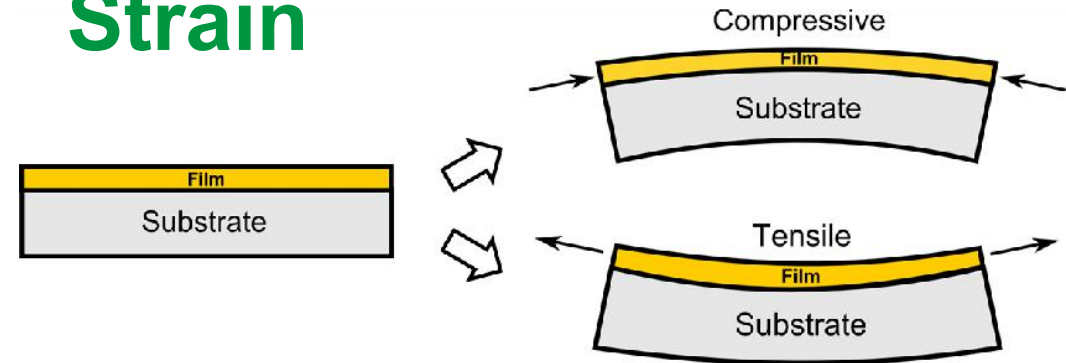


What influence wafer curvature

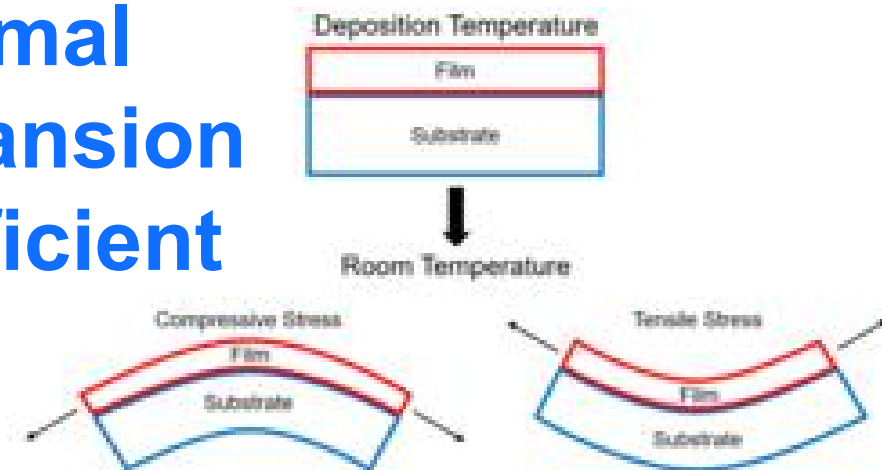
Temperature



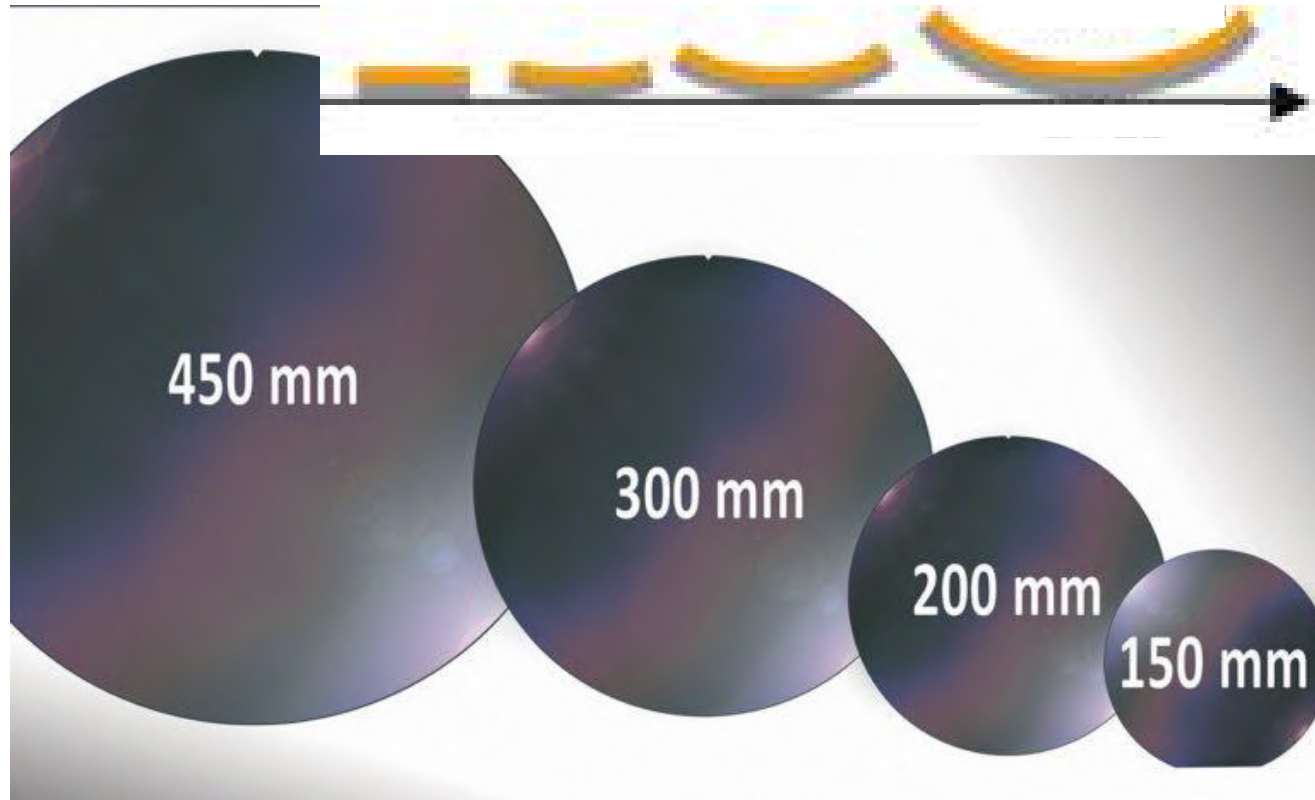
Strain



thermal expansion coefficient

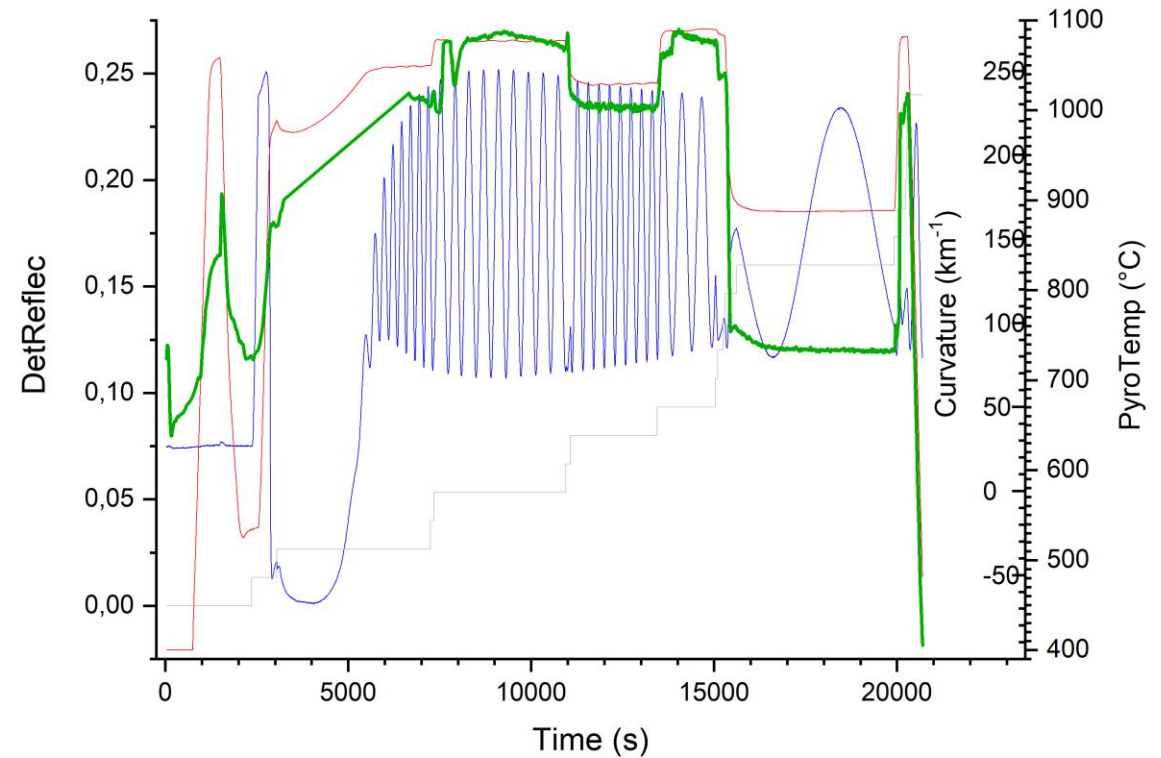
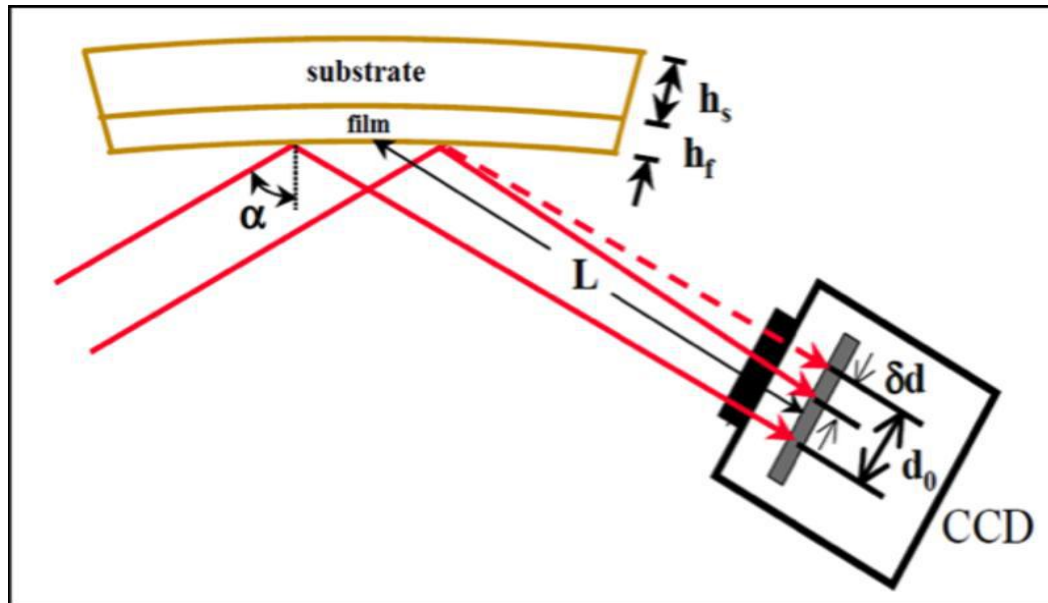


Why the wafer curvature is so important?



1. With increased curvature **during epitaxy** the **temperature** over the wafer is **inhomogeneous**, which has impact on homogeneity of epilayer properties
2. Wafer curved **after epitaxy** complicates further technological steps (lithography)

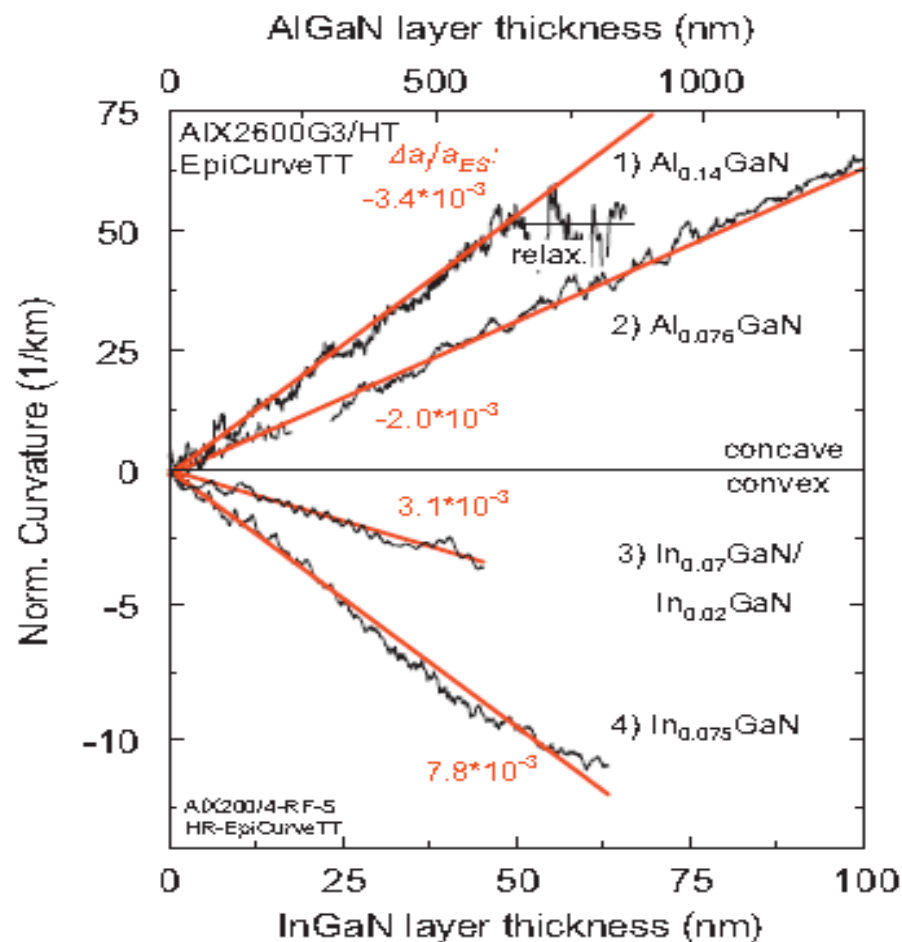
Measurement of wafer curvature - temperature



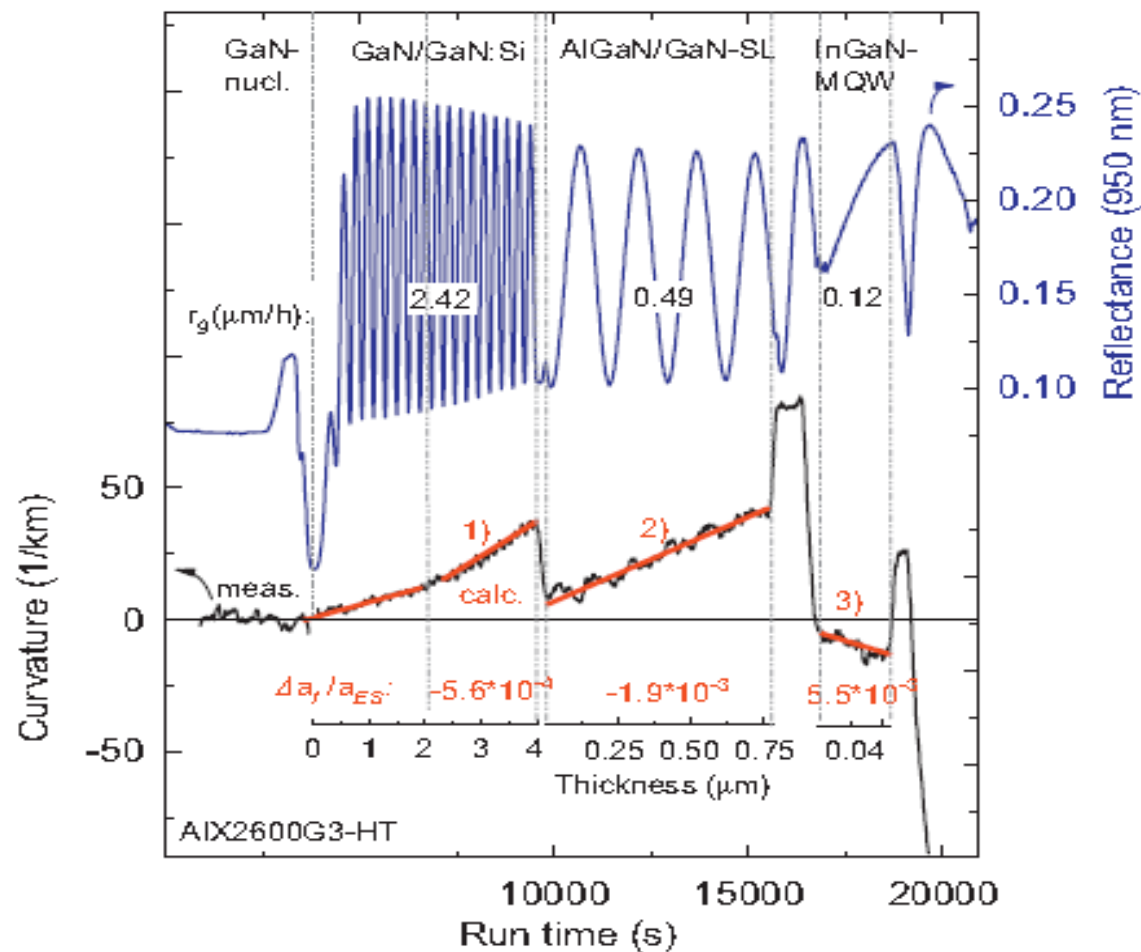
In case of non direct semiconductors, dopants with deep levels and Heisenberg relations were employed

Curvature caused by strain - examples

a



b



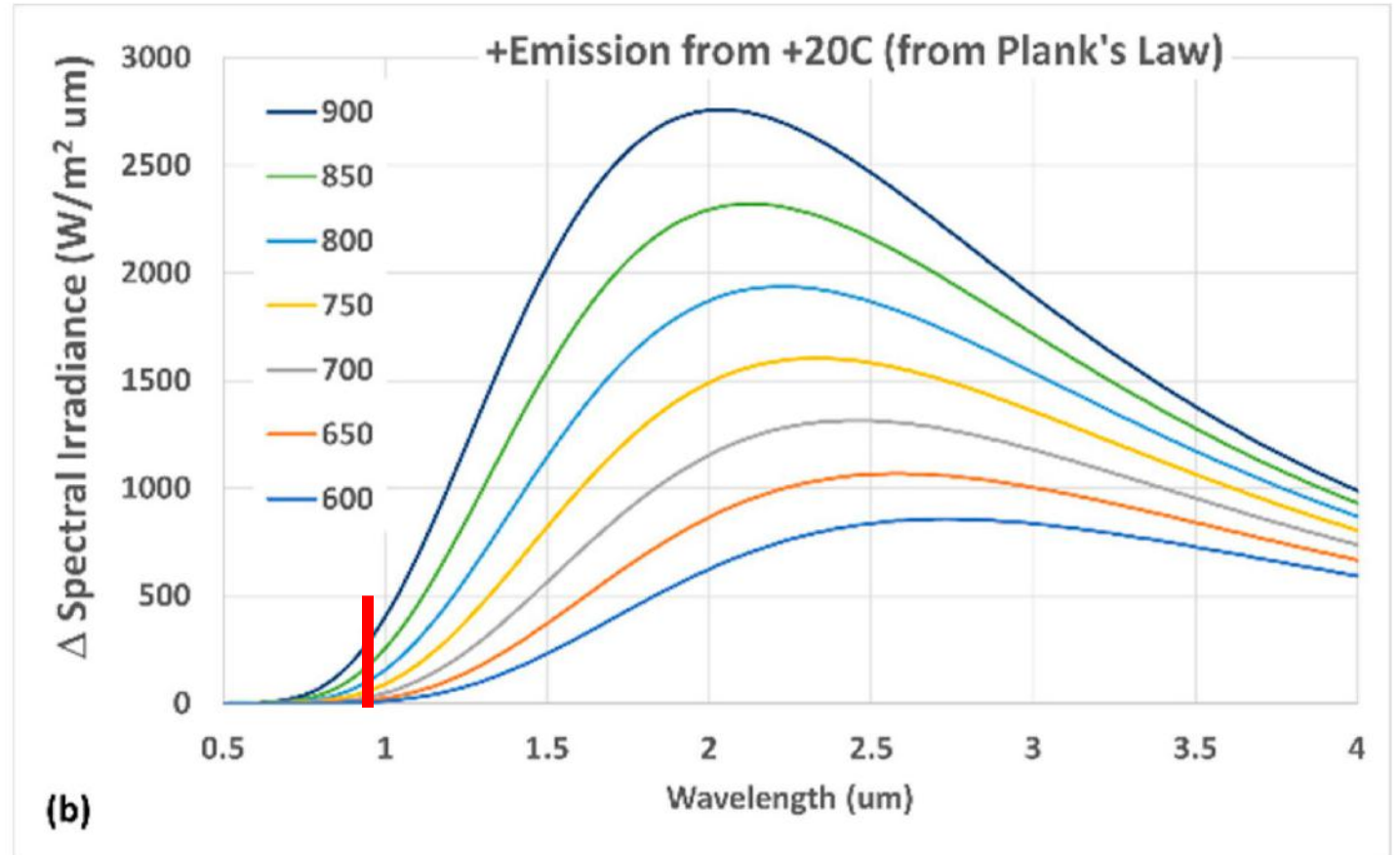
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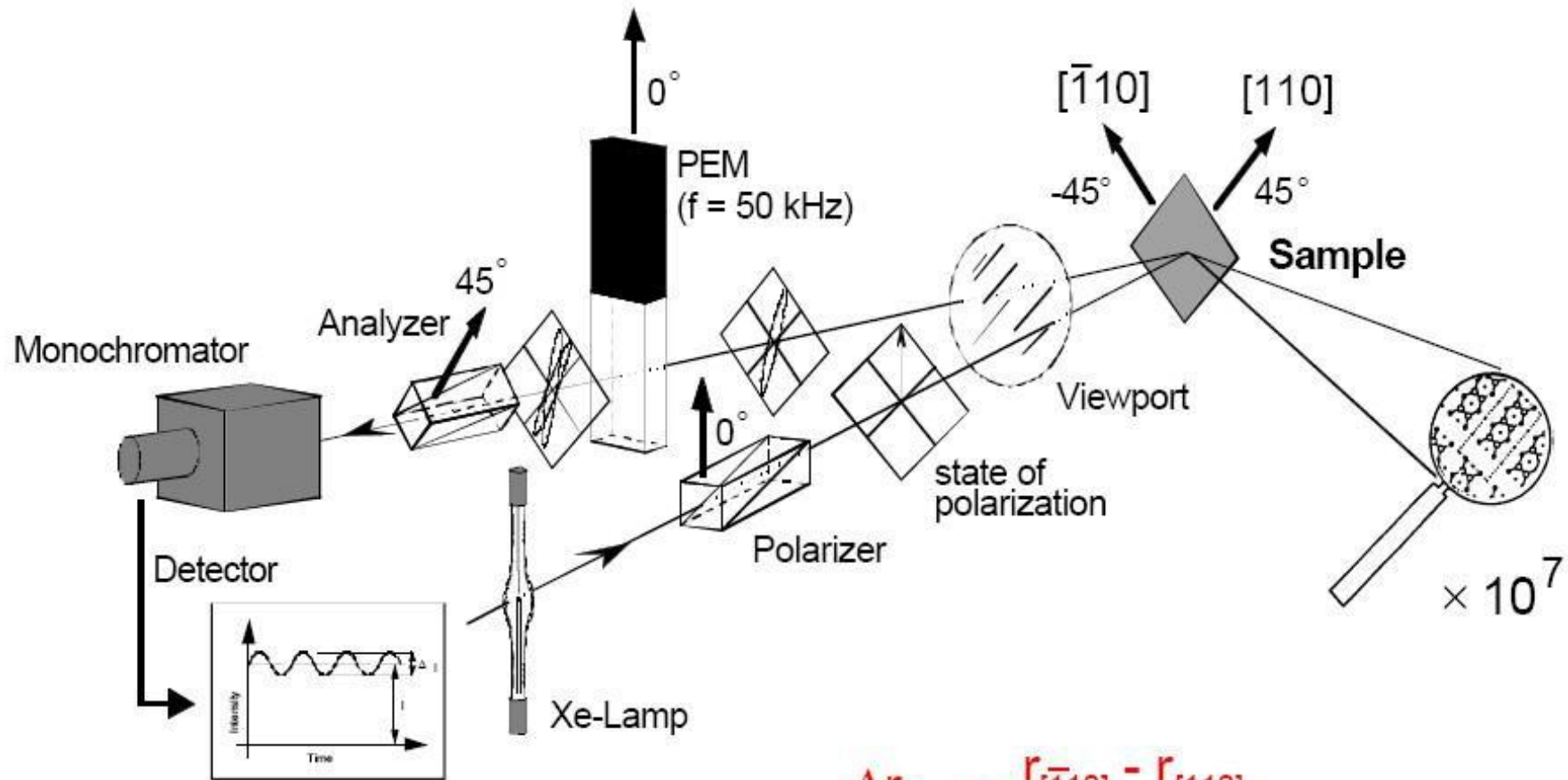
True temperature measurement Emissivity corrected pyrometry

Measured at 950 nm

Transparent for nitrides: susceptor
temperature is measured



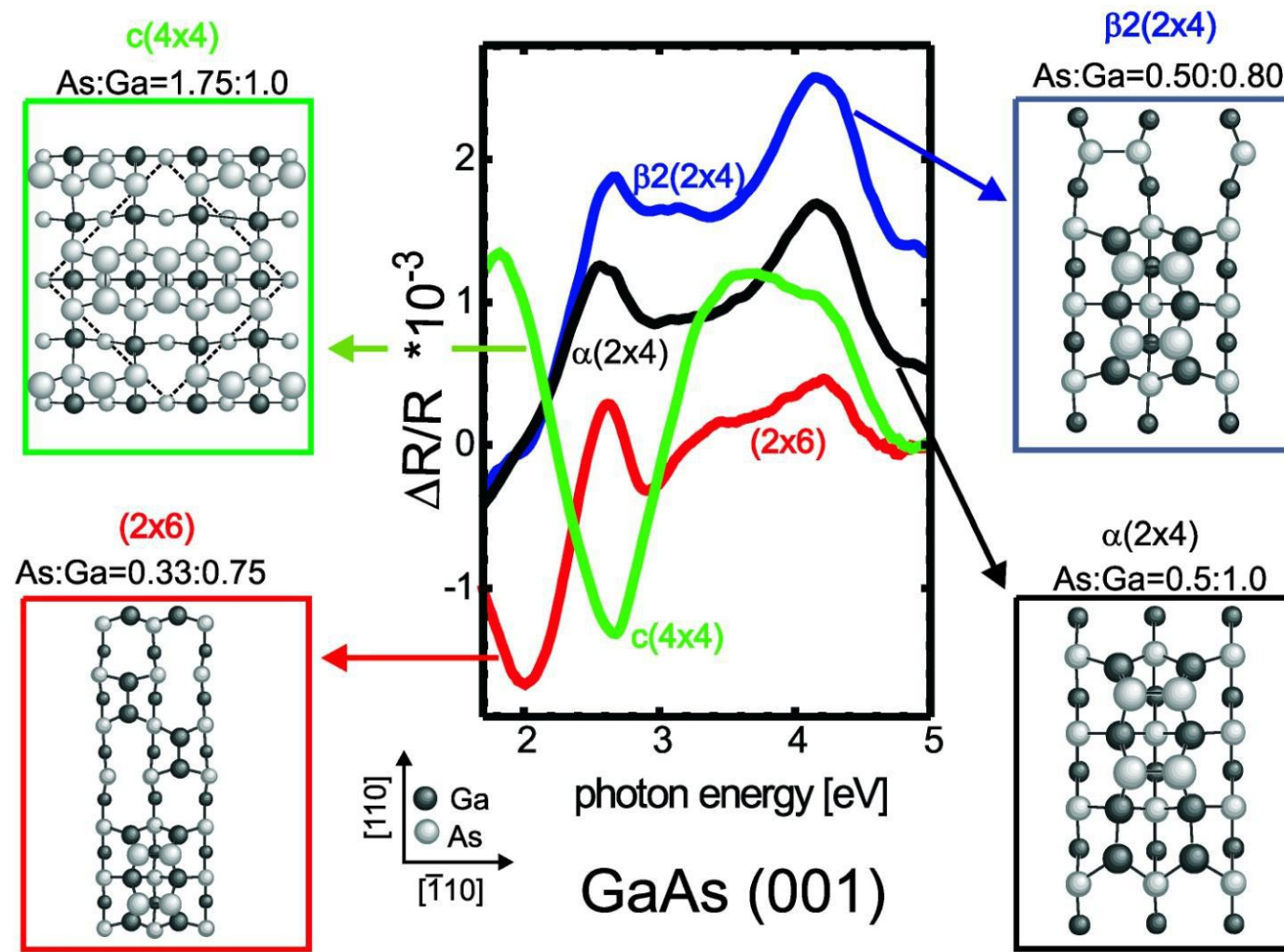
RAS – reflectance anisotropy spectroscopy



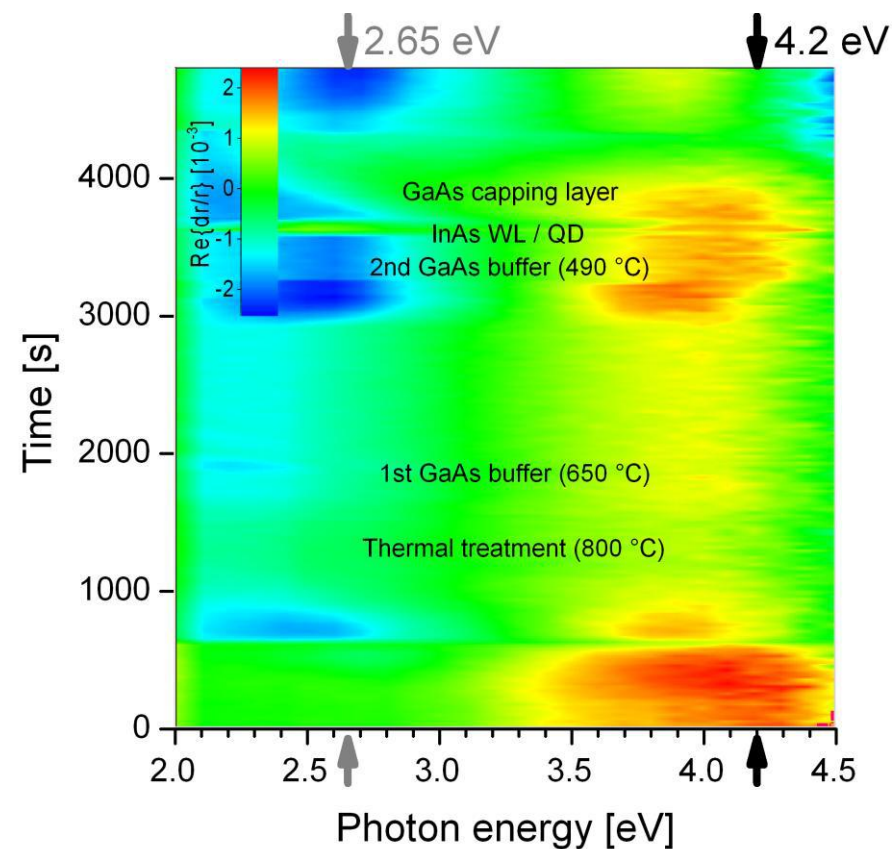
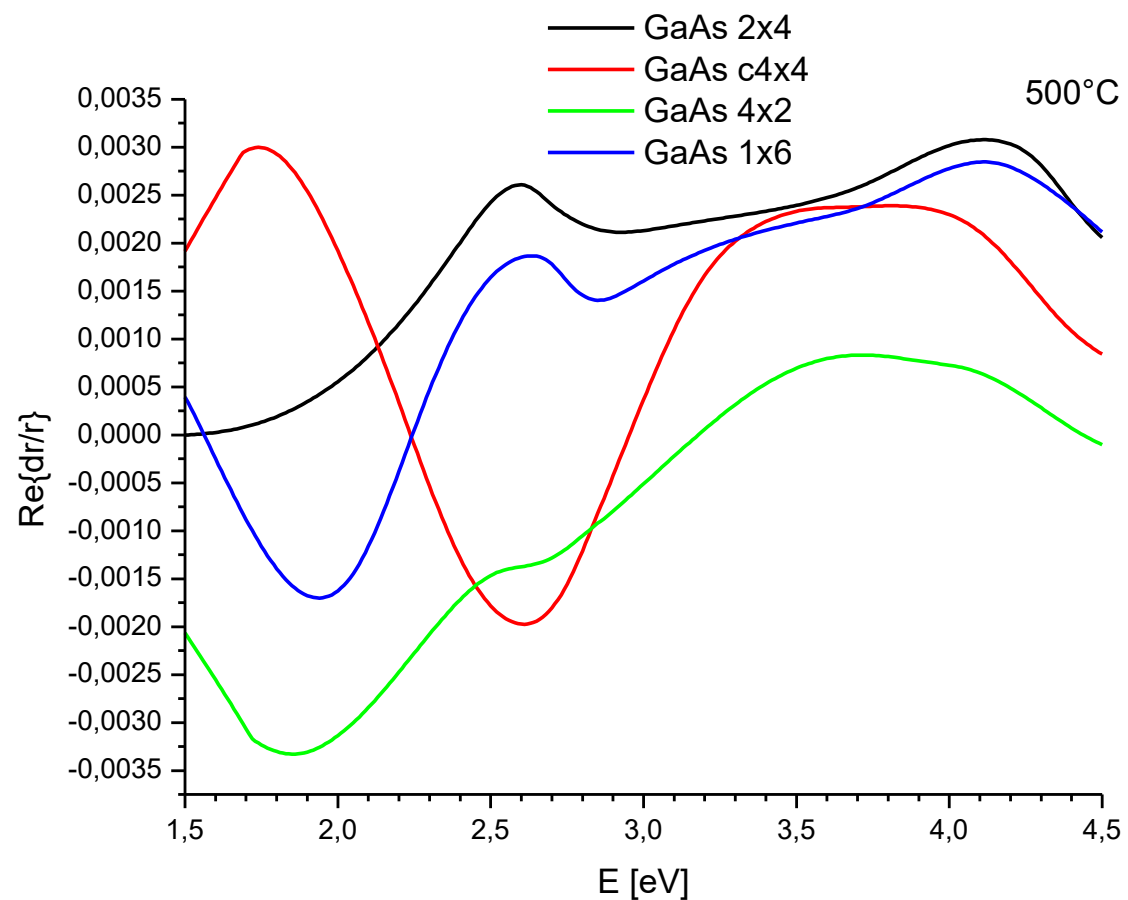
$$\frac{\Delta r}{r} = 2 \frac{r_{[\bar{1}10]} - r_{[110]}}{r_{[\bar{1}10]} + r_{[110]}}$$

RAS – reflectance anisotropy spectroscopy

RAS can be used only
for cubic crystal lattice:
GaAs, GaP, GaSb, InAs...

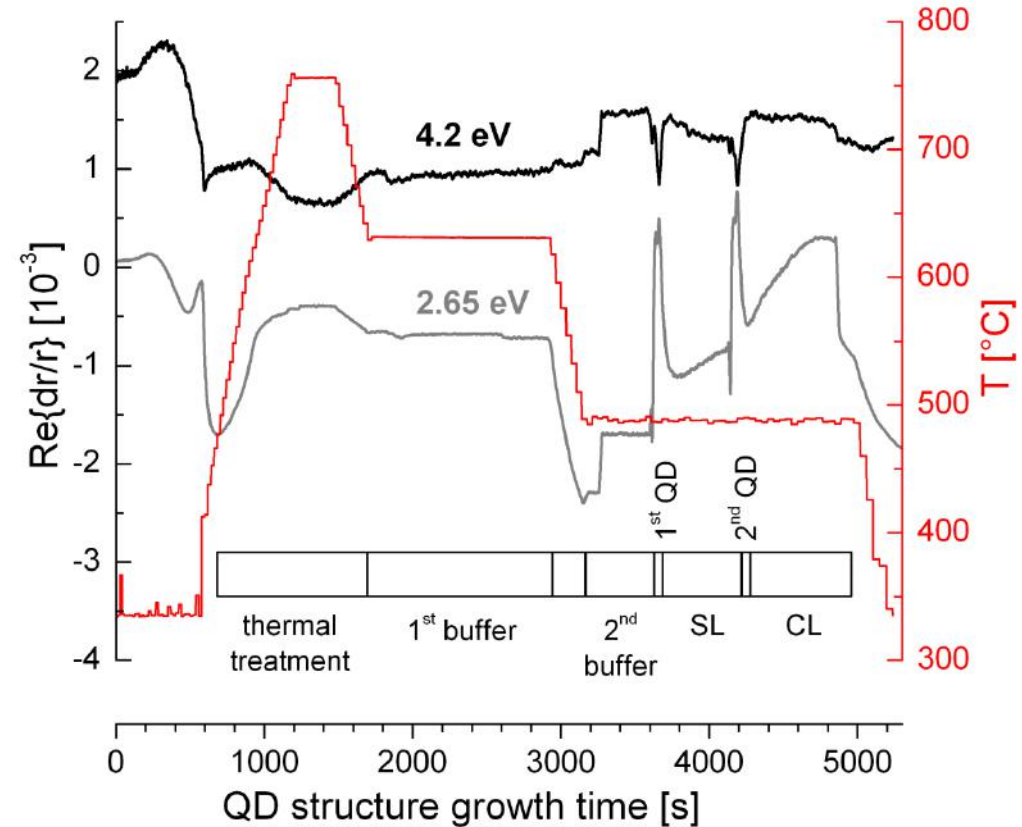
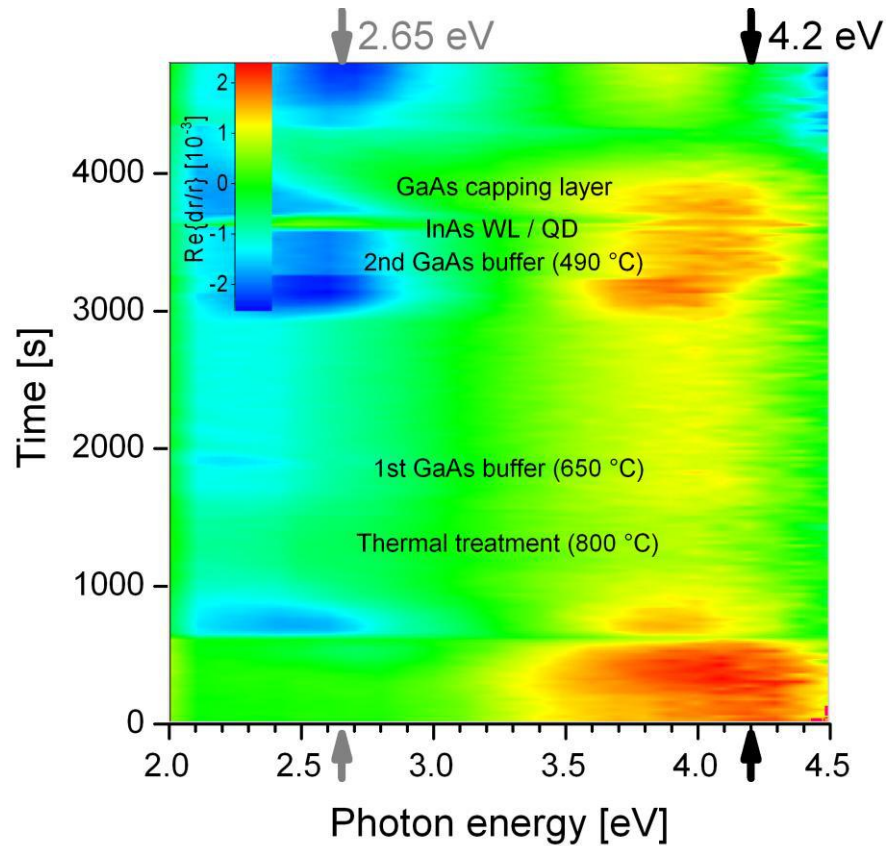


RAS – reflectance anisotropy spectroscopy



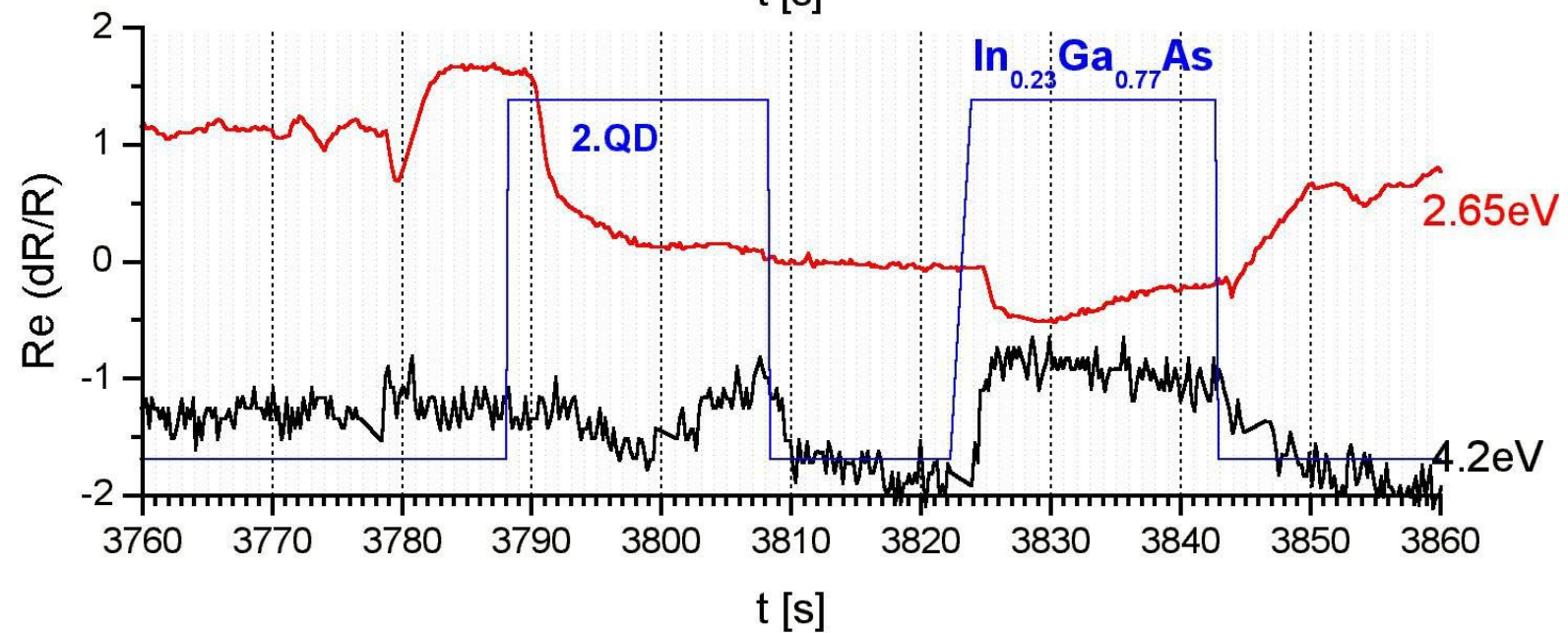
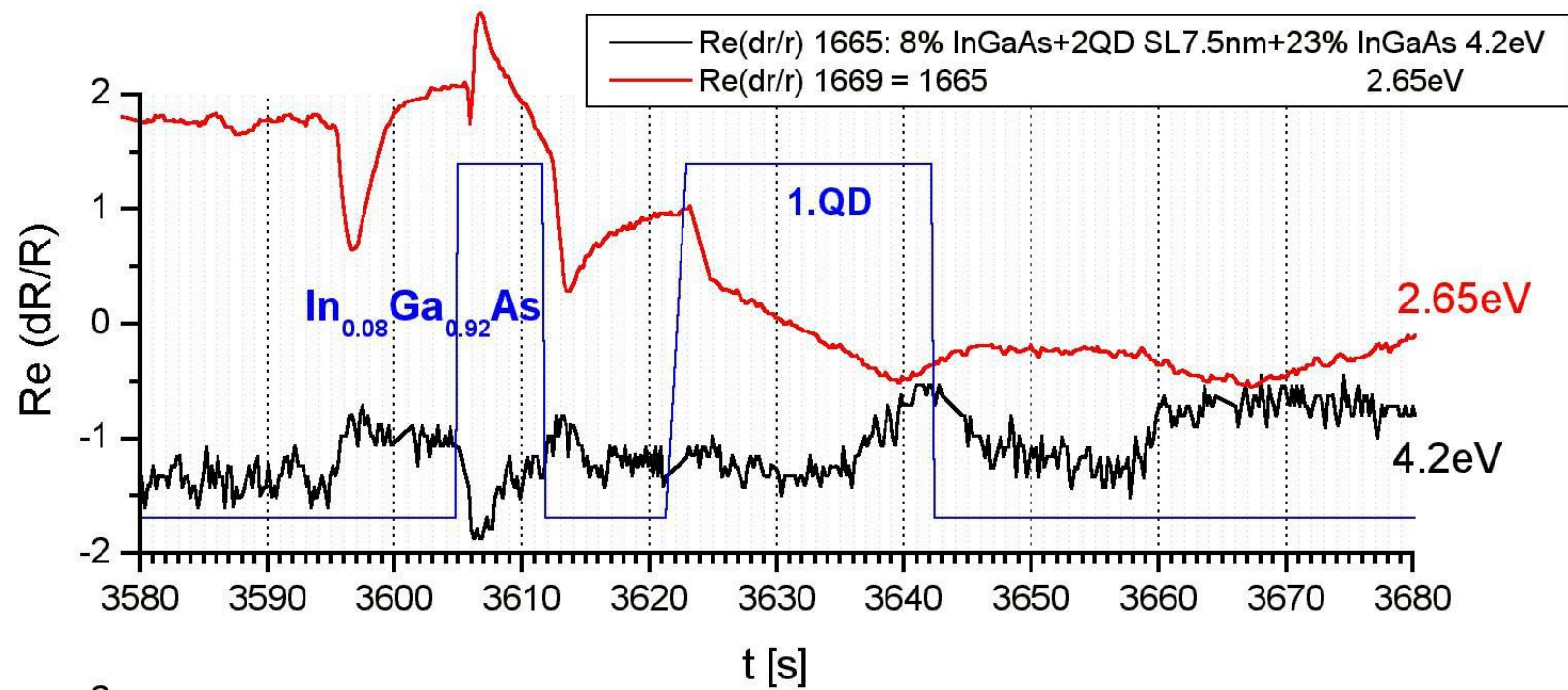
In situ growth monitoring and controlling III

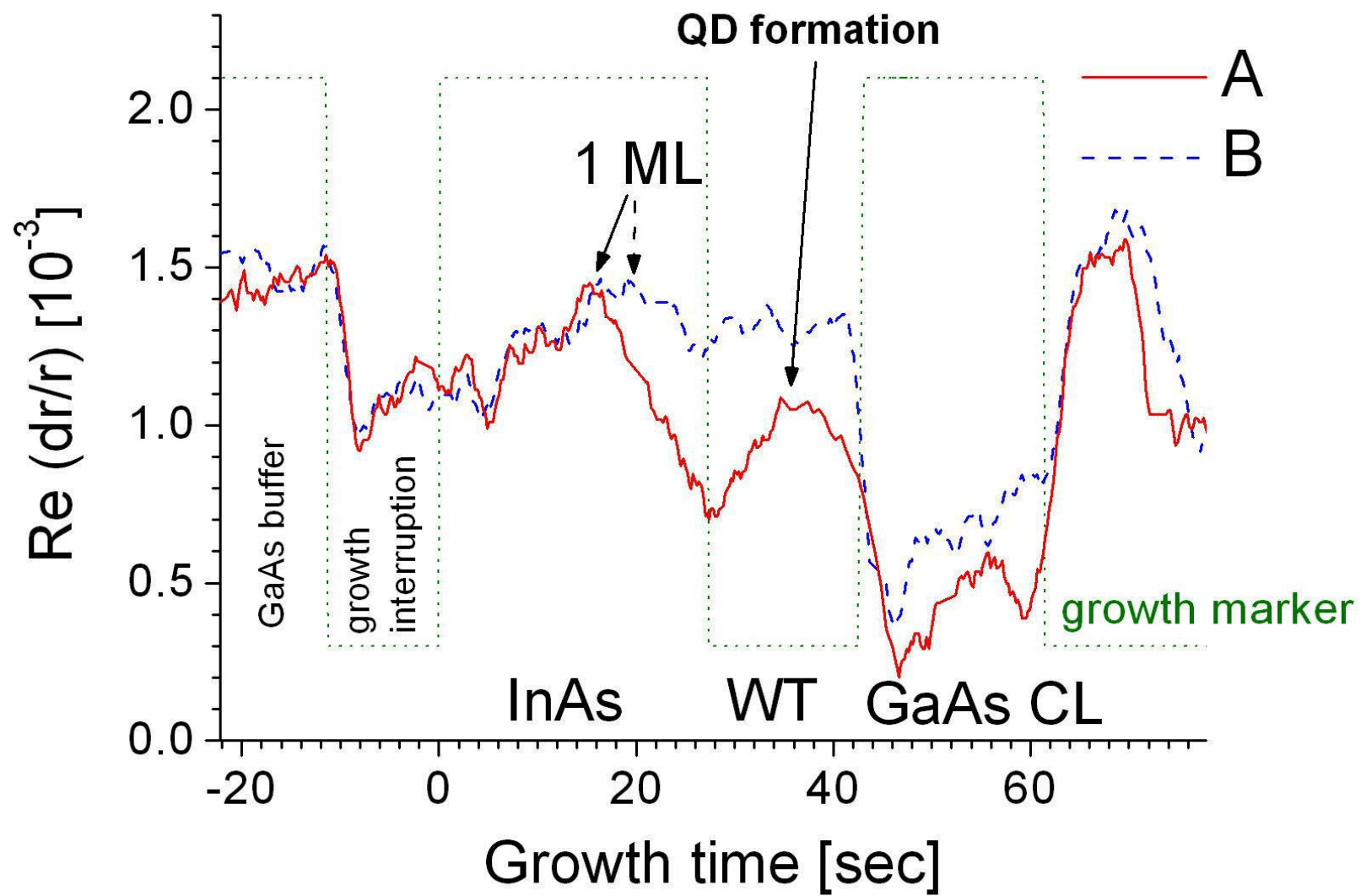
Quantum dot growth



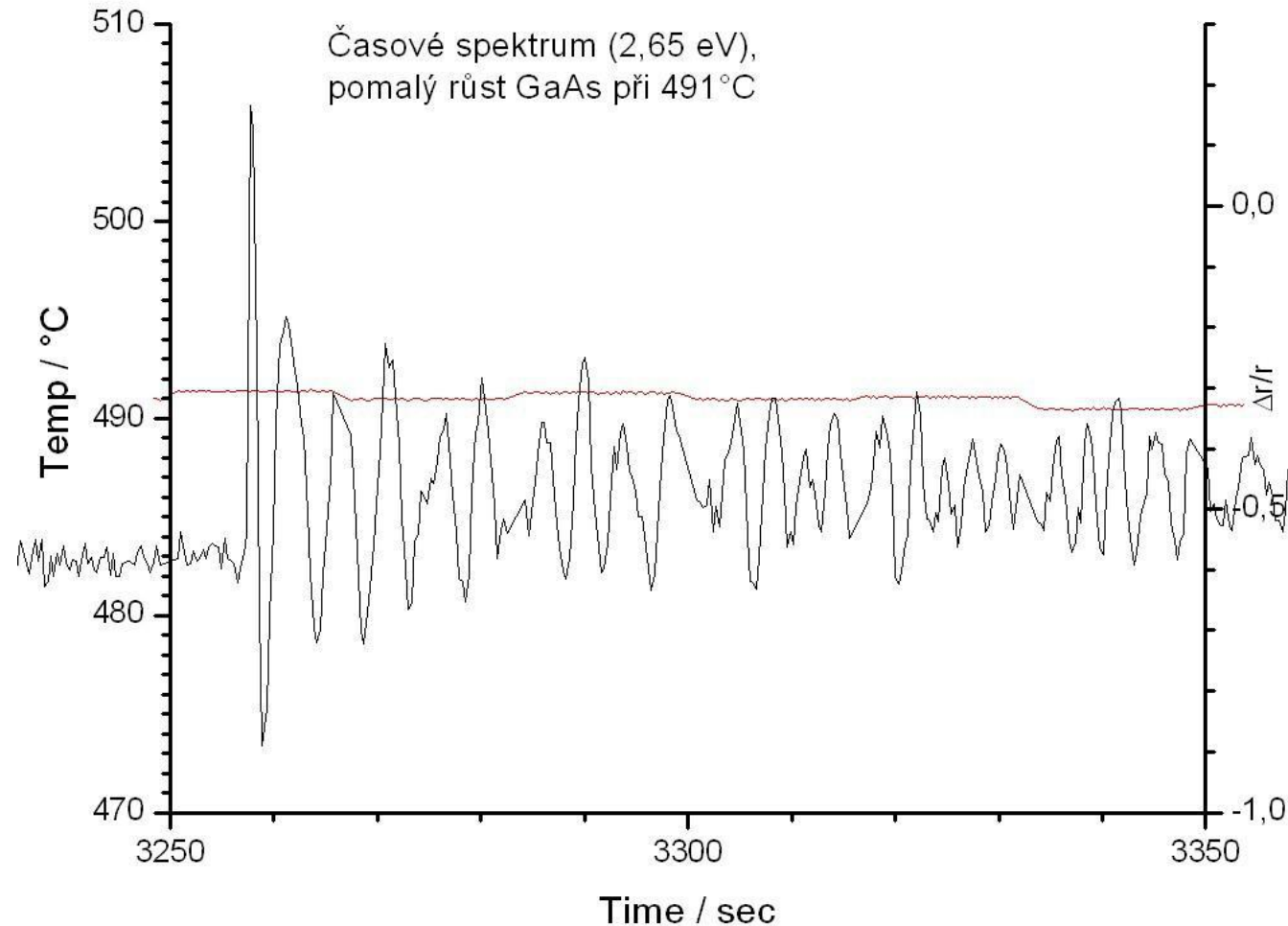
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Other extremely important property of the Reflection Anisotropy Spectroscopy is possibility of monolayer growth oscillations:



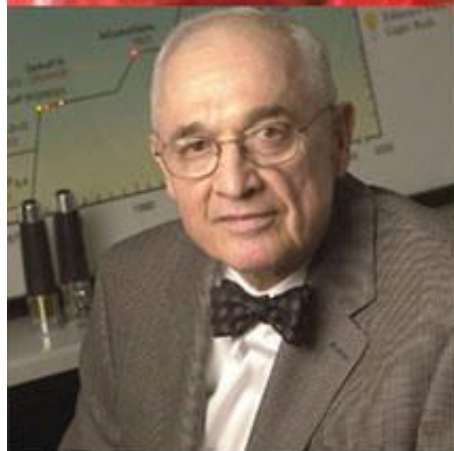
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GaN epitaxy challenges

the first motivation: blue LEDs

LED history



Nick Holonyak
Syracuse, NY

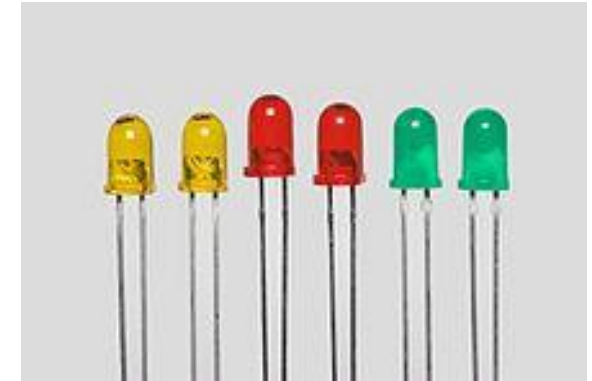
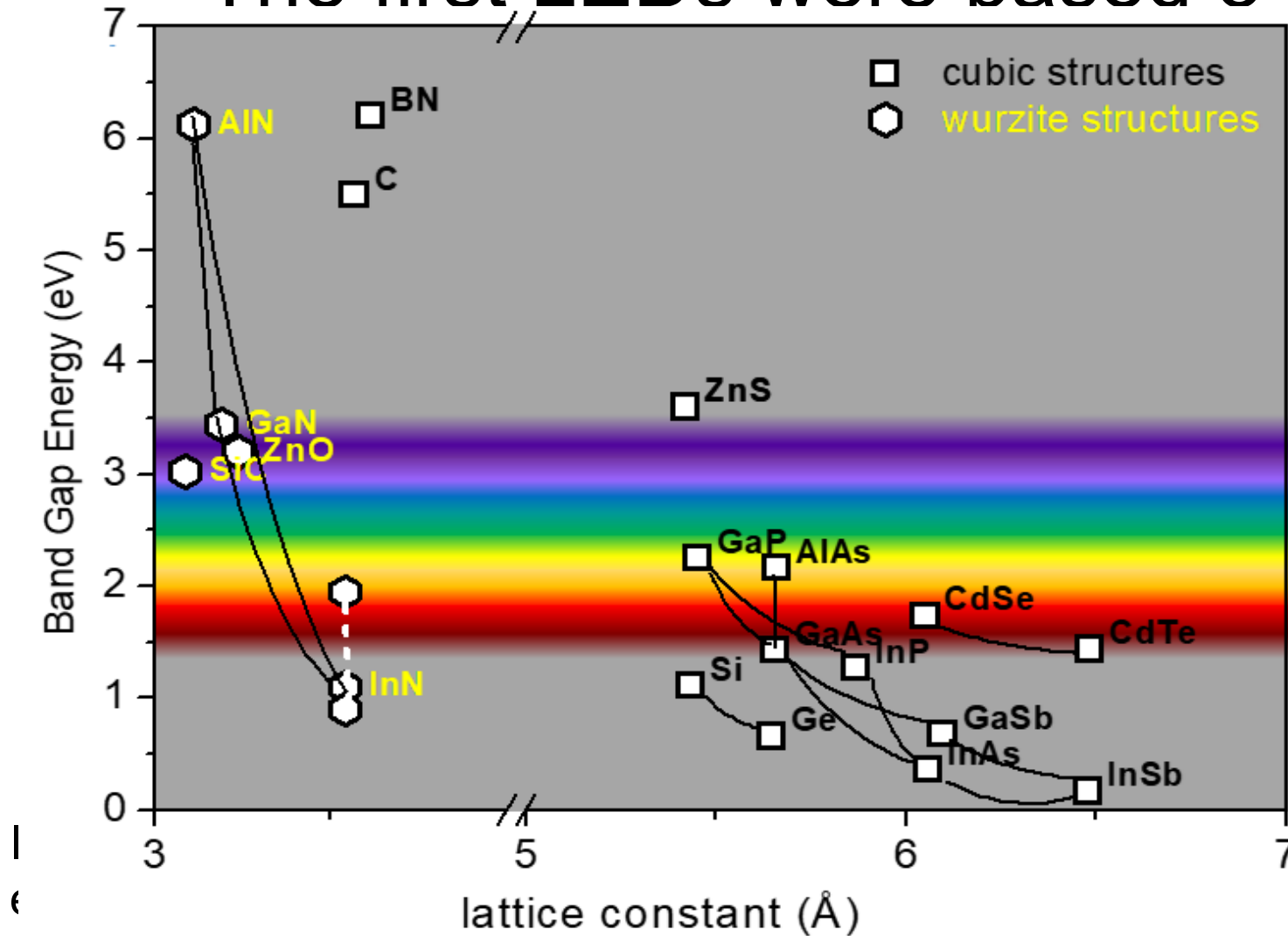


George Craford
St. Louis, MI



*Shuji Nakamura
Tokushima, Japan

The first LEDs were based on phosphides



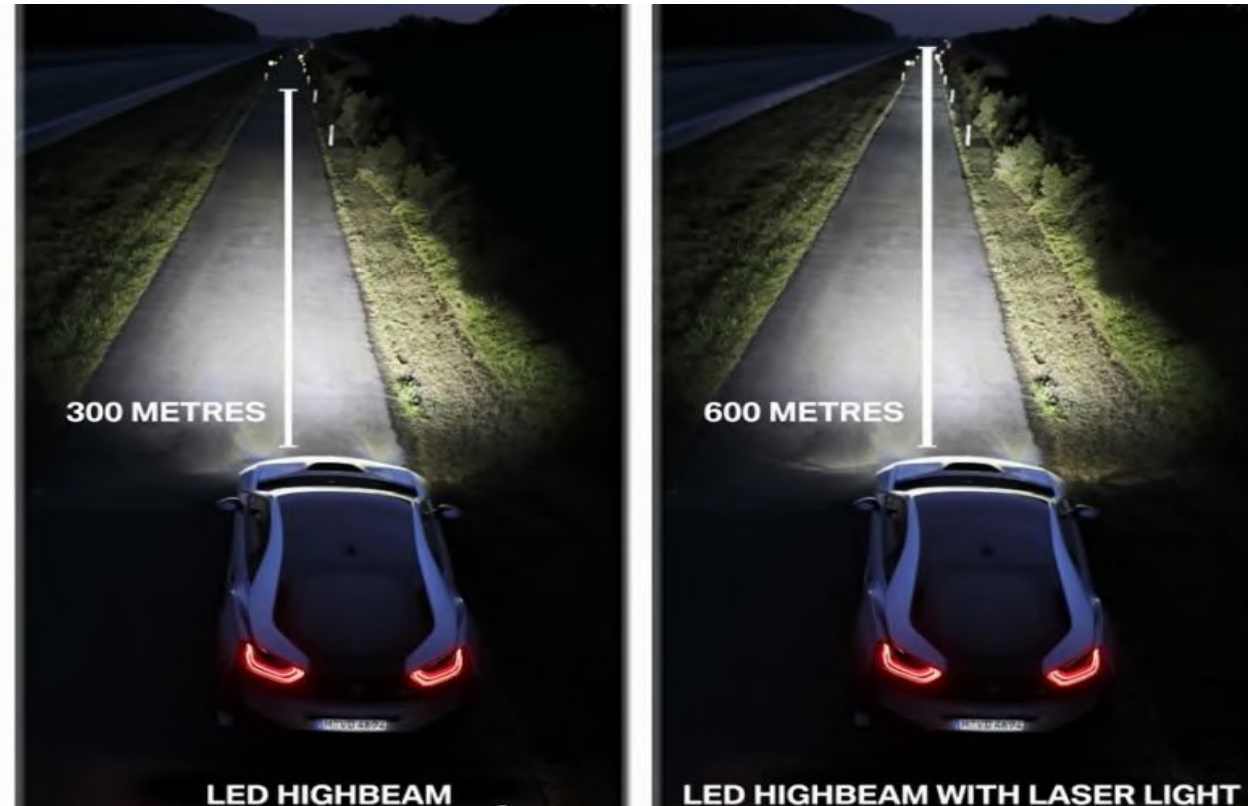
InGaP, GaAsP
and GaP LED

and Heisenberg relations were

Without blue LEDs none of following applications would be possible:

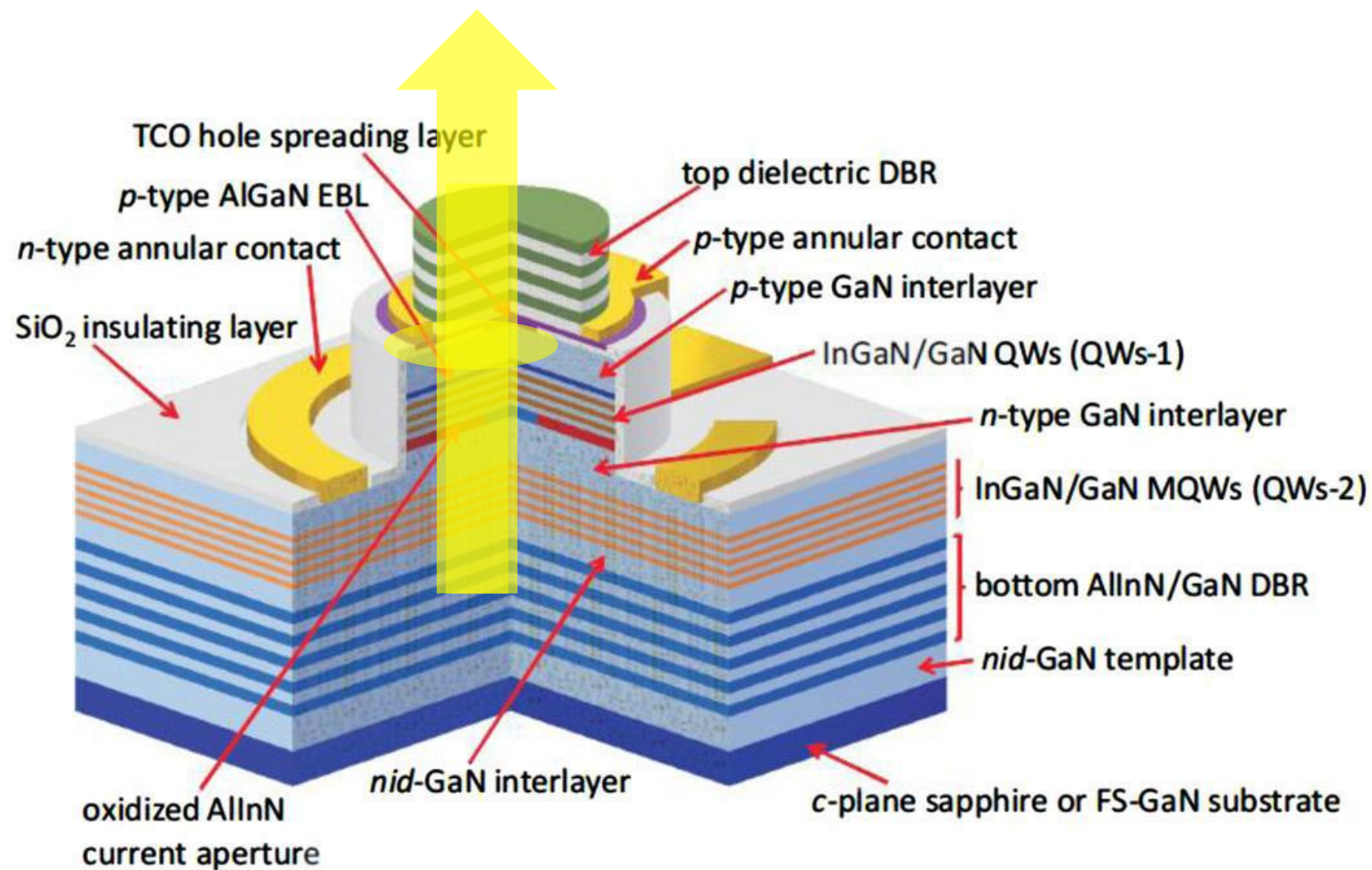


LED high beam for cars



The laser light is used only in most expensive cars, since the main problem is the sufficiently efficient phosphor which has long life time which can transform the laser light.

Blue VCSEL structure



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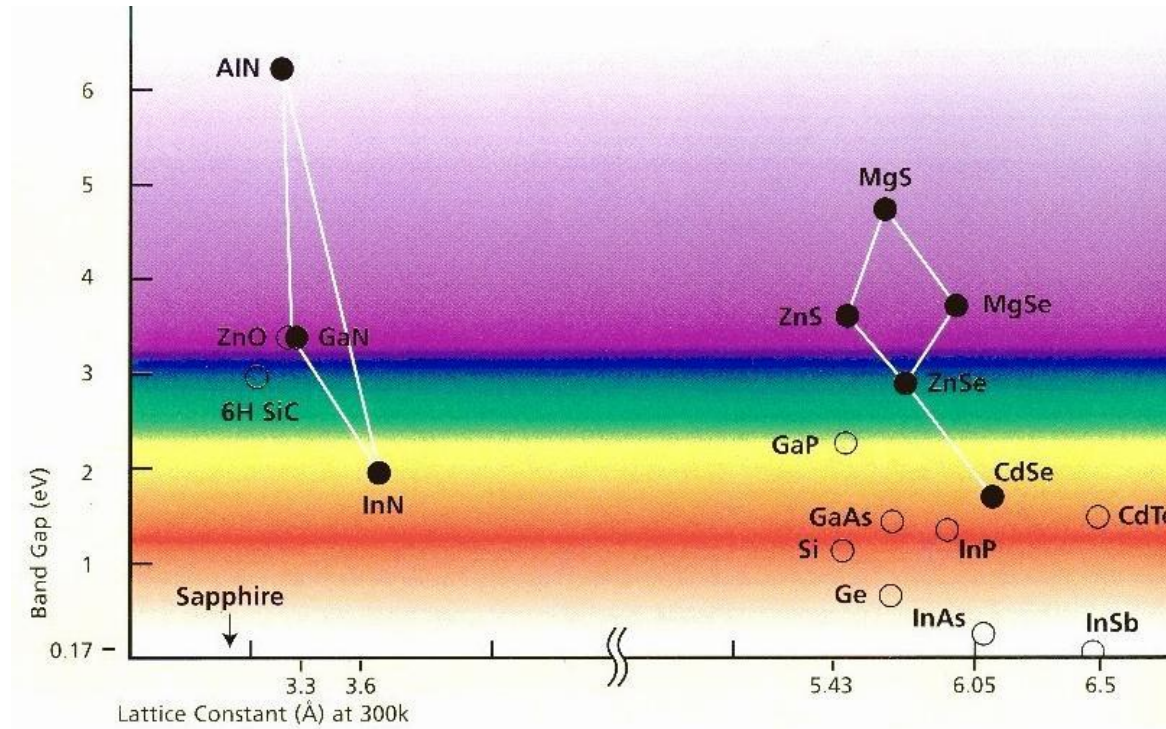
New LED application

Pink green houses 😊



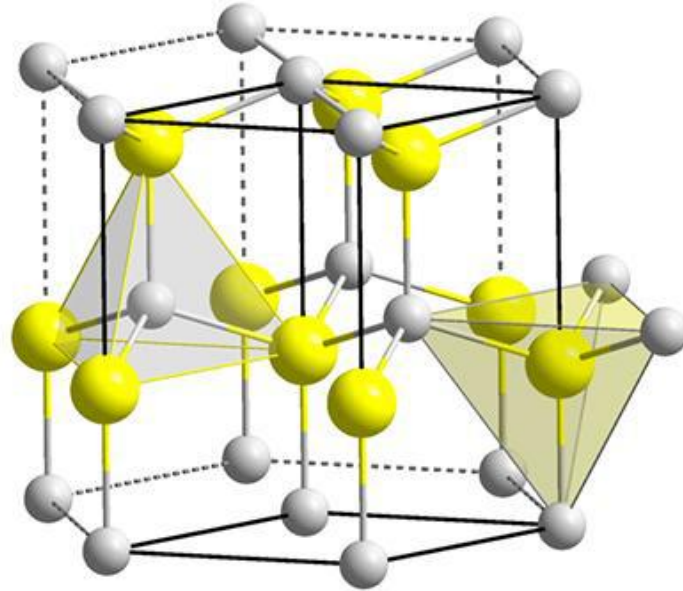
Possible semiconductors for blue LED

Sulfides-selenides, silicon carbide, ZnO or nitrides?



Sulfides-selenides have weak bonds and the lifetime of LEDs was only few hours. SiC is non direct semiconductor with very low luminescence efficiency. ZnO is difficult for doping and it cannot form heterostructures. Nitrides are very suitable, but there were no available substrates for epitaxy.

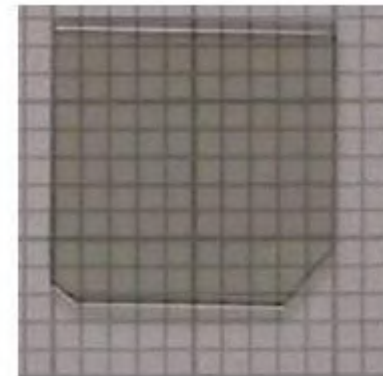
Wurzite structure of GaN



Lattice constants:

$$a = 3.19 \text{ \AA}$$

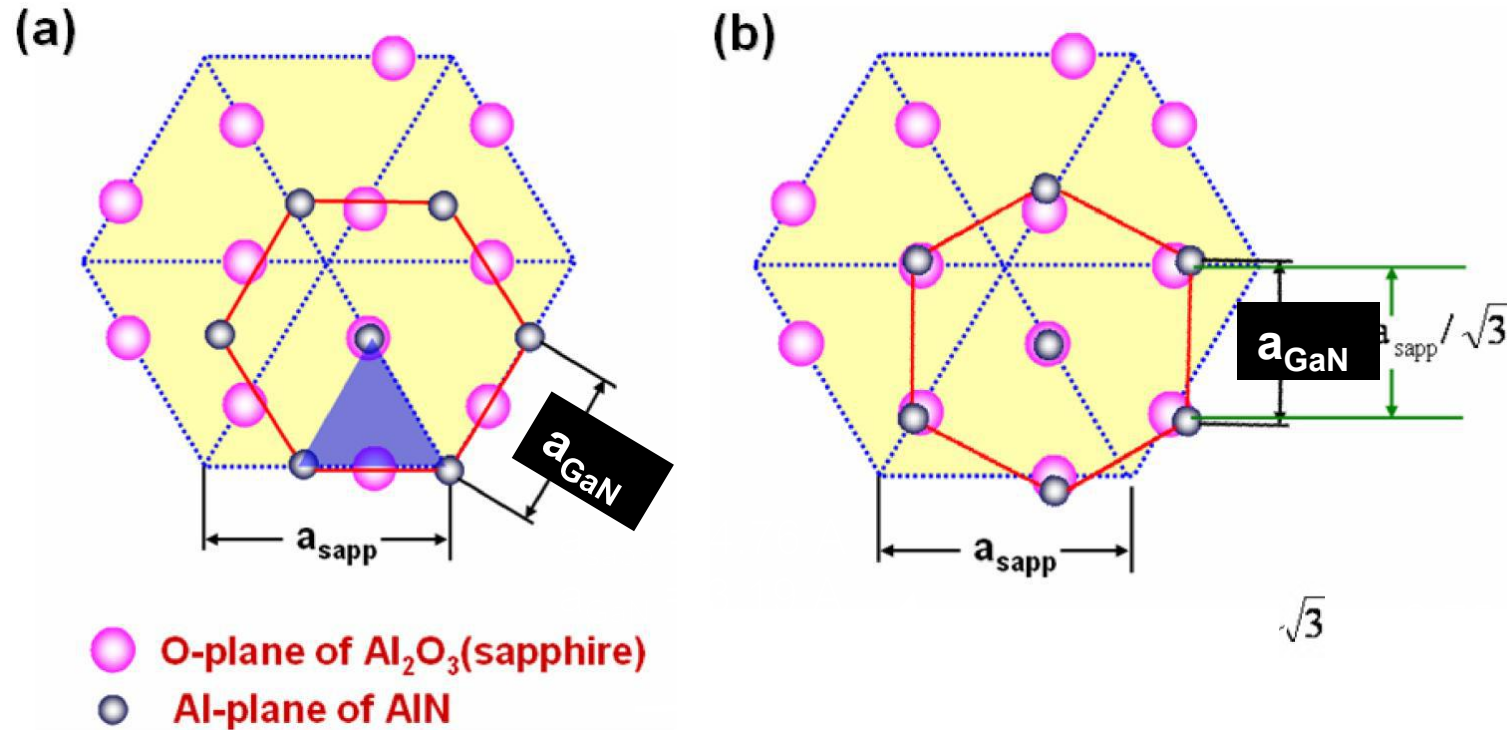
$$c = 5.10 \text{ \AA}$$



Strong binding of atoms:

- High temperature stability
- Difficult to prepare bulk semiconductor

GaN on sapphire substrate



V. P. Kladko et al., Appl. Phys. Lett. 95 (2009) 031907

Sapphire substrates were very promising, but not ideal.
The strain was still too high

Nobel prize laureates for physics 2014



Isamu Akasaki

Hiroshi Amano

Shuji Nakamura

University of Nagoya

Nichia

After 20 years battle this 3 scientist succeeded to improve the growth of GaN on sapphire and to produce the first blue LED



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Japanies soldiers



Jokoi Shoichi

Guamo (Pacific)

Hiroo Onoda

Philipines

Teruo Nakamura

Indonesia

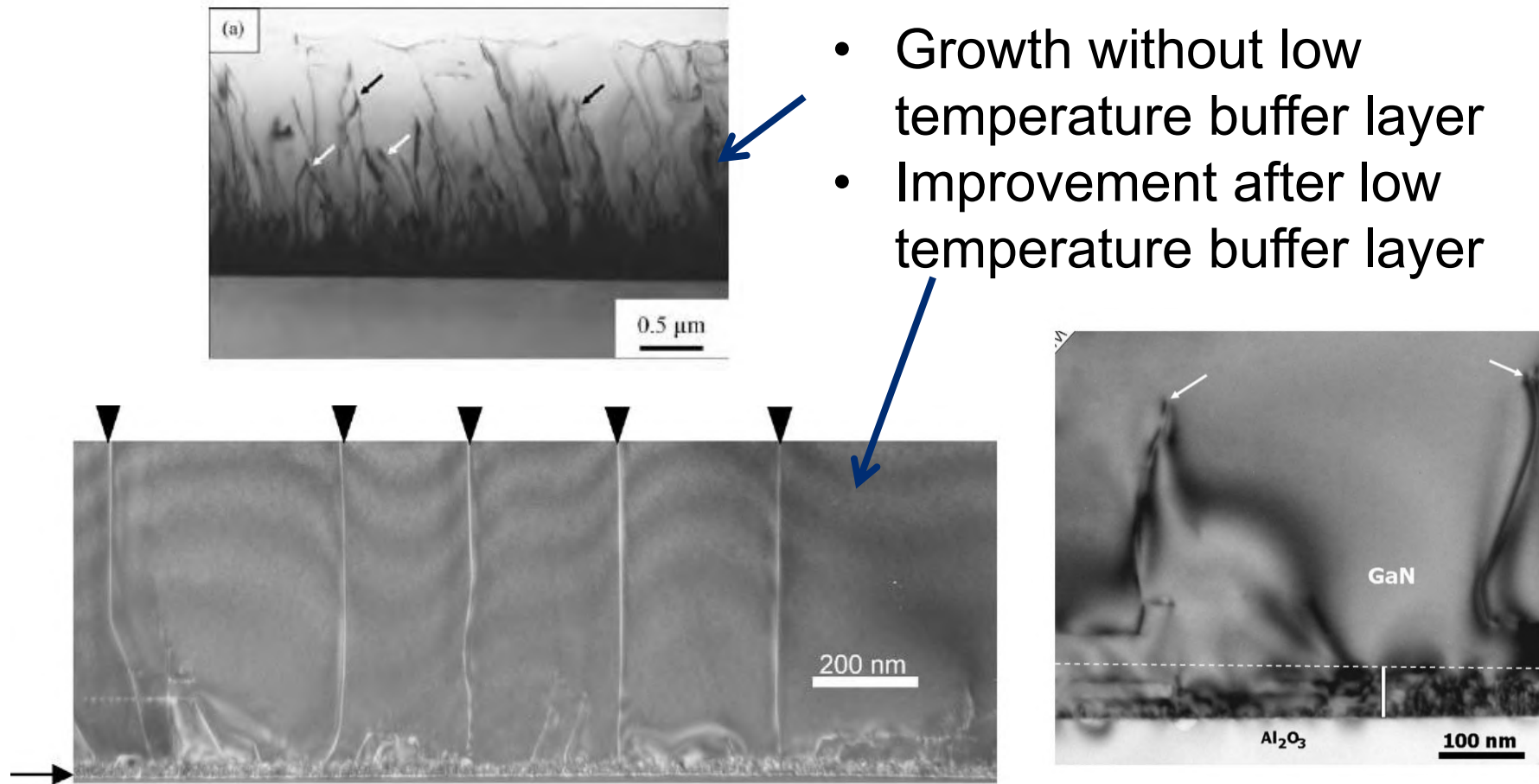
Although their fight was supposed to be as useless as the fight of these 3 Japanies soldiers who did not accept the Japan capitulation and fought against US still in 1970.



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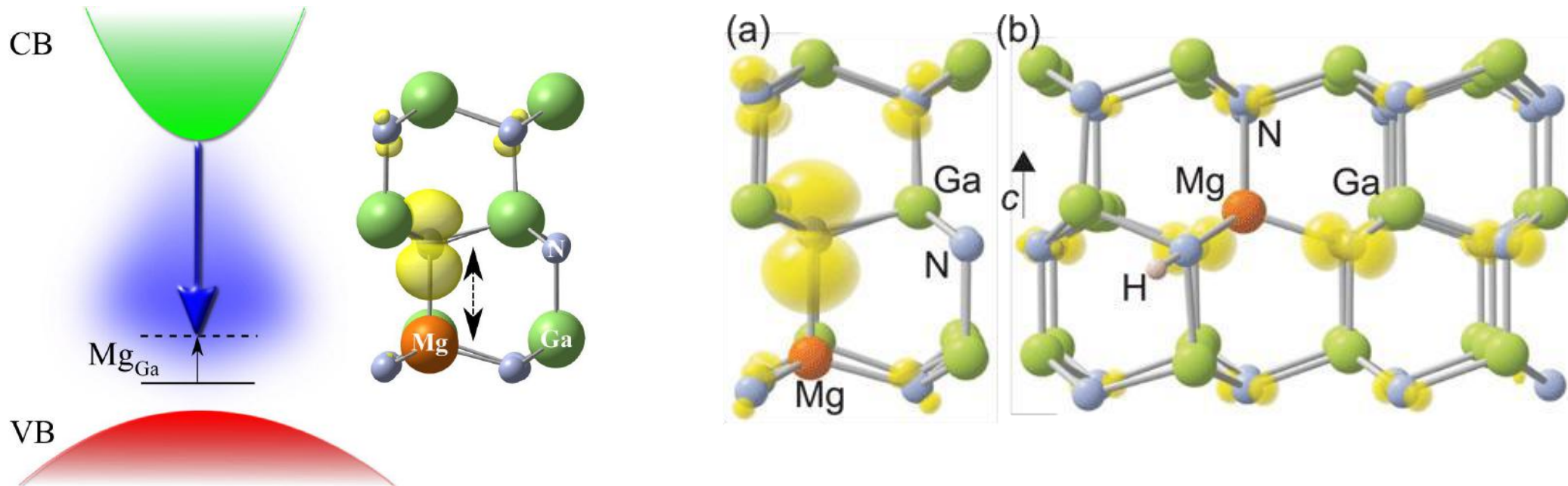
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Dislocation in GaN after epitaxy on sapphire



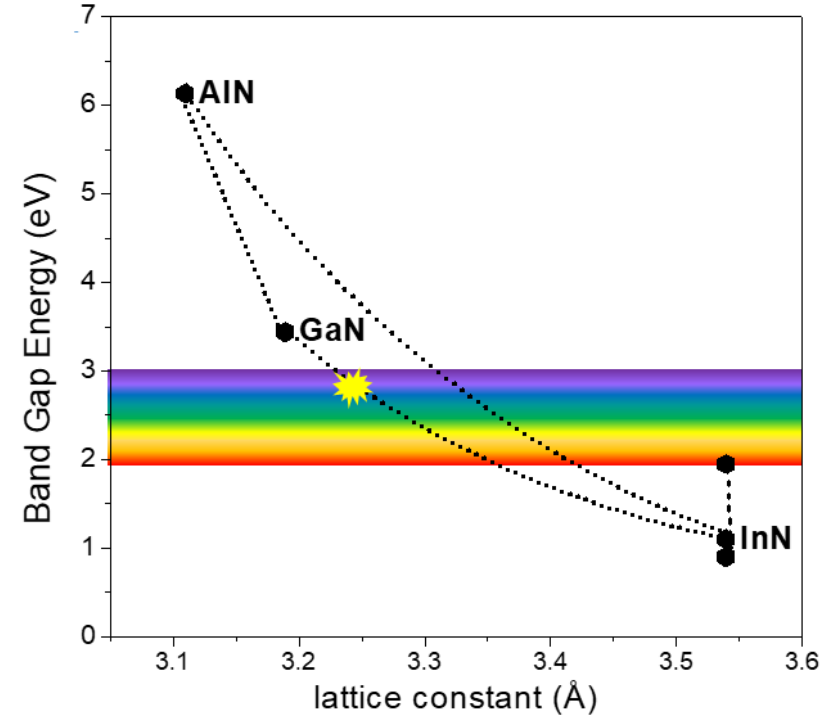
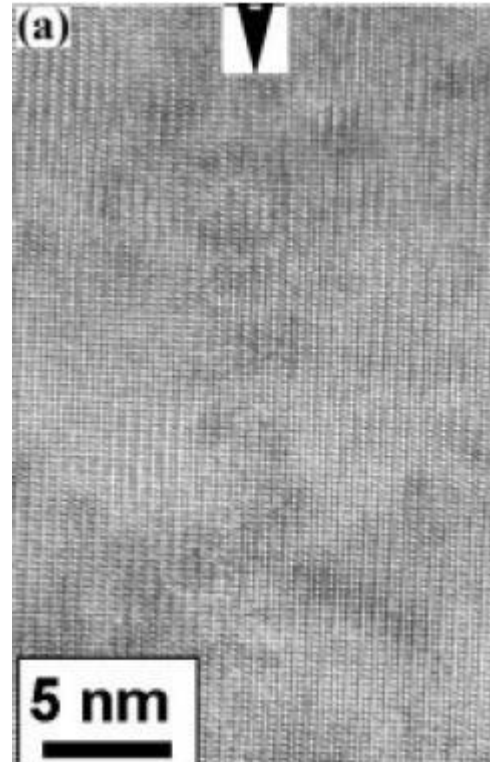
The main idea was to grow the buffer at very low temperature. It resulted in very rough surface which enable to curve the dislocation. Dislocations mutually annihilated and only few of them penetrated into the upper layers.

P-type doping by Mg atoms



Another problem was p-type doping. Mg was supposed to be suitable dopant, but although there was enough Mg atoms incorporated in layers, they did not have p-type conductivity. The reason was H atoms on neighbour nitrogens, which compensated effect of Mg acceptors. Annealing in N₂ atmosphere helped to solve this problem.

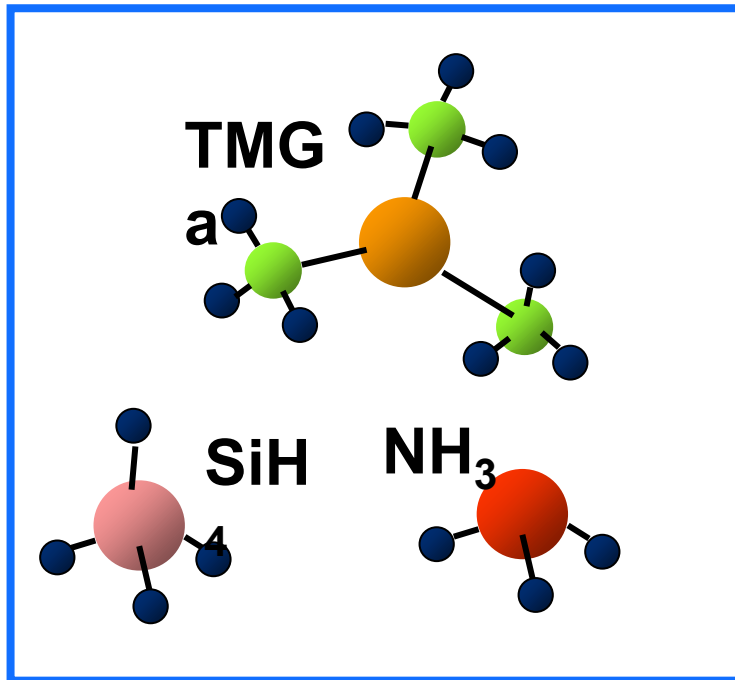
InGaN QW – blue luminescence



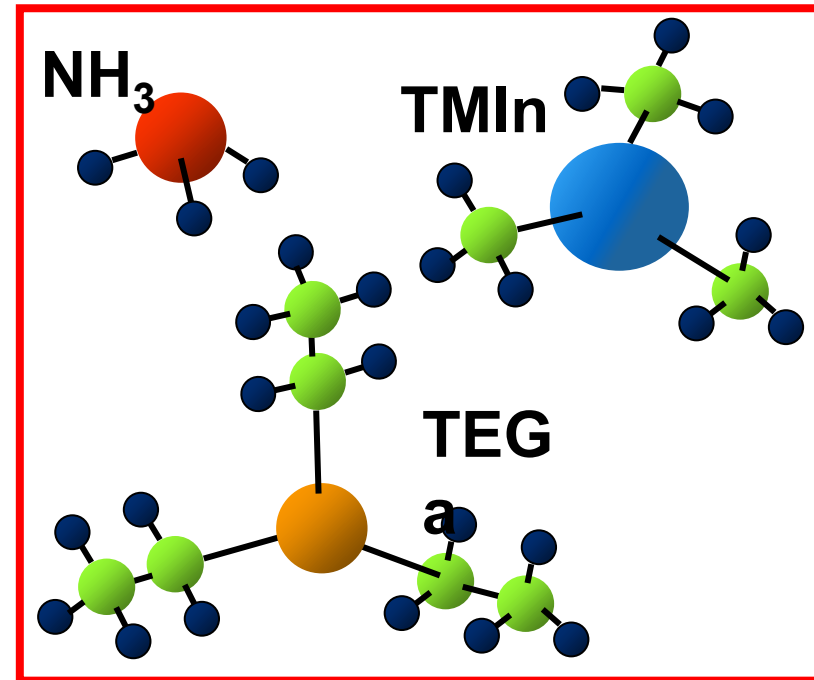
GaN have luminescence in UV region. To obtain Blue light big In atoms were incorporated in GaN lattice. InGaN layers were later prepared as thin quantum well layers (QW) which significantly enhanced luminescence efficiency.

Precursor molecules

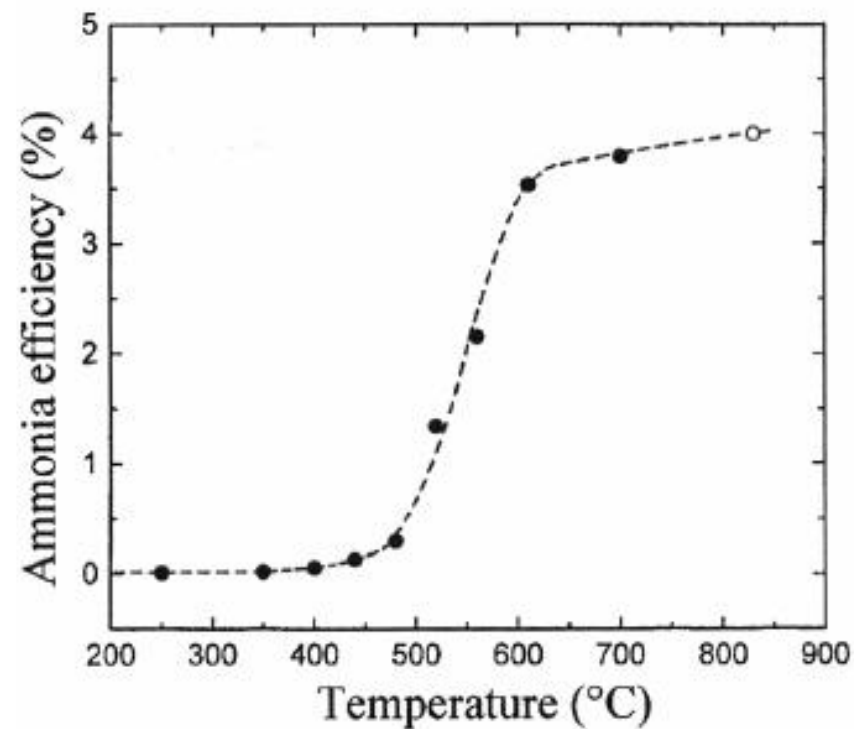
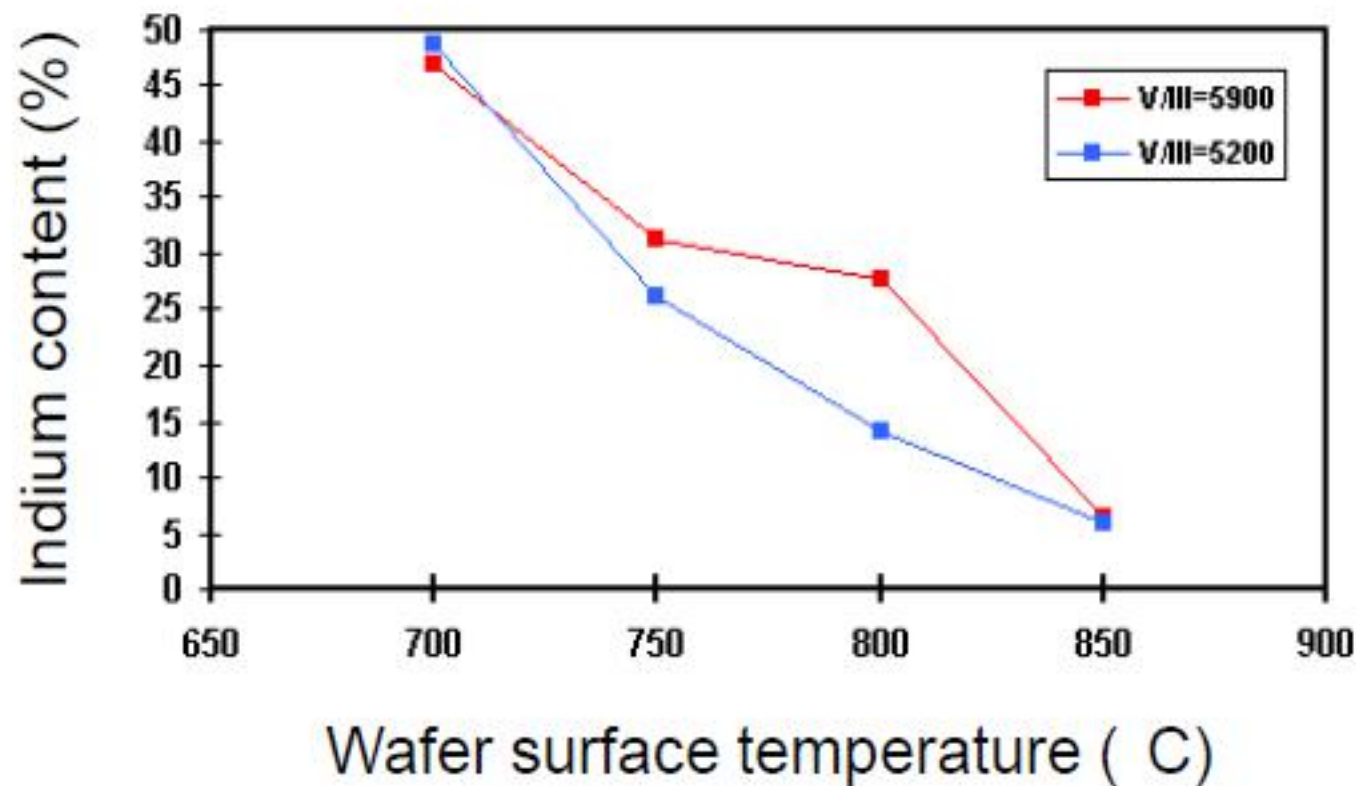
Buffer
carrier gas: H₂



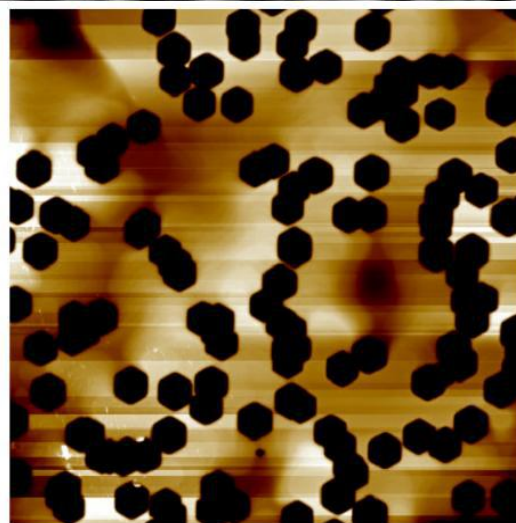
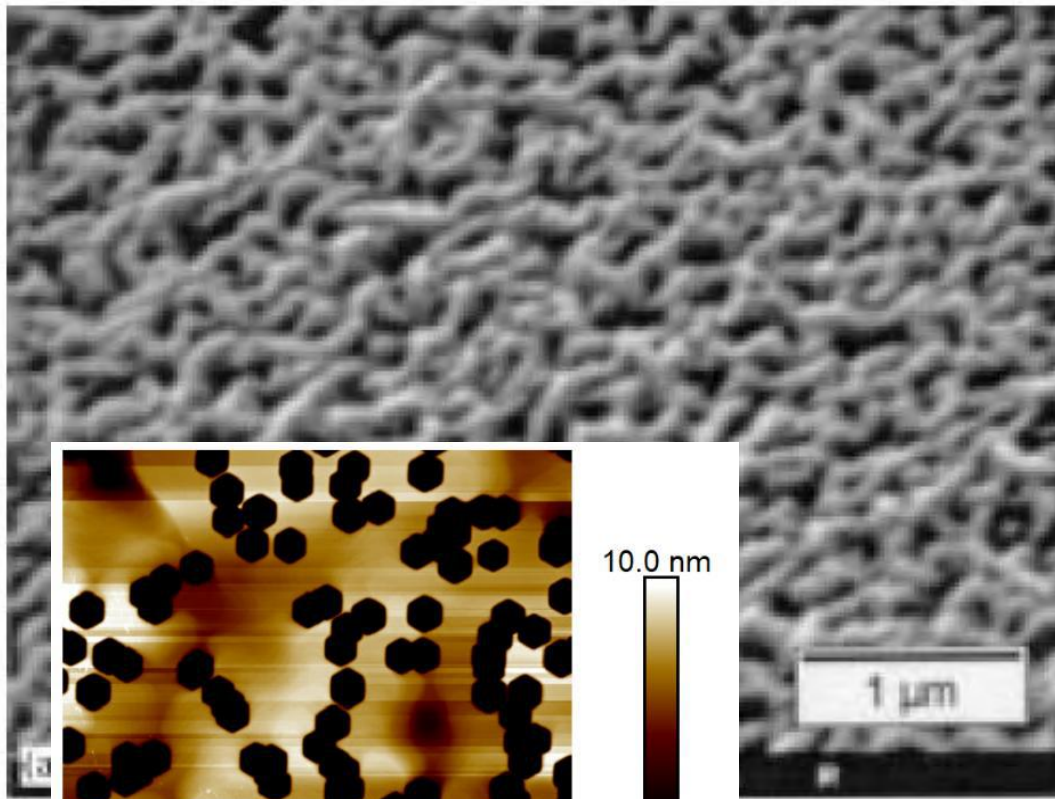
QW
carrier gas N₂



InGaN

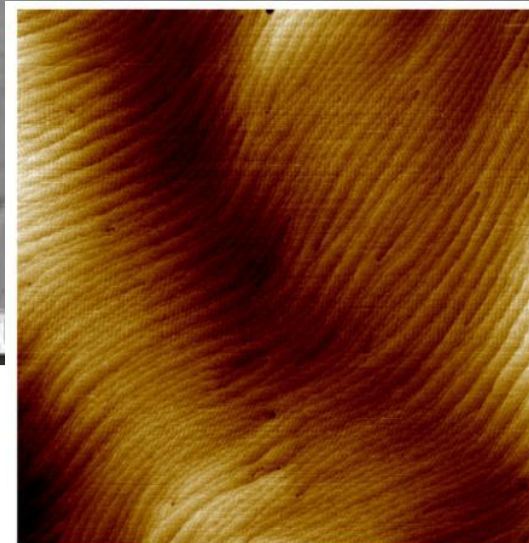
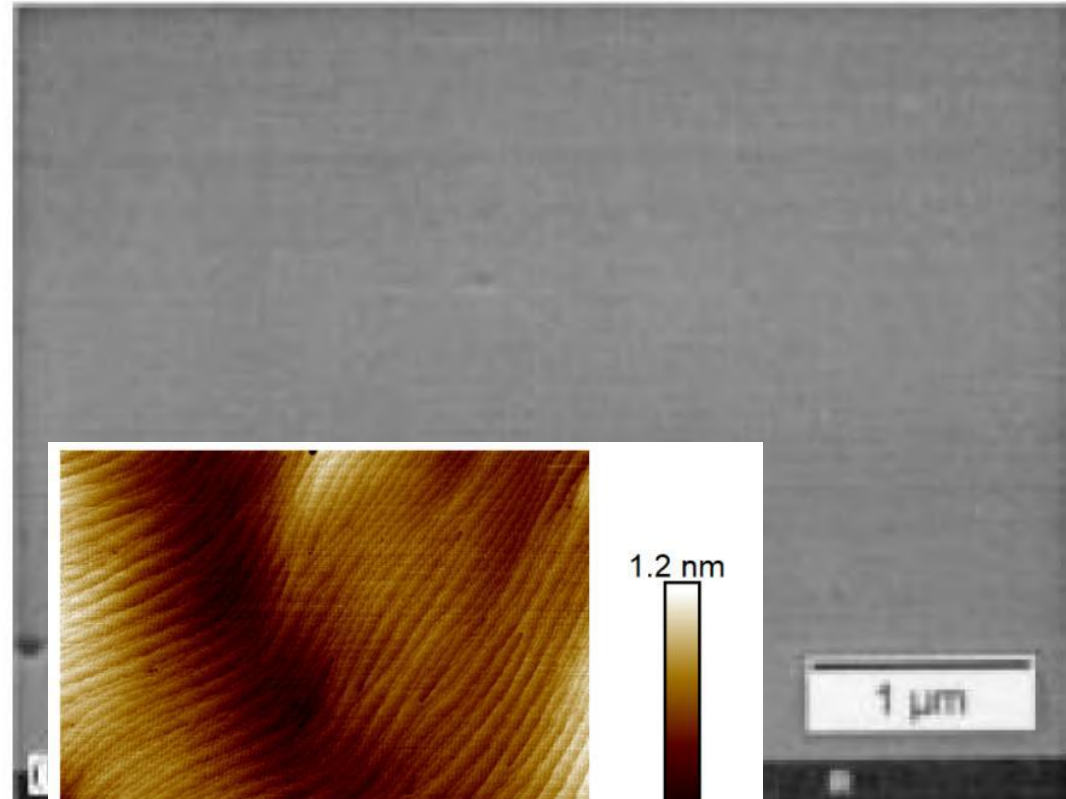


Growth in N₂ and H₂ atmosphere



Height Sensor

1.0 μm



Height Sensor

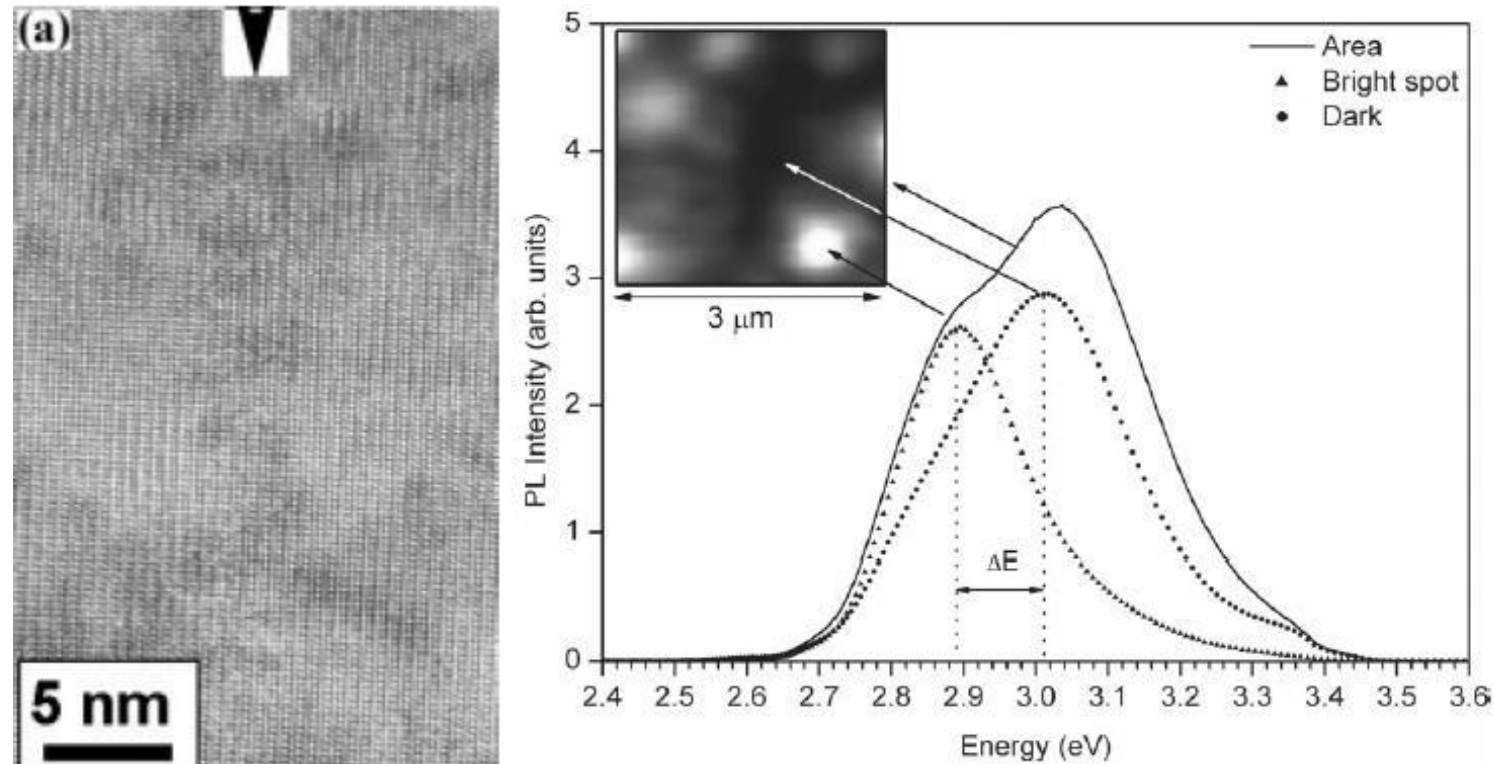
1.0 μm



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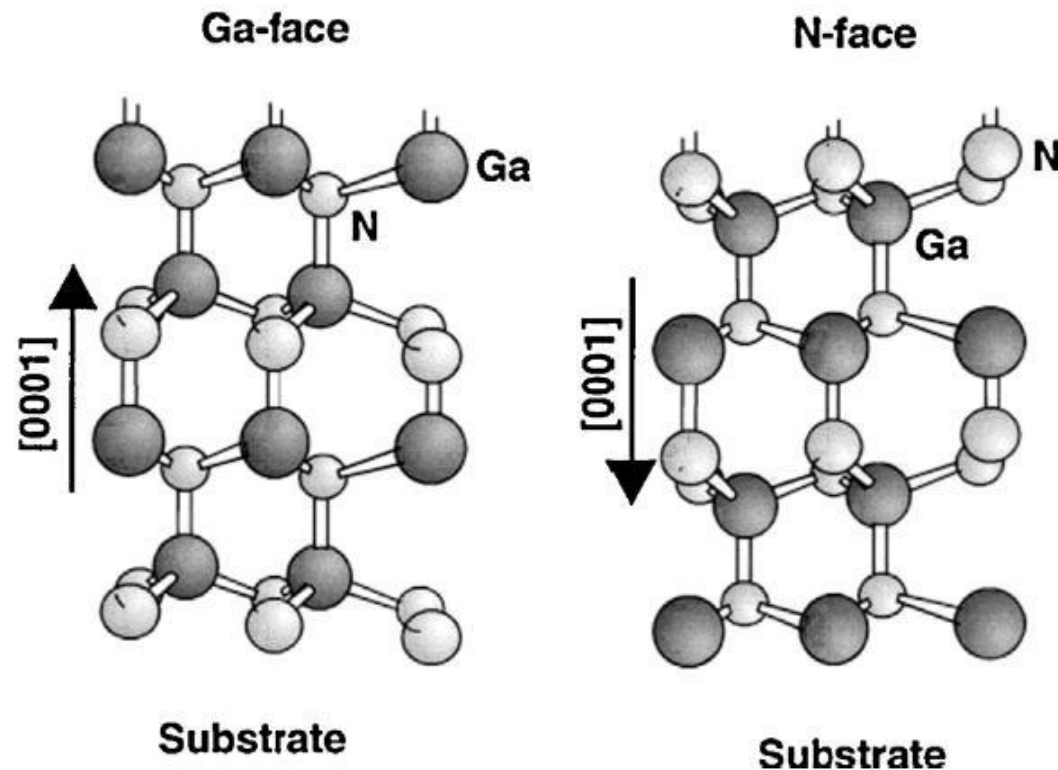
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InGaN QW – increased luminescence intensity



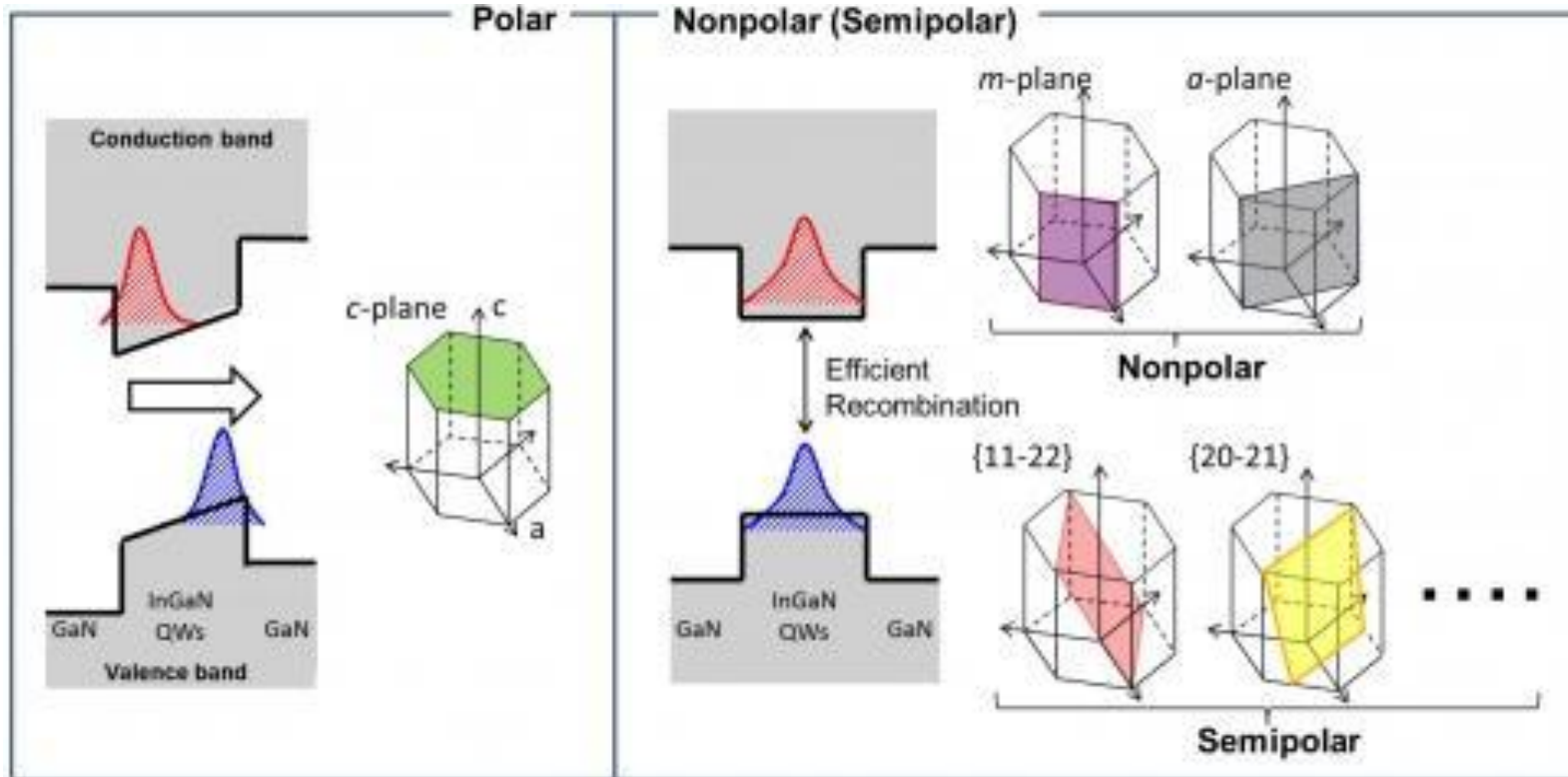
Luminescence intensity is increased in places with higher In content (potential wells for carriers)

Polar surfaces



Very important are polarization properties of nitrides which are caused by non equivalent bonds in wurzite structure. For luminescence applications the polarization is harming, but in HEMTs

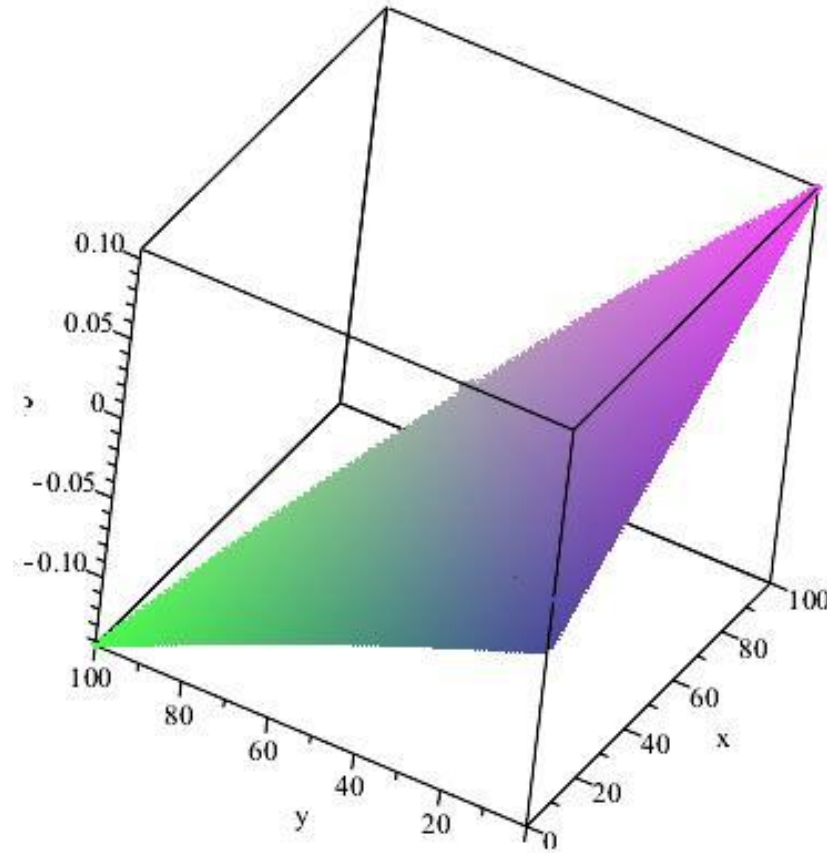
Electric field between polar and nonpolar heterojunctions



In InGaN QWs the polarization field separates spatially electrons and holes, their wave function overlap is lower and luminescence efficiency is suppressed.

Polarization in AlInGaN layer on GaN

Polarization of $\text{Al}_y\text{In}_x\text{Ga}_{1-x-y}\text{N}$ layer with respect to the GaN as a function of Al and In content in the layer



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Substrates for nitrides

➤ Substrate material properties for GaN deposition:

	Coefficient of linear thermal expansion ($\times 10^{-6}$)K ⁻¹	Lattice Mismatch (%)
Al ₂ O ₃ (C)	> 8	13.8
SiC	~ 2.8	3.6
GaN	3.17	0
AlN	5.27	2.5
Si	2.6	17

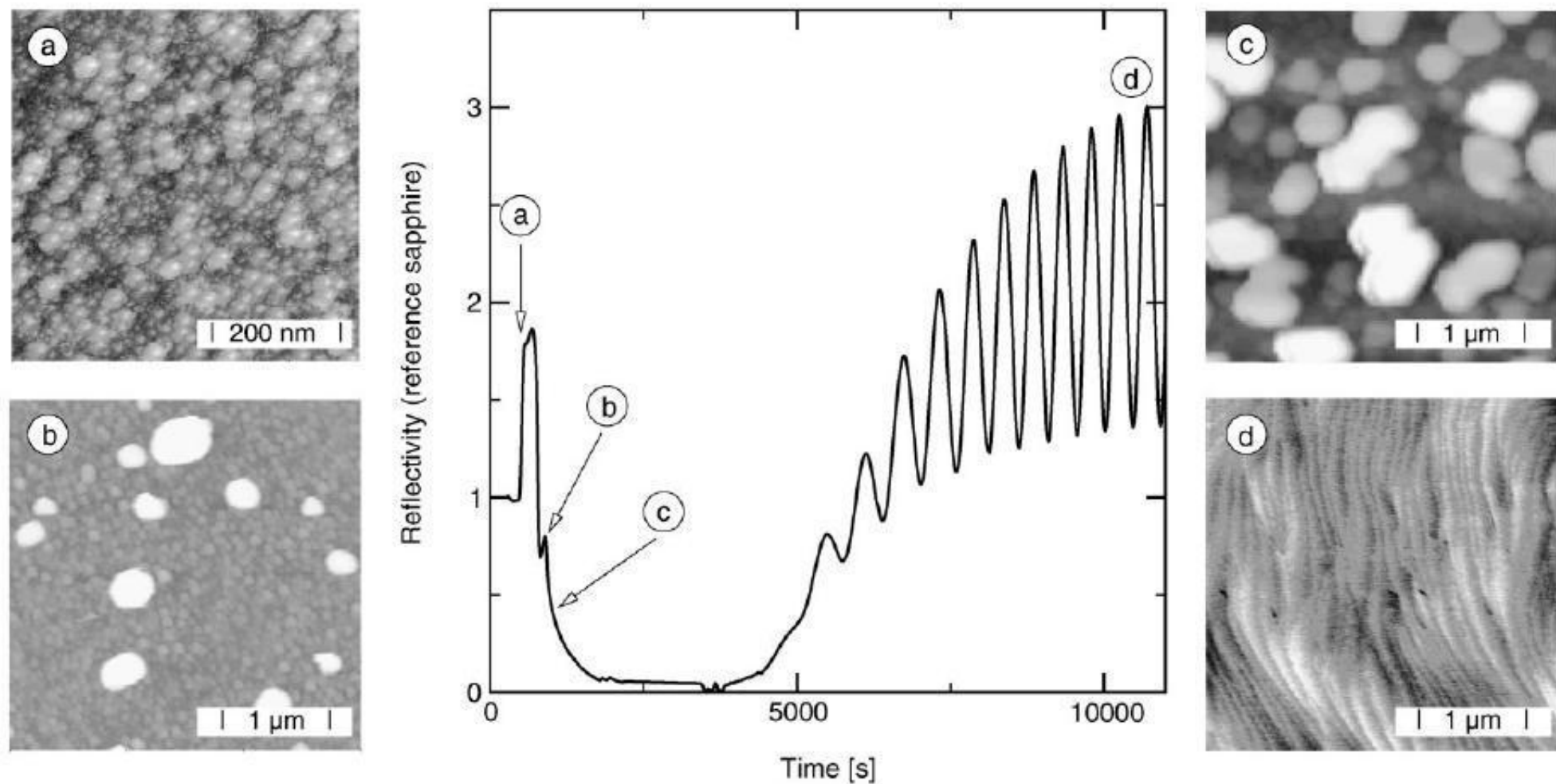
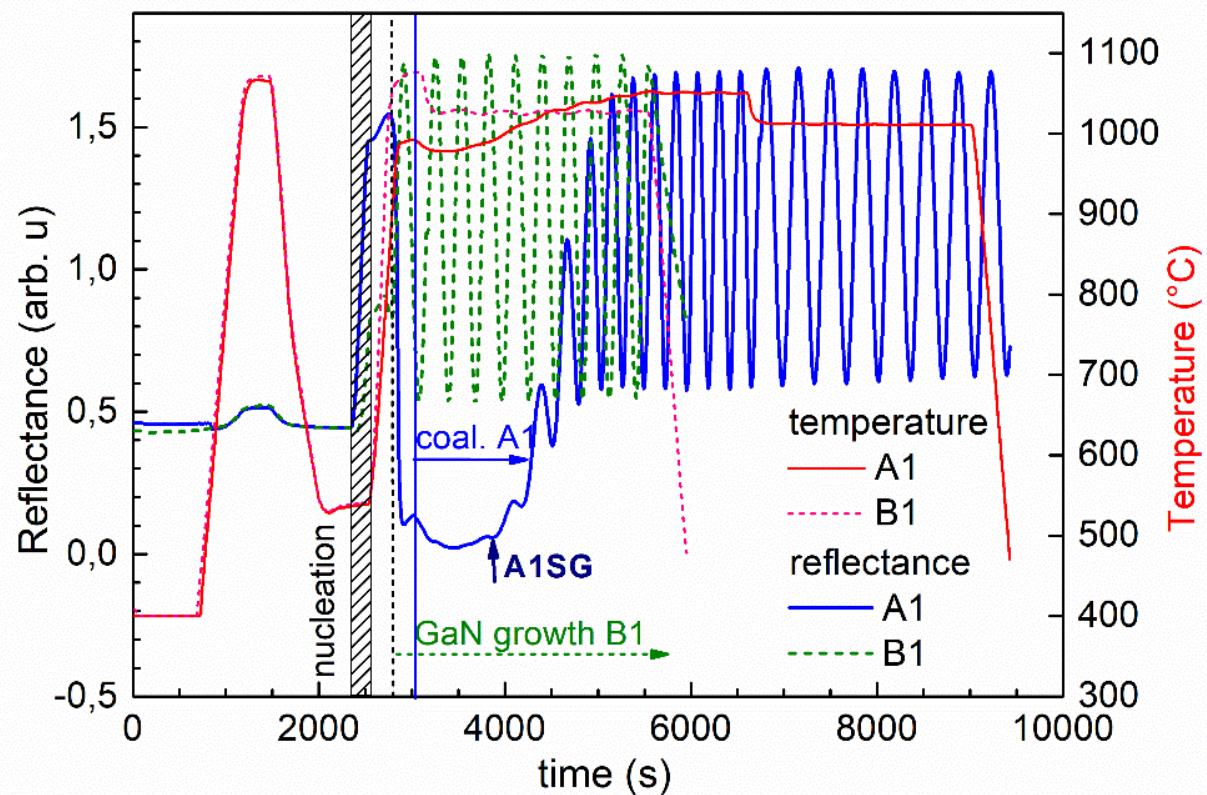


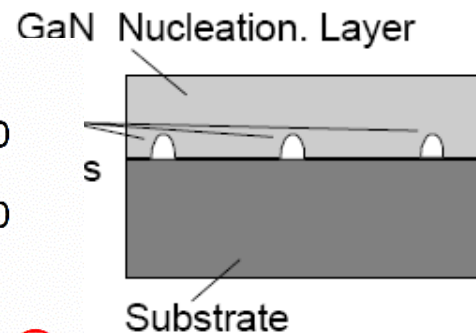
Fig. 2. Typical reflectance transient taken from a GaN growth run. AFM insets show the morphology at different stages of growth as the nucleation layer before (a) and after recrystallization (b), at the start of epilayer growth (c) and the final surface with atomic steps after coalescence (d).



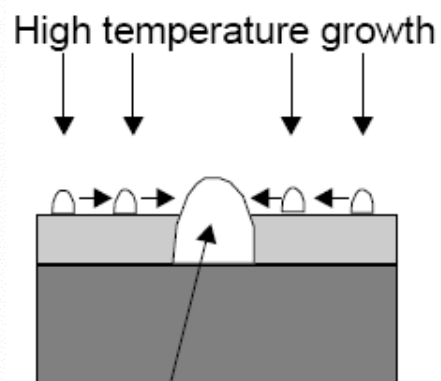


O

After deposition

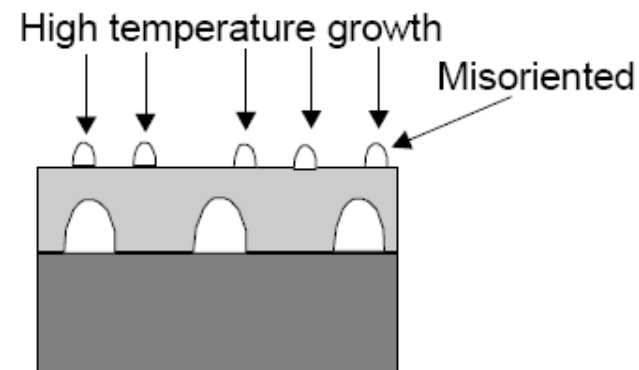


Optimal annealing

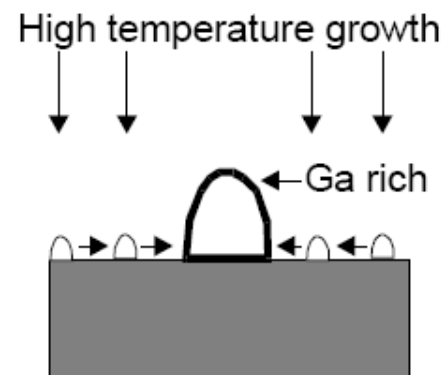


Single-crystal nucleated site, re-arranged in direction of c-axis and a-axis

Too short annealing



Too long annealing



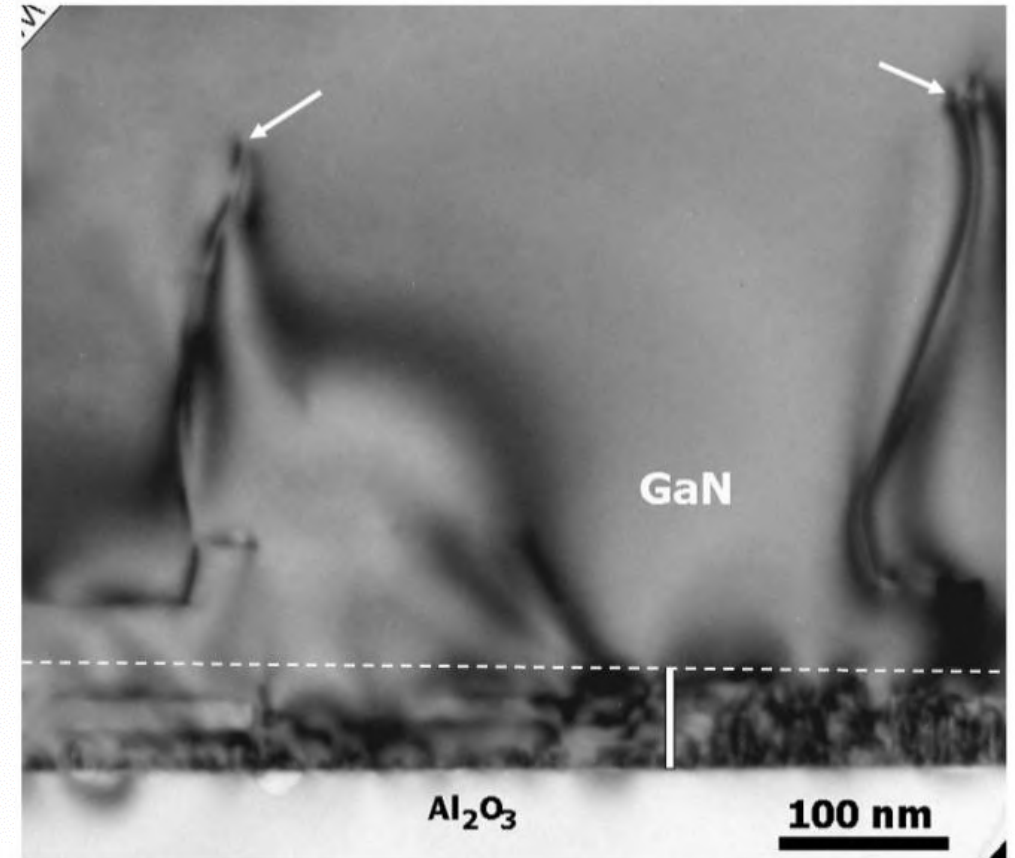
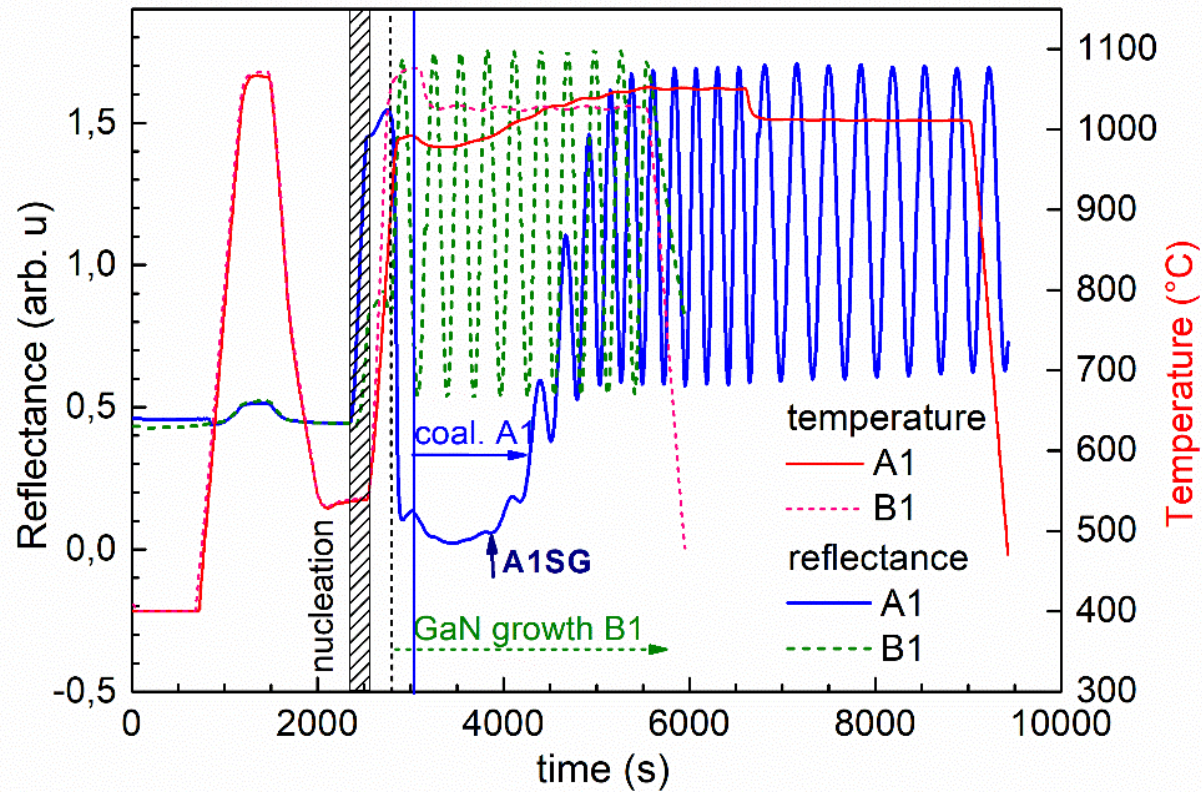
Nitrogen re-evaporation



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Our structures suppression of dislocation density



Increasing the coalescence time by V/III ratio

Table 1
Growth conditions of each sample

Sample number	V/III ratio	Initial growth time (s)
S1	1760	0
S2	970	500
S3	970	940
S4	580	500
S5	580	940

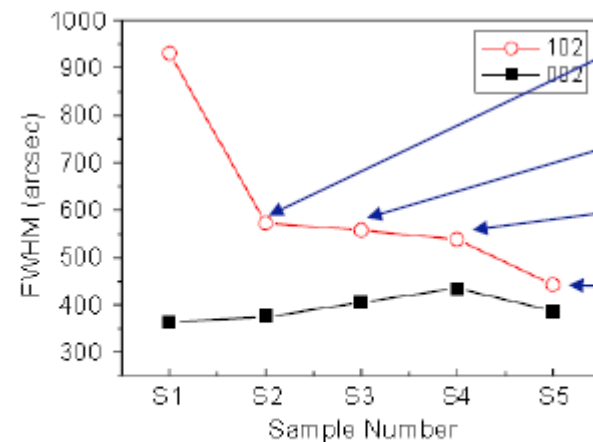


Fig. 3. FWHM values of X-ray rocking curves with different V/III ratios during the initial growth time.

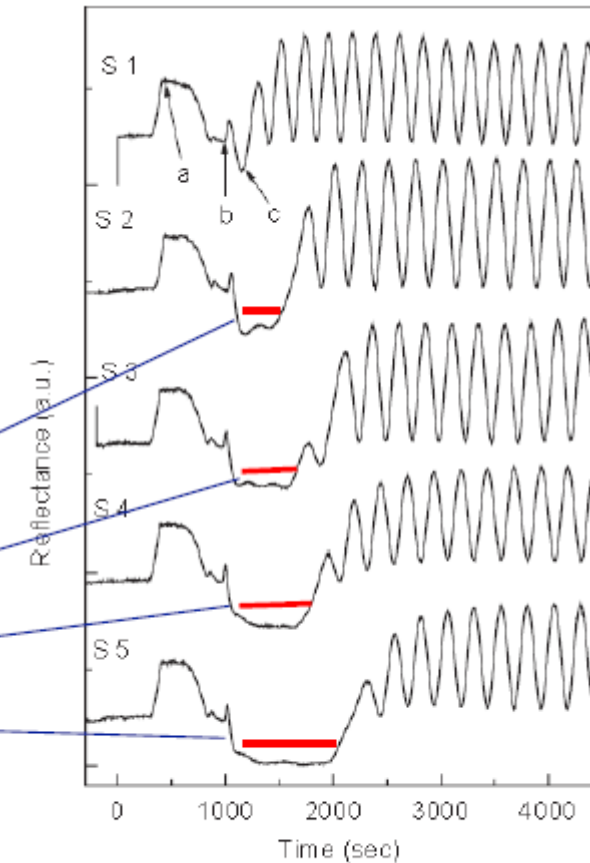
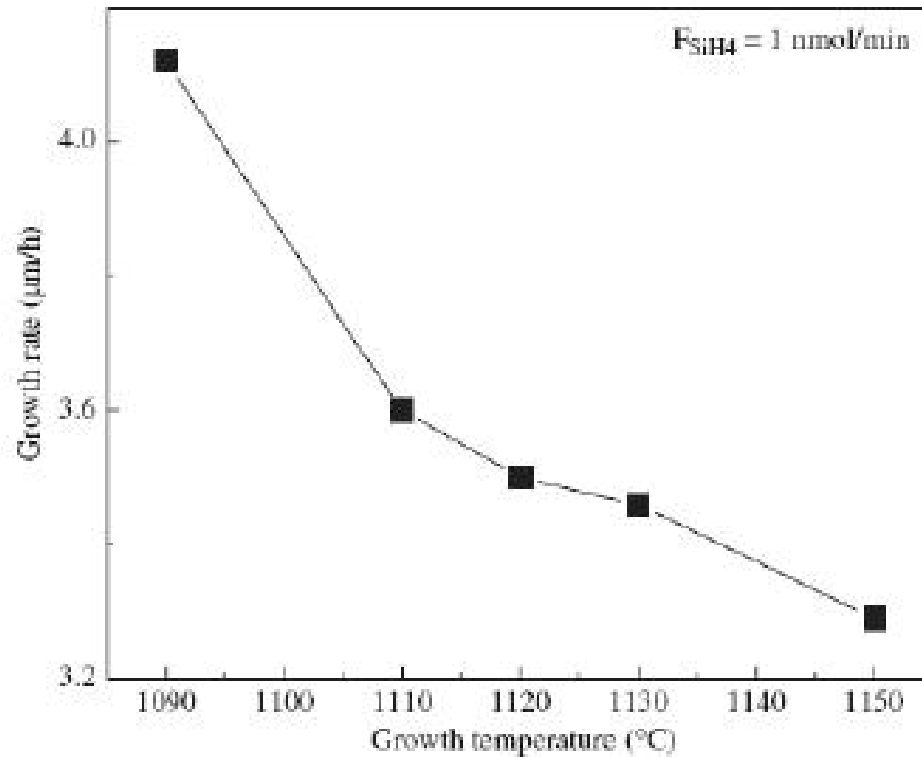
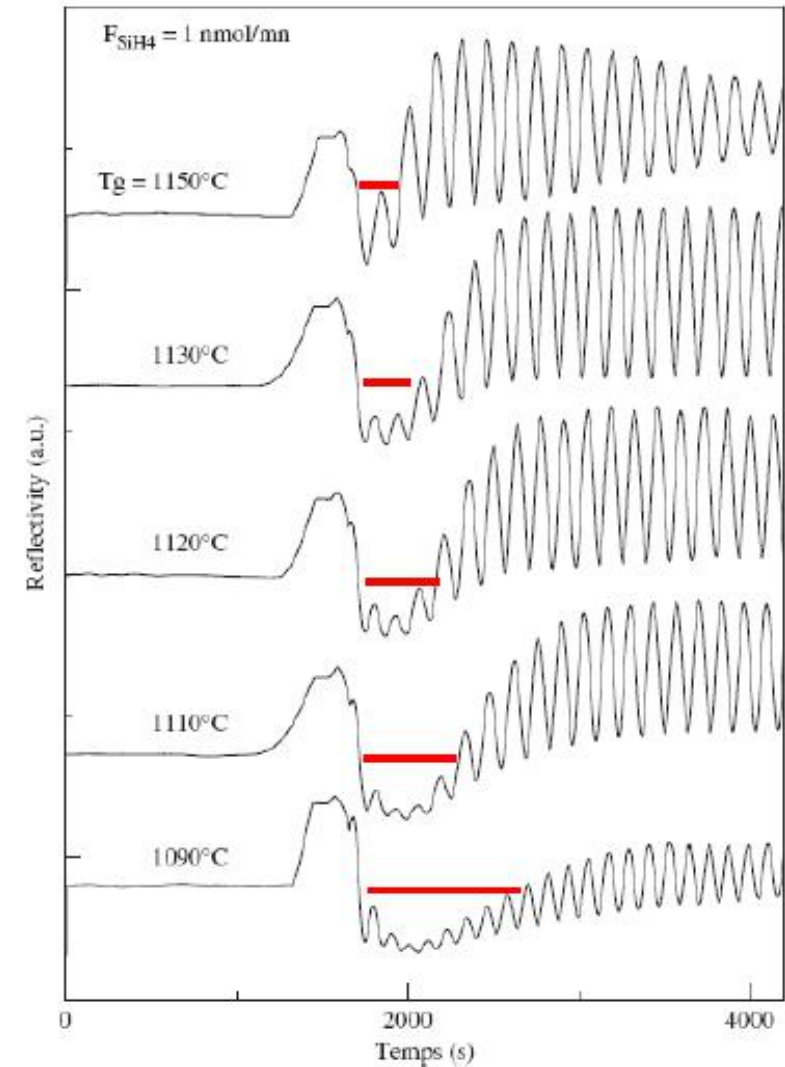


Fig. 2. Reflectance traces of five samples with different V/III ratios during the initial growth time.

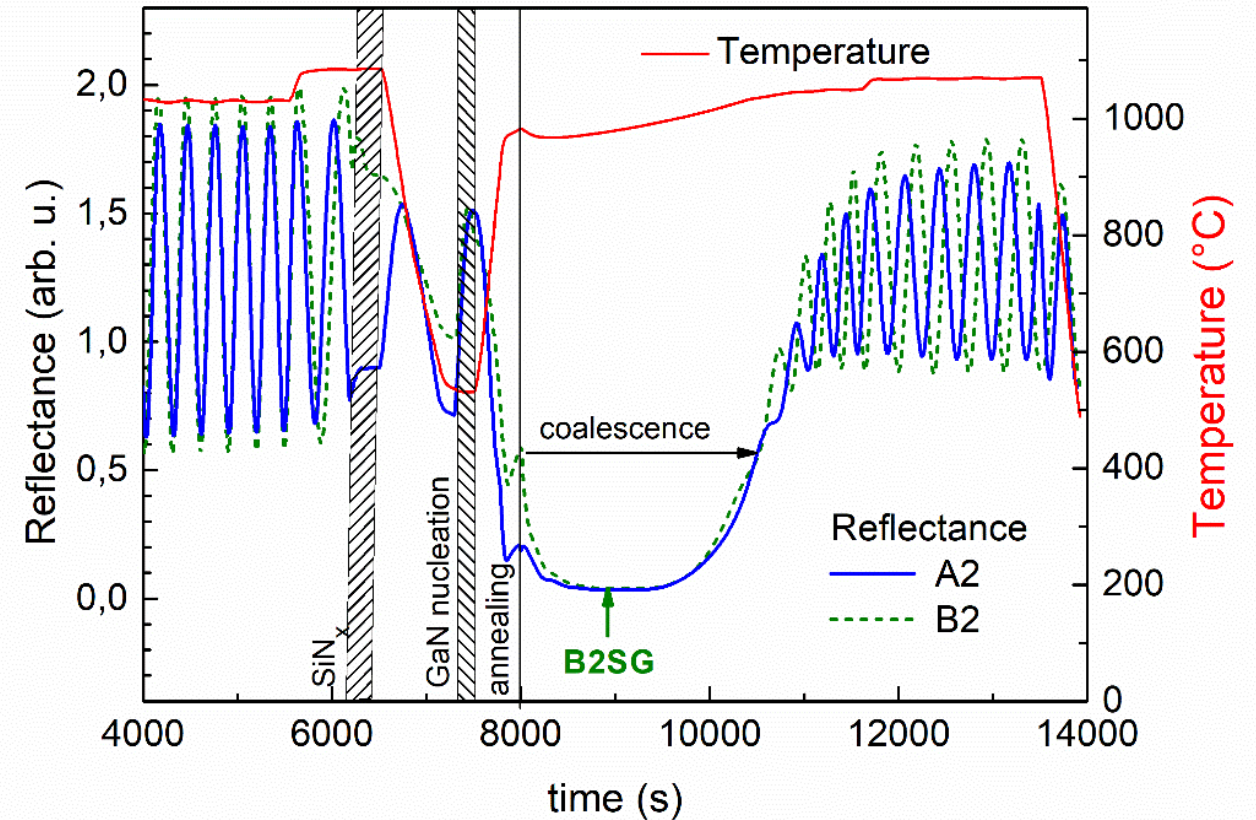
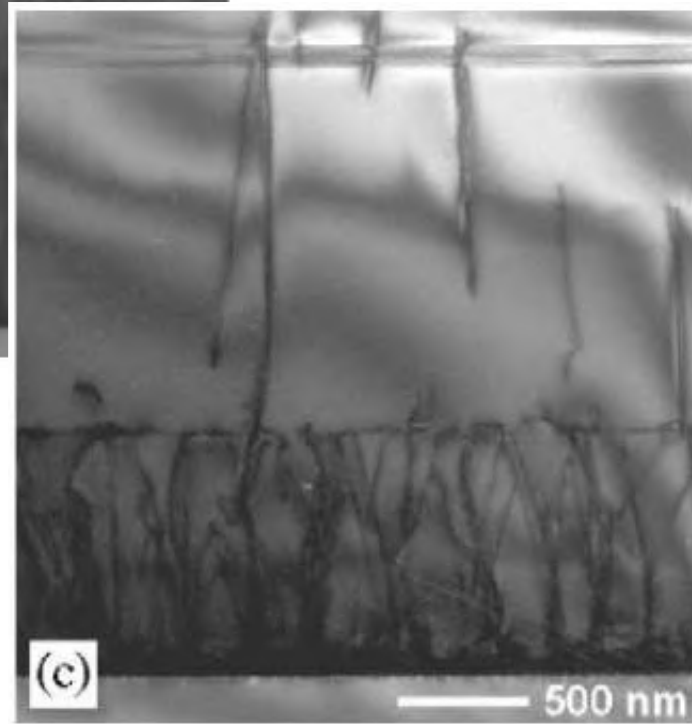
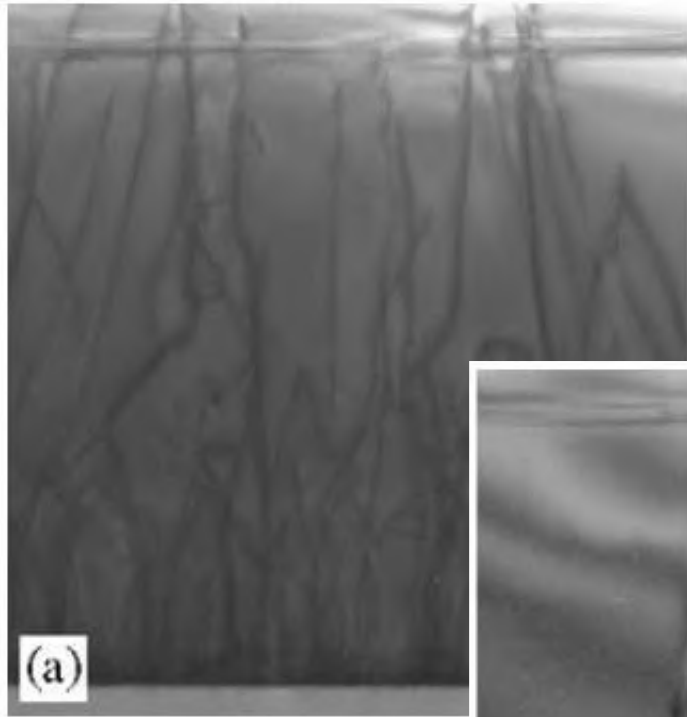
Increasing the coalescence time by temperature



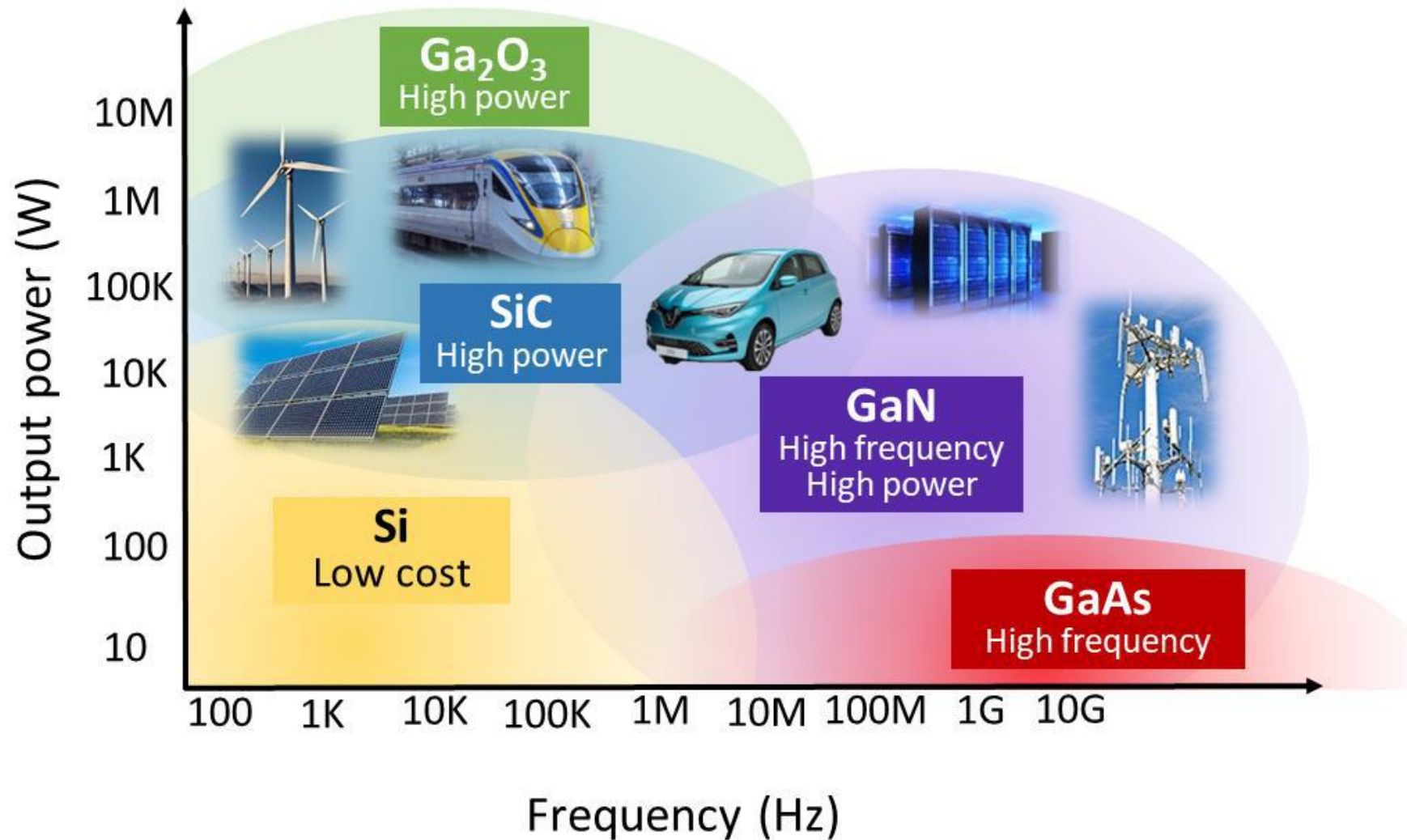
Growth temperature effect on MOVPE si-doped GaN-Thermodynamic modeling-Microelectronics journal-p363-v40-2009



SiNx layer

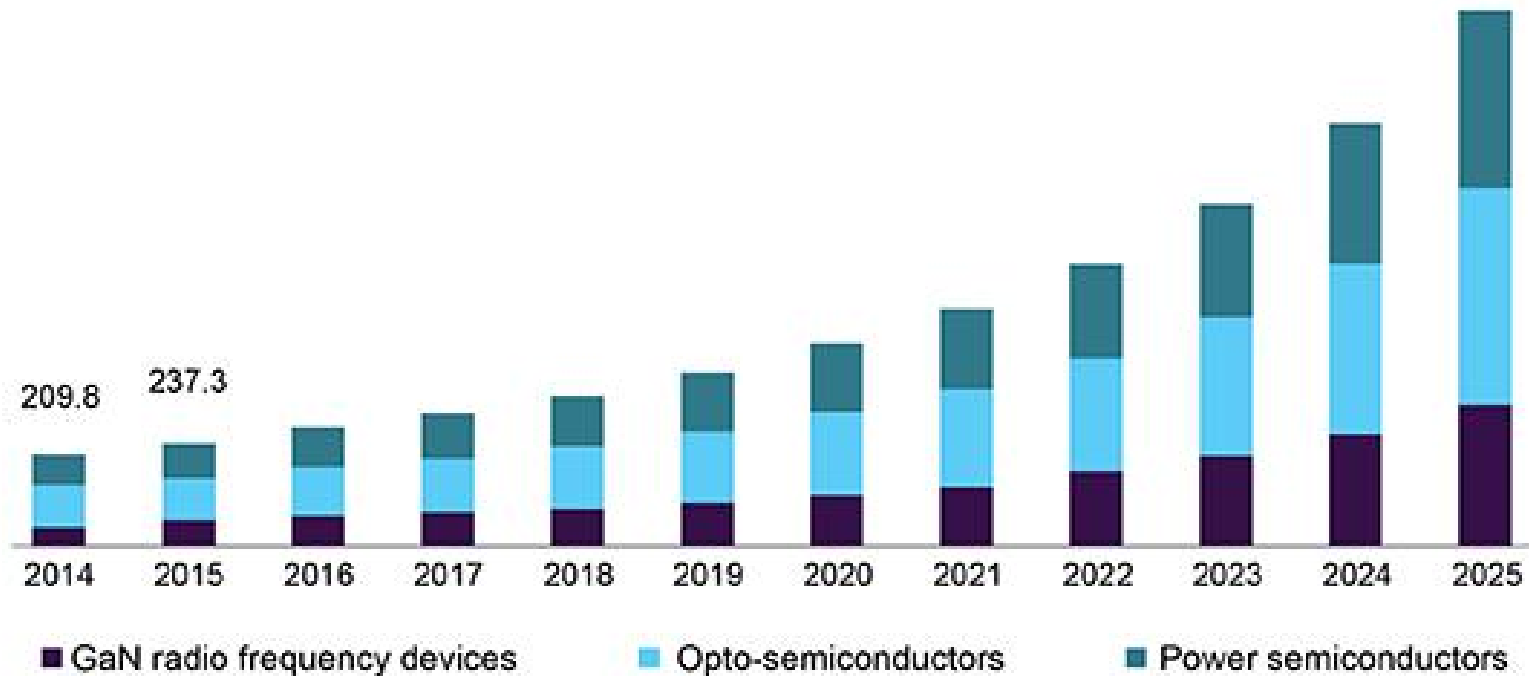


Semiconductors are not only silicon



GaN applications

U.S. Gallium Nitride semiconductor devices market, by product, 2014 - 2025 (USD Mn)



GaN RF applications

5G networks – base stations

- Higher bandwidth enable higher capacity – higher number of connected devices – higher power requirements

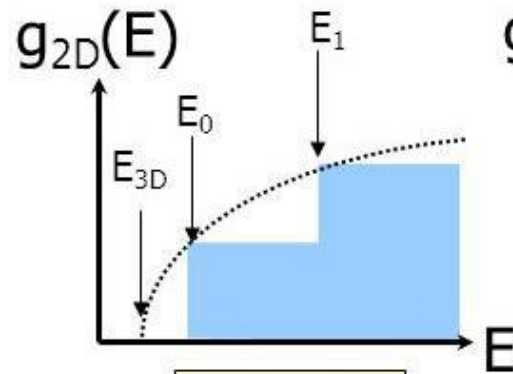
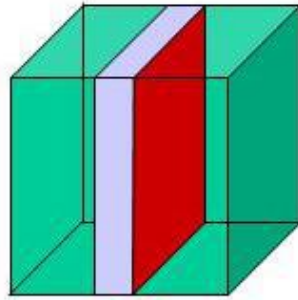
high power + high frequency= GaN



- Wavelengths used in 5G have shorter propagation distances – increased density of base stations

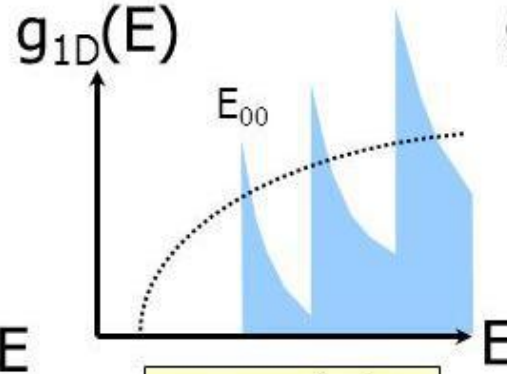
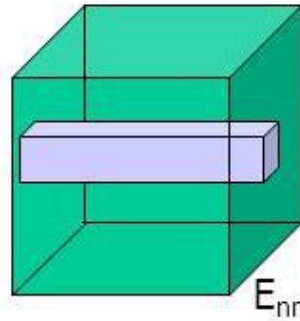
Nanoheterostructures:

Quantum Well



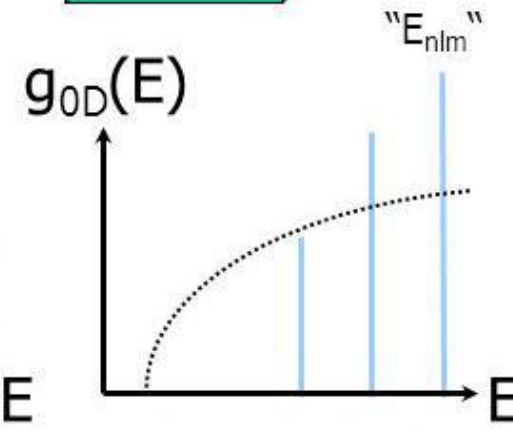
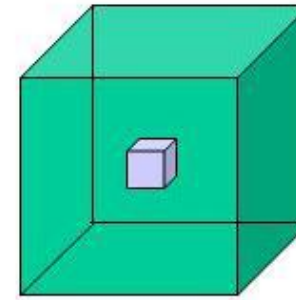
$$g_{2D}(E) = \frac{m}{\pi \hbar^2}$$

Wire



$$g_{1D}(E) = \frac{\sqrt{2m}}{2\pi\hbar} \frac{1}{\sqrt{E}}$$

Dot



$$g_{0D}(E) = \text{discrete}$$

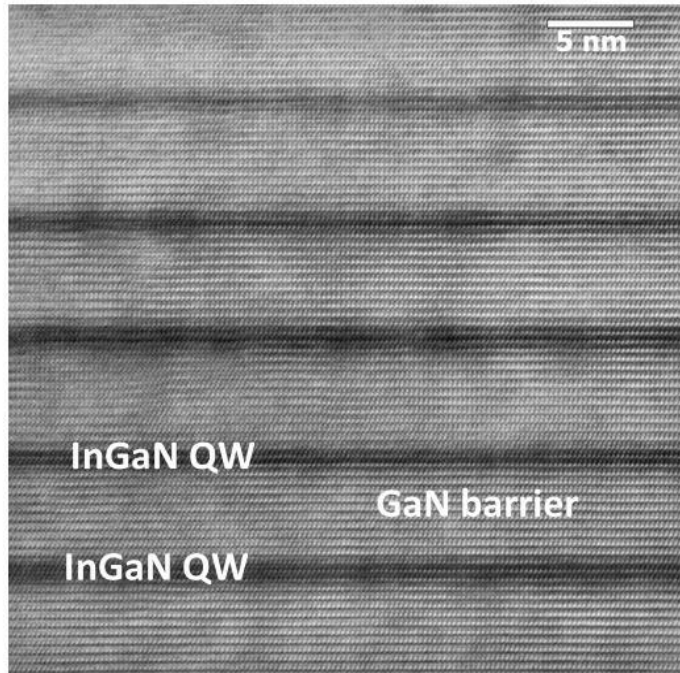


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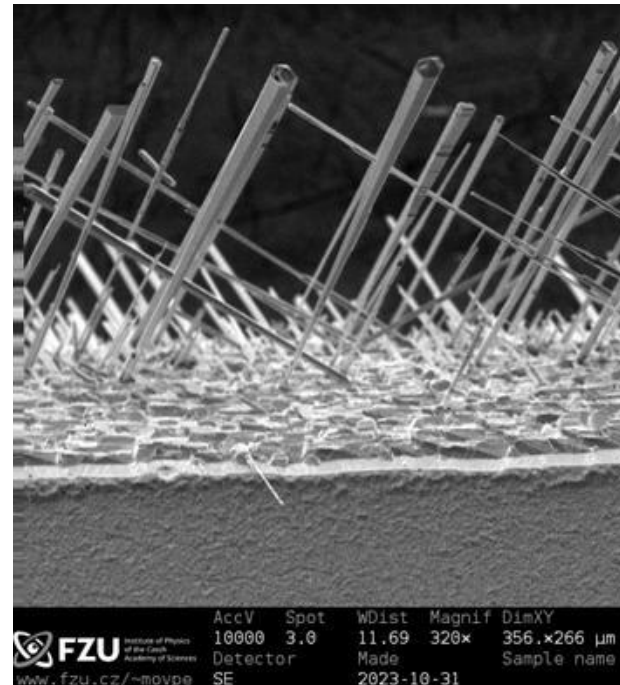
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Epitaxy of nanoheterostructures:

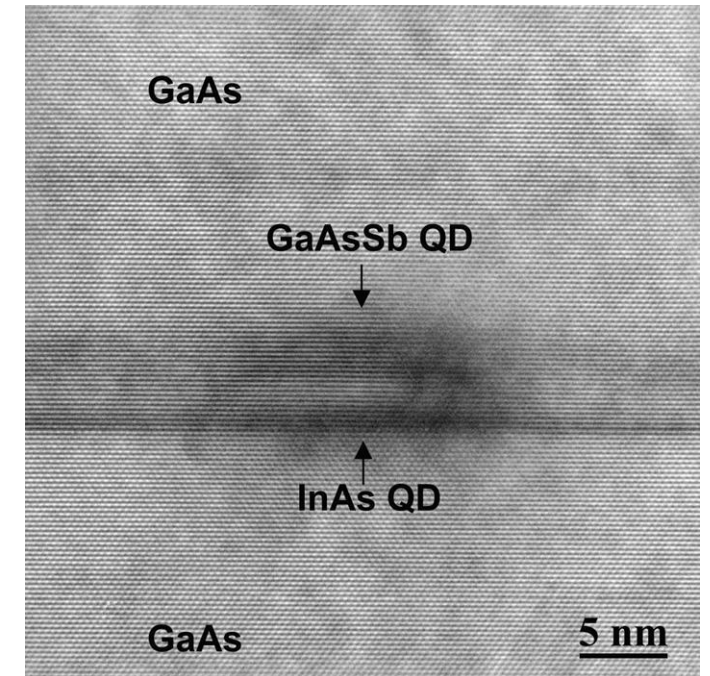
QWs



Nanorods



QDs



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Nanoheterostructures: QWs For fast scintillators

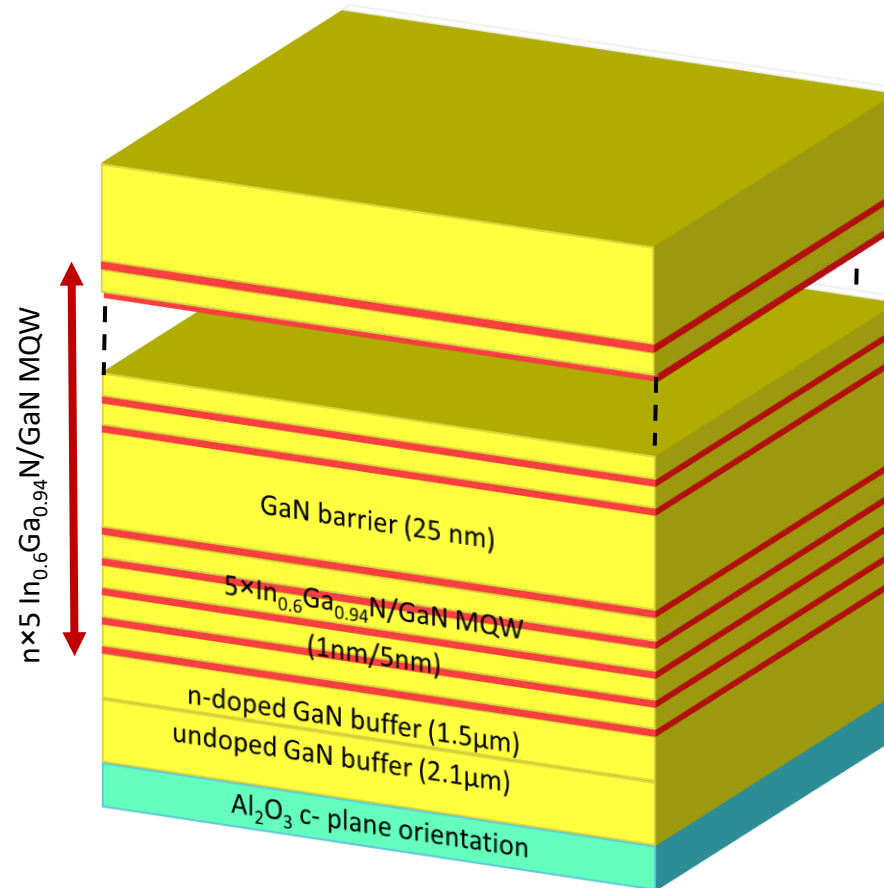


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Scintillator structure

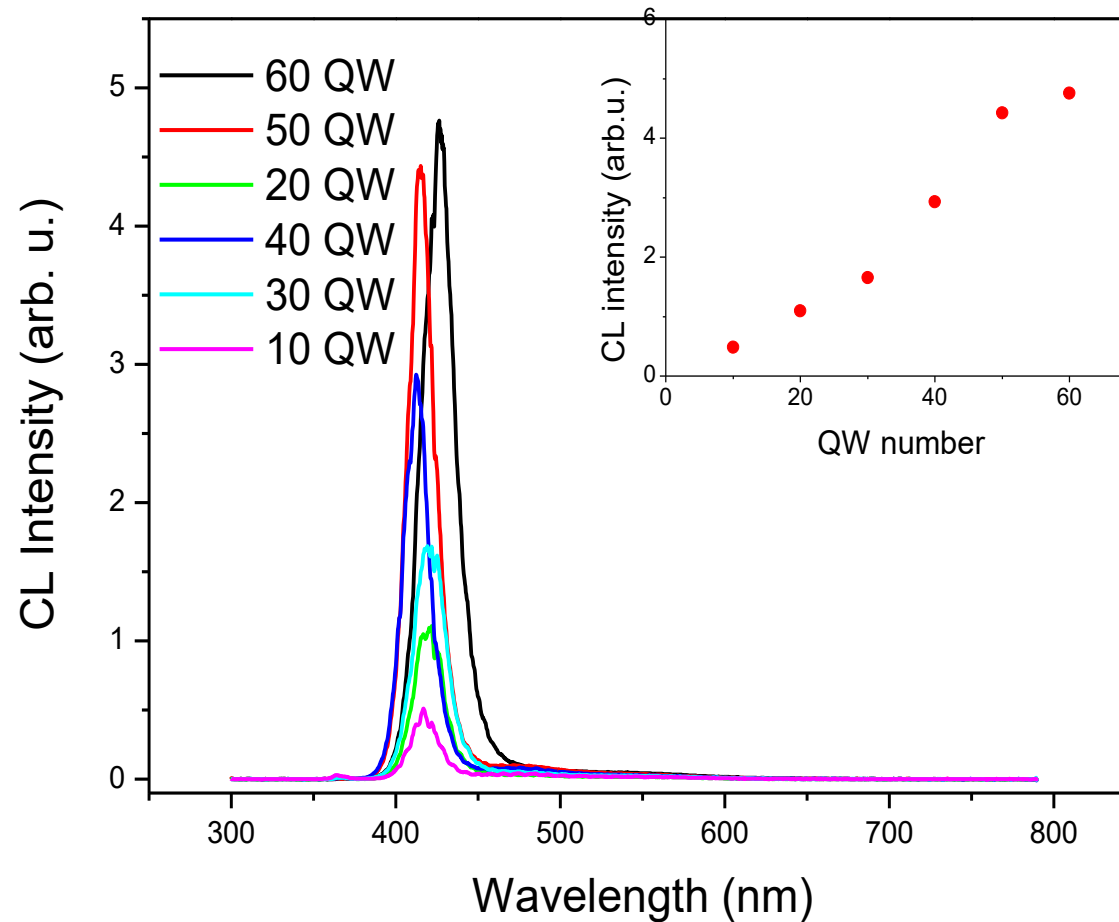
In our laboratory scintillator structures are developed. They have to contain much more InGaN QWs than in LED structures, to detect bigger part of the penetrated ionizing radiation



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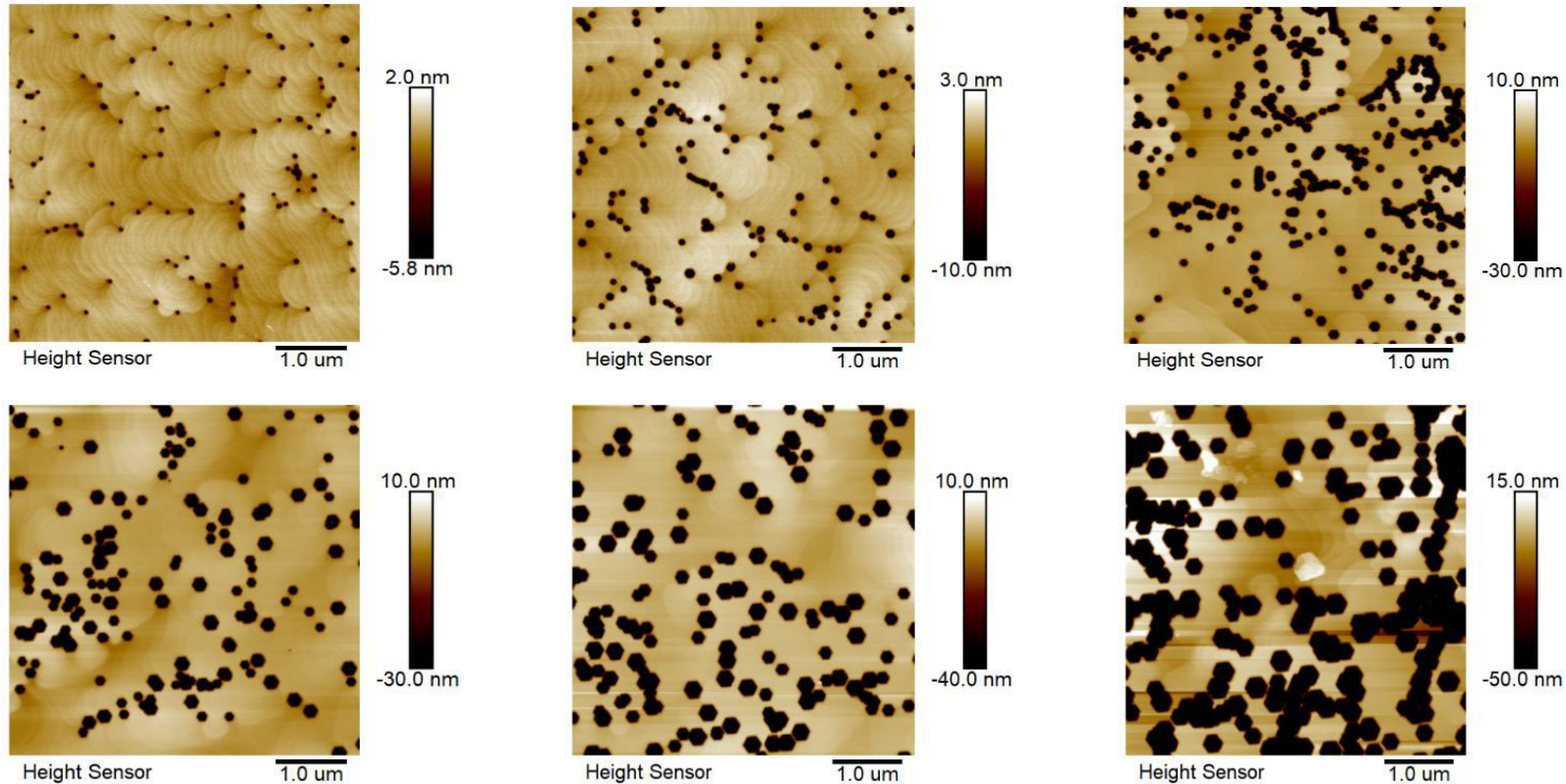
Cathodoluminescence of structures with different QW numbers



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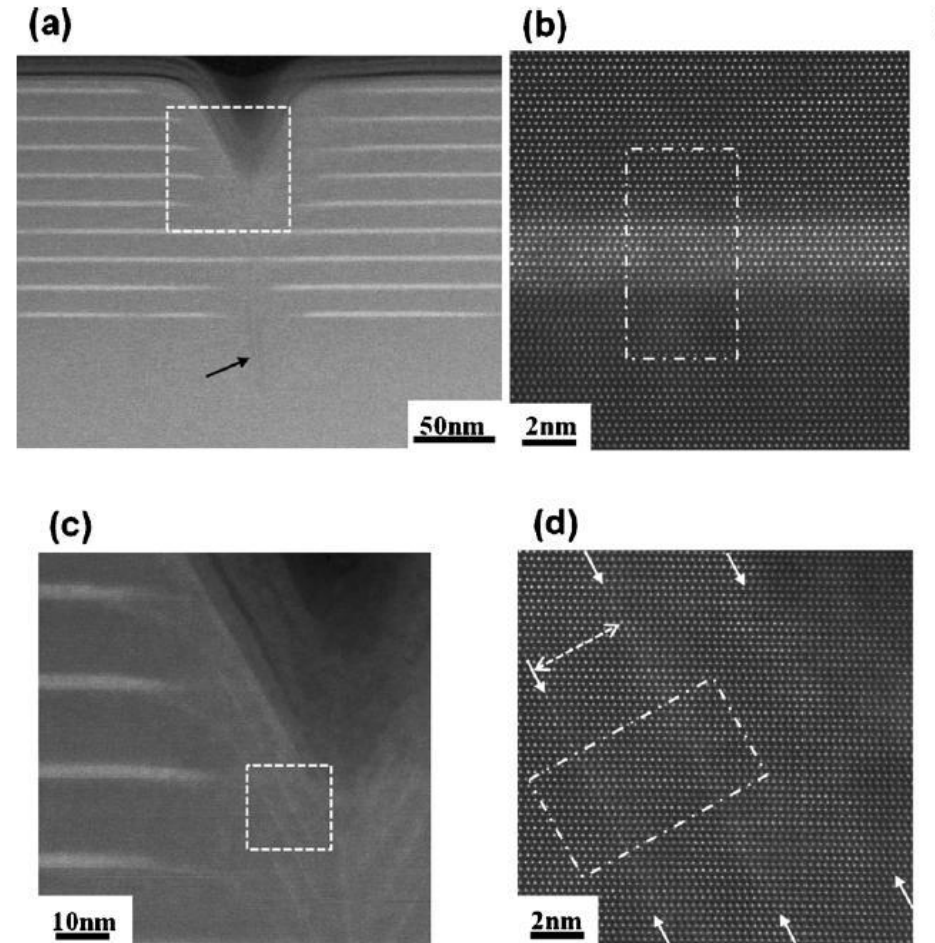
Increasing thickness of the active layer increases also V-pits



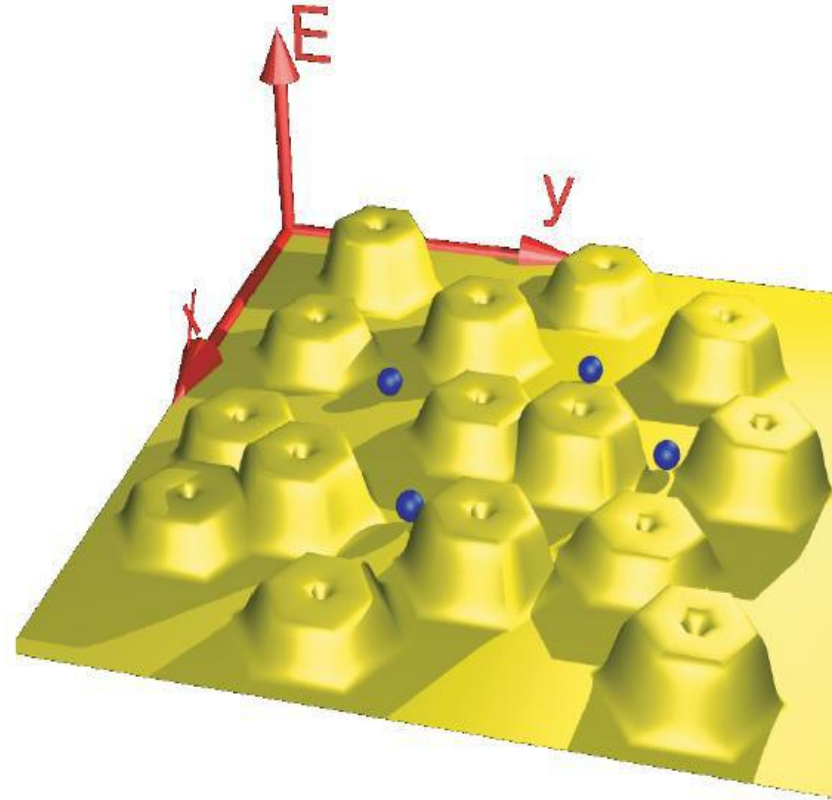
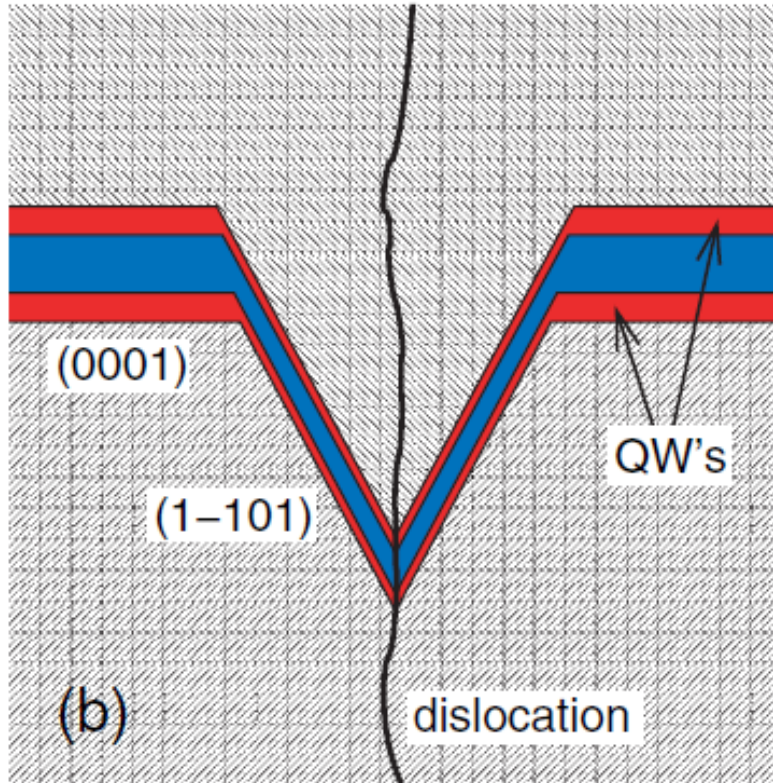
V- pits are very interesting defects in nitride semiconductors which are believed to enhance the luminescence efficiency of InGaN QWs

TEM and HRTEM images of V-pits

V-pits are formed around dislocations. InGaN QWs on V-pit sides are thinner than on flat surface. The electron energy in thinner QWs is higher. That is why electrons do not penetrate into V-pit sidewalls and are effectively separated from dislocations, where non-radiative recombination takes place – see following slide.

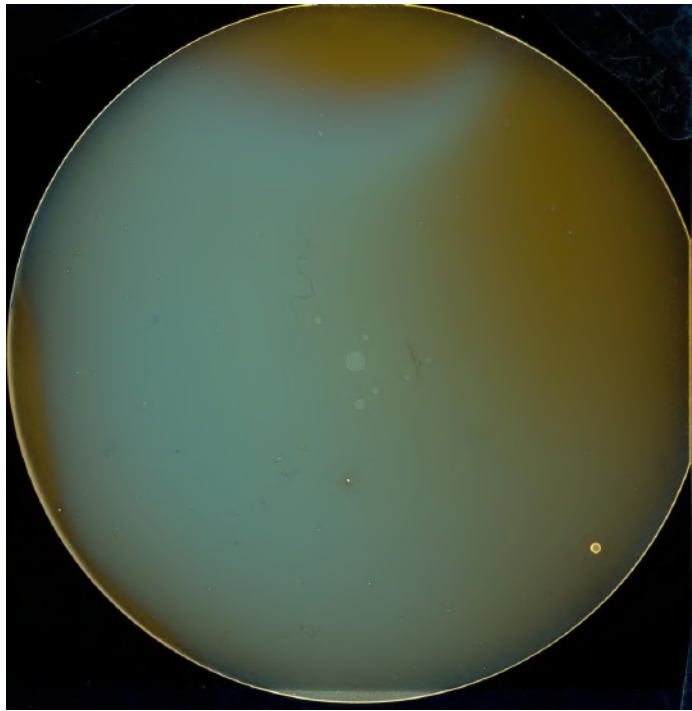


V-pits



Scintillators

Comparisson of luminescence of scintilator structures
before and after optimization

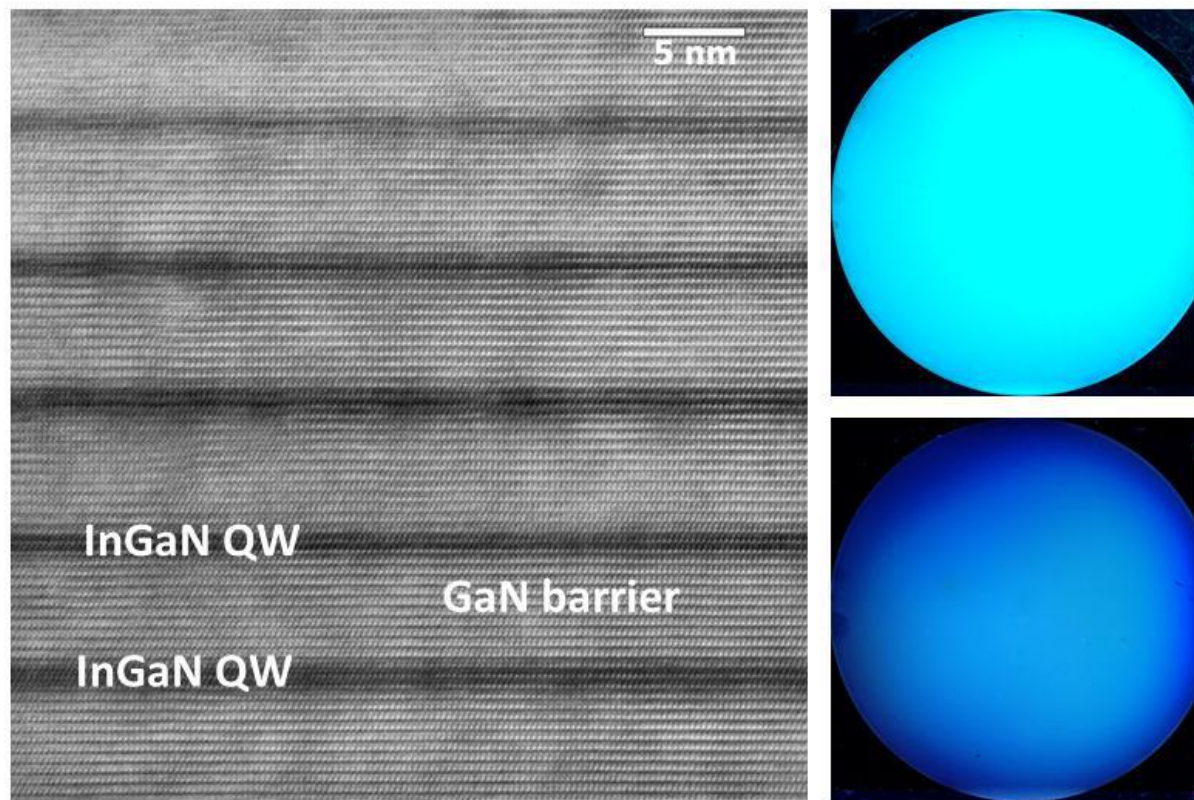


FZU

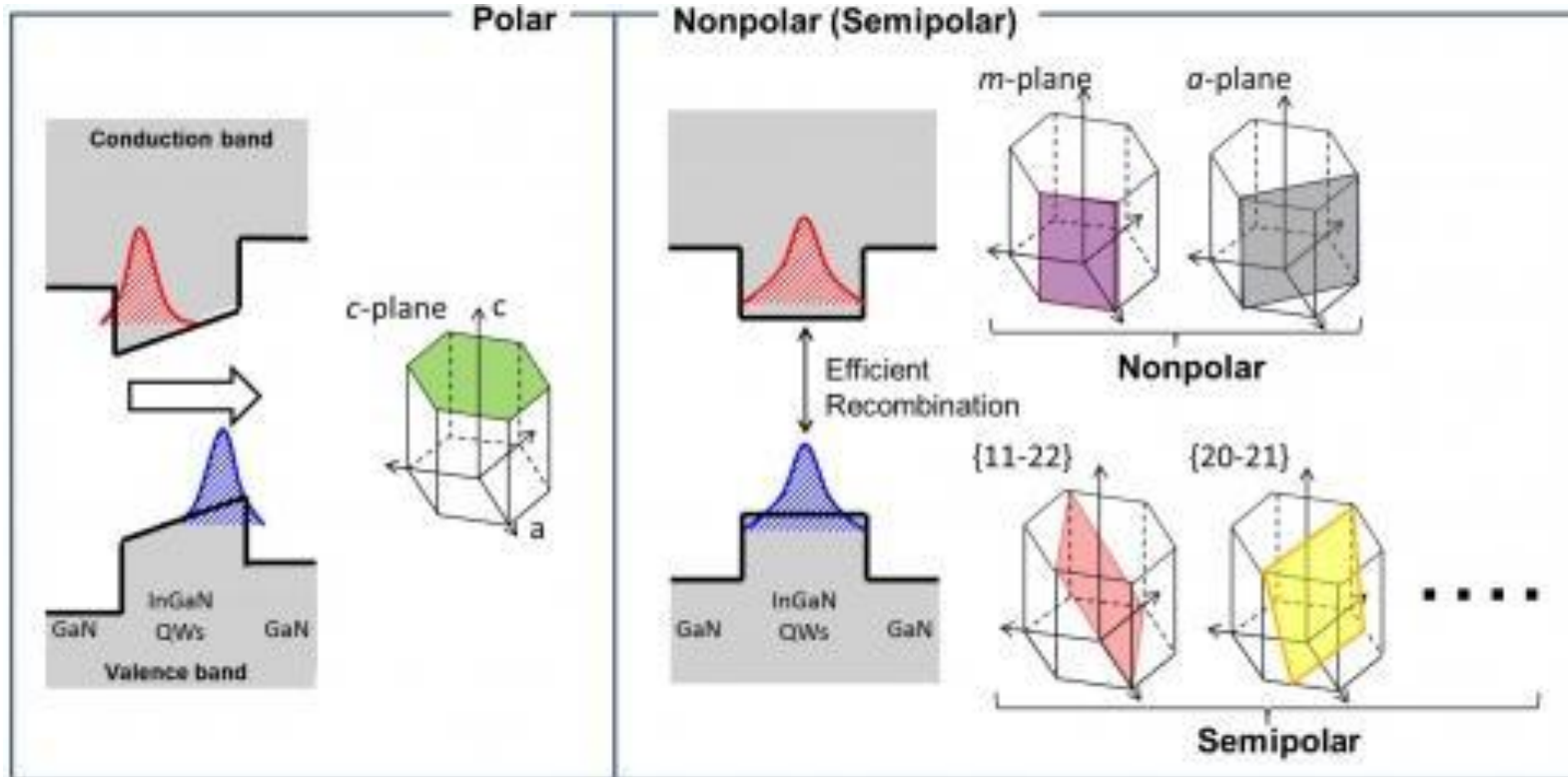
Fyzikální ústav
Akademie věd
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Scintillators

HR TEM image of InGaN/GaN MQW structure

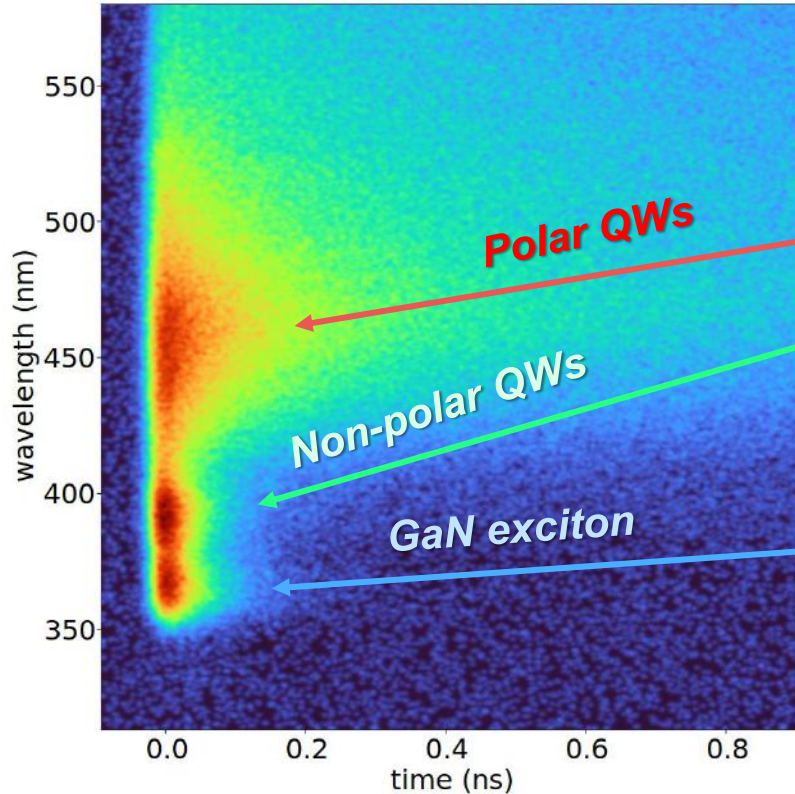


Electric field between polar and nonpolar heterojunctions

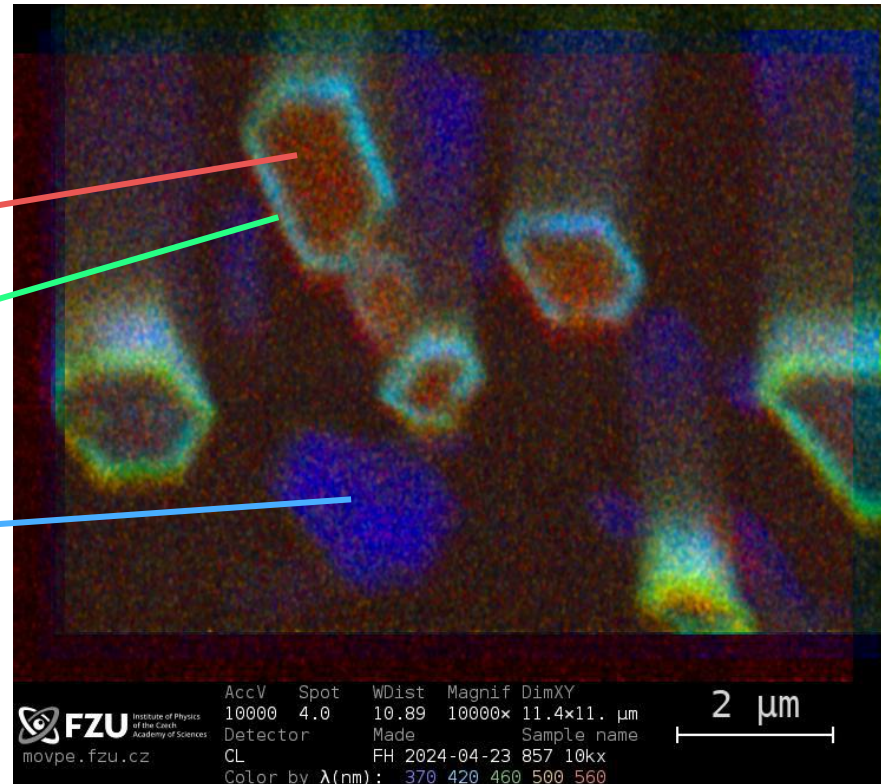


In InGaN QWs the polarization field separates spatially electrons and holes, their wave function overlap is lower and luminescence efficiency is suppressed.

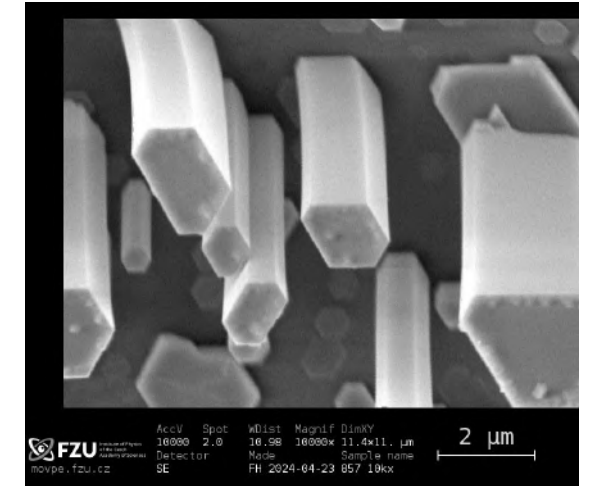
QWs on nanorods



Decay time for different parts of the InGaN/GaN nano-rod structure. *PL of non-polar QWs has even faster decay than PL of GaN exciton*



SEM cathodoluminescence of the InGaN/GaN nano-rods.



SEM SE mode of InGaN/GaN nano-rods.
The same position.

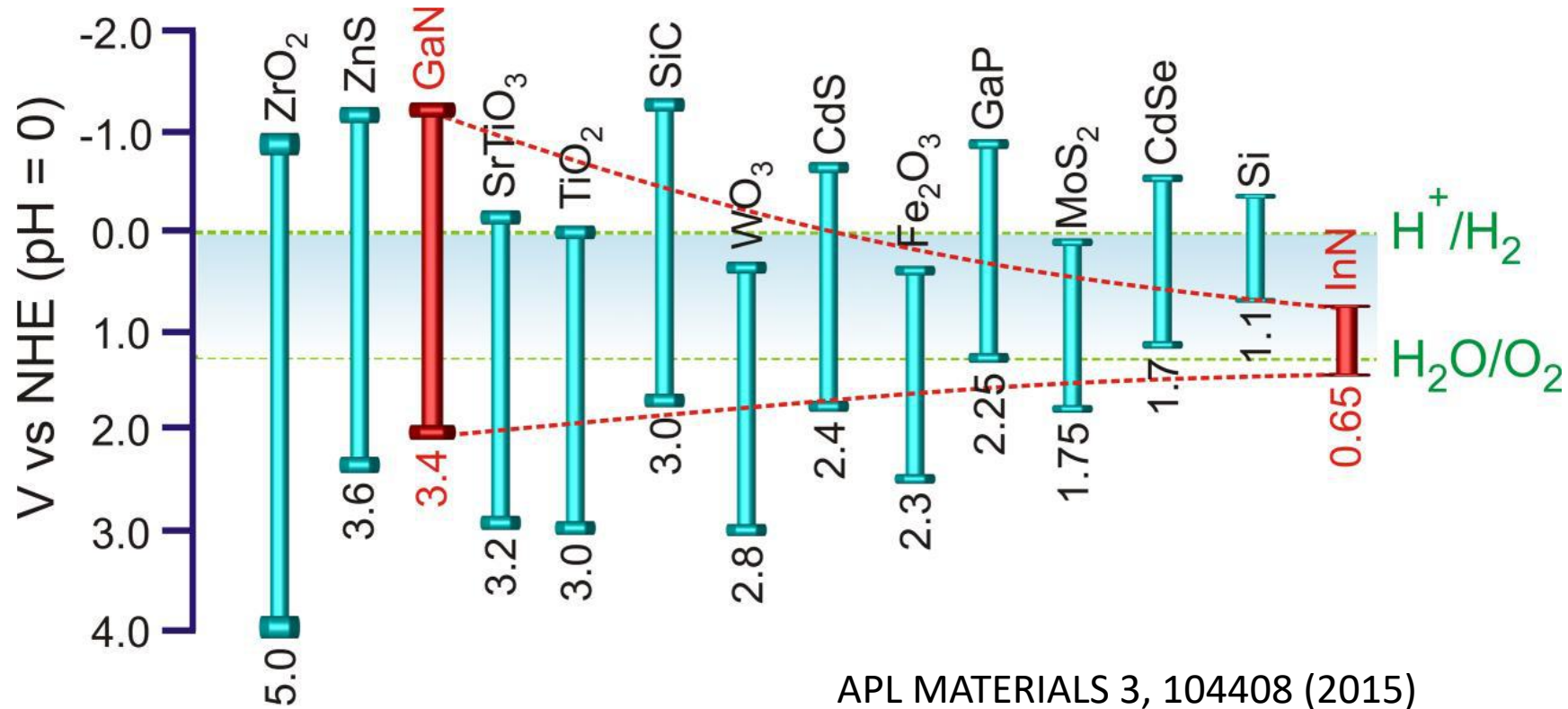
10×MQW of InGaN/GaN shell around the GaN rods

Nanoheterostructures:

Nanorods

For solar H₂ generation

Valence and conduction band vs. redox H₂O potentials

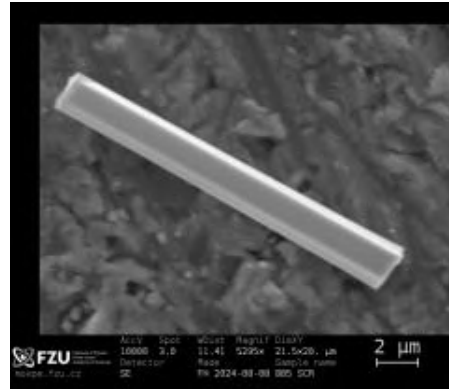


InGaN has optimal band alignment

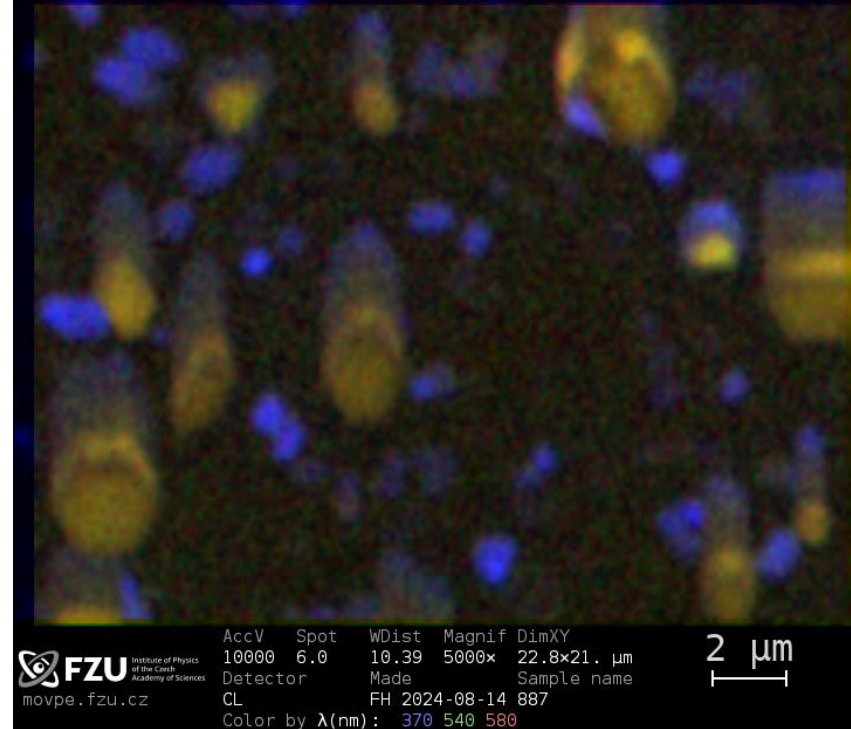
Core-shell InGaN/GaN micropillars for solar photocatalysis



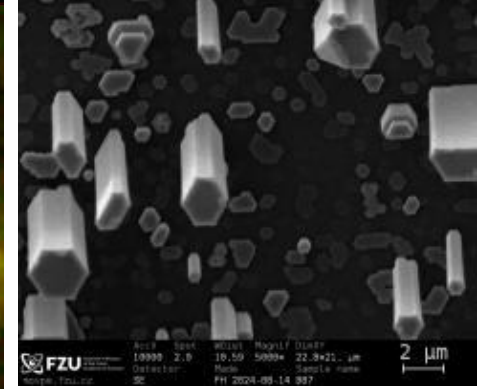
SEM cathodoluminescence of InGaN/GaN nano-rods shows different composition in *polar direction*, which can separate electron-hole pairs.



SEM SE mode of InGaN/GaN nano-rods.
The same rod.



SEM cathodoluminescence of InGaN/GaN nano-rods.
Blue are GaN seeds not grown to rods.



SEM SE mode of InGaN/GaN nano-rods.
The same position.

Core-shell structures - SEM

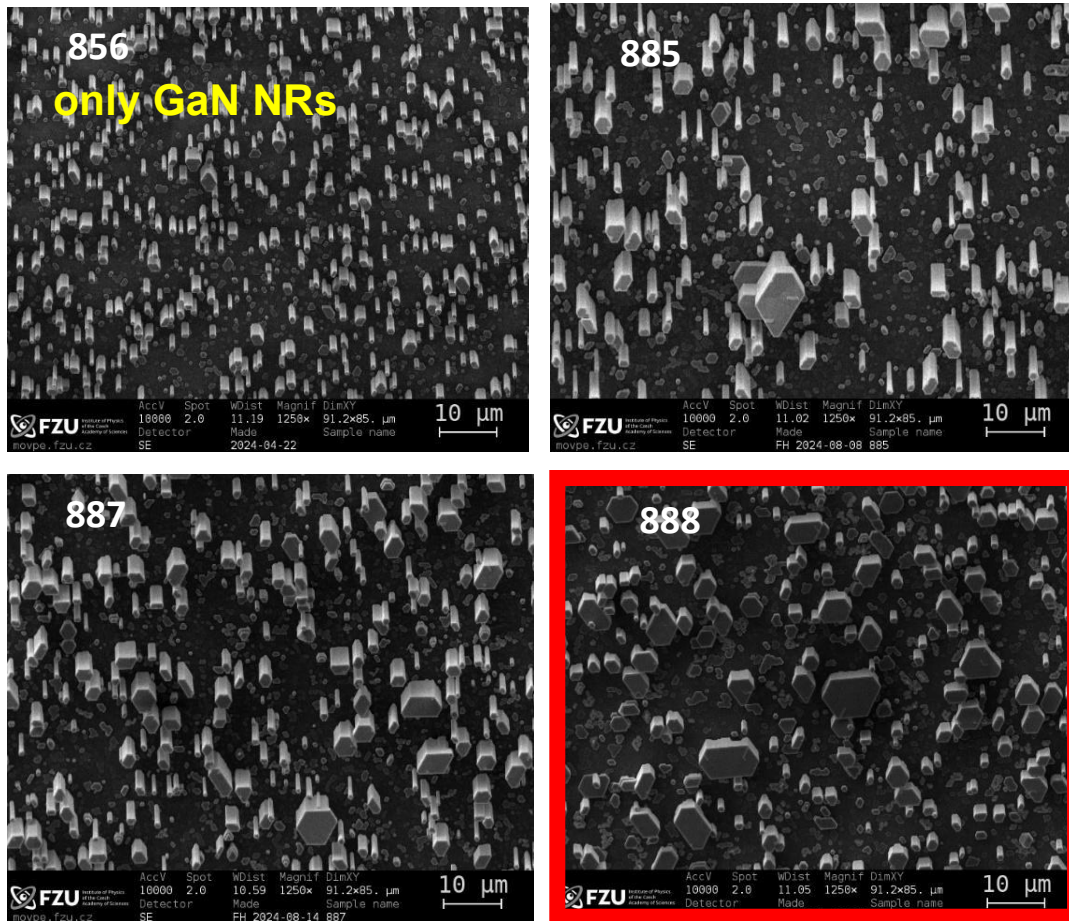
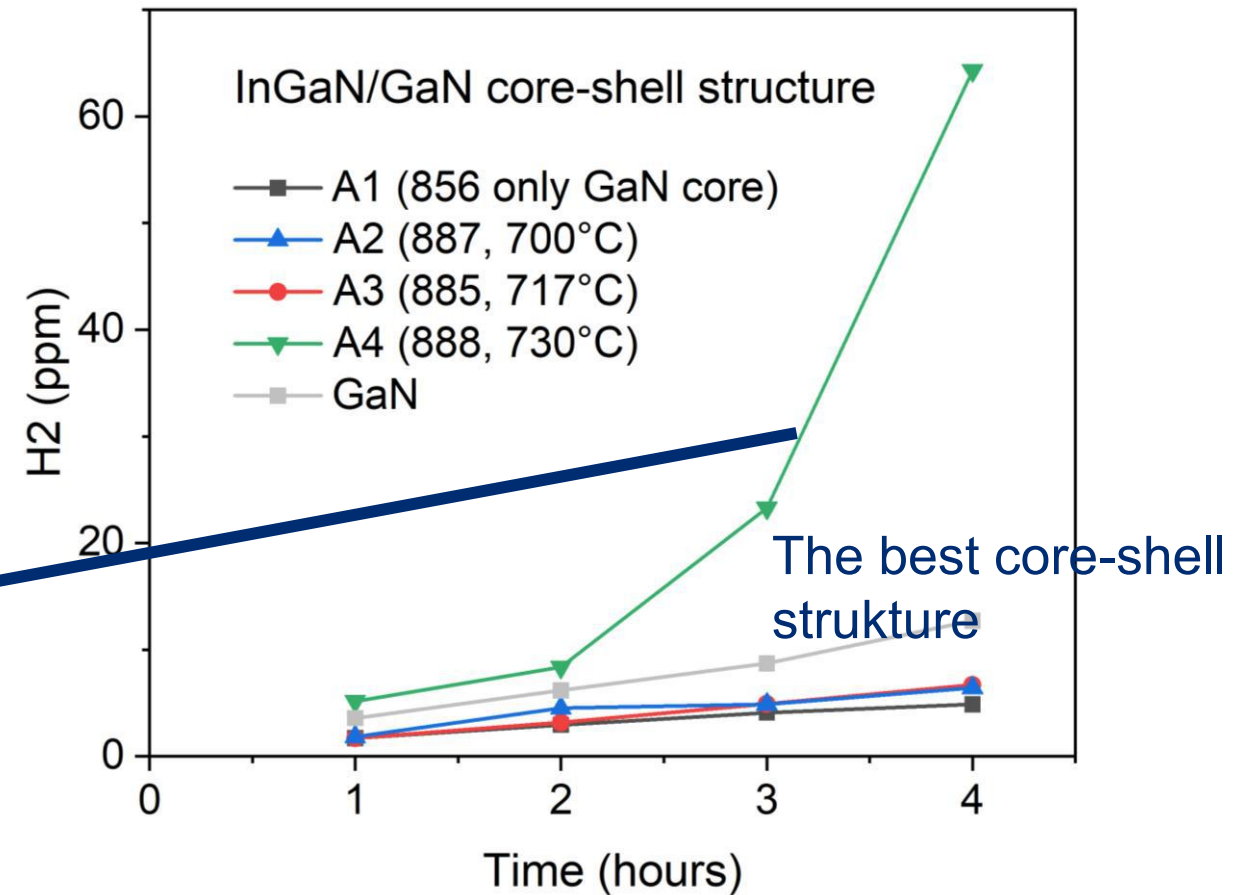
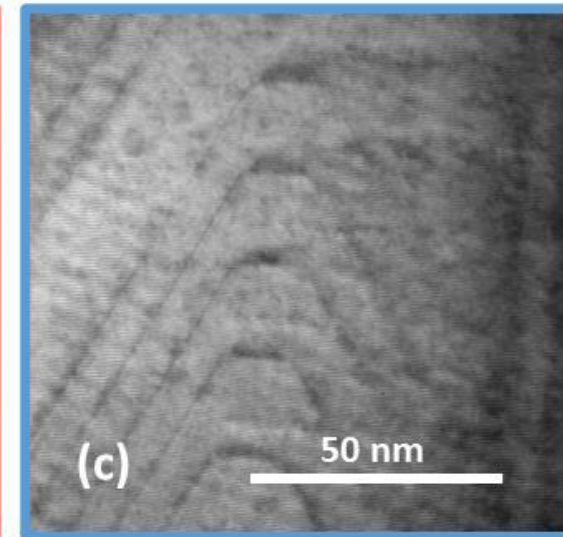
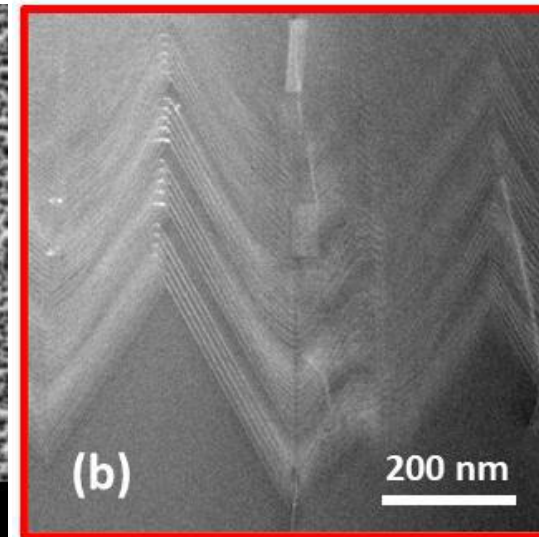
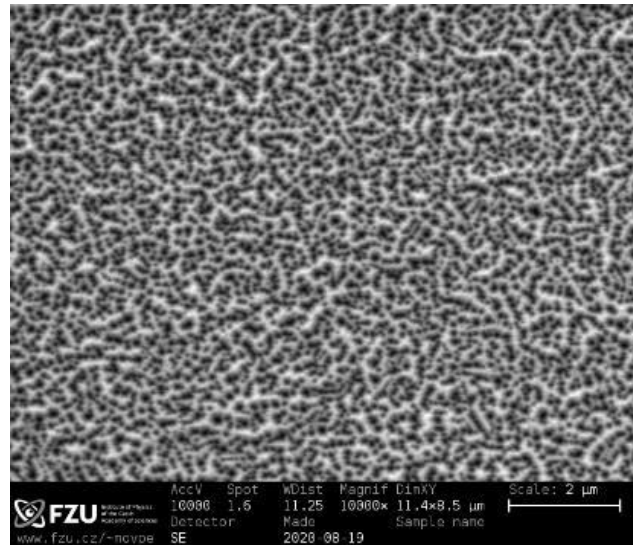
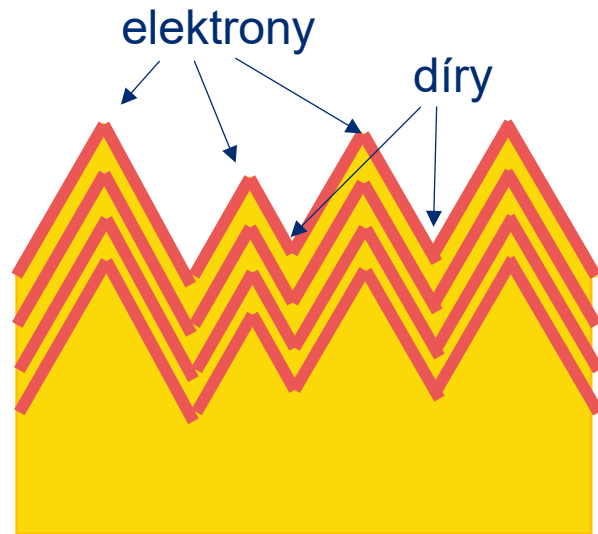


Figure 3: SEM images of nanorods in the sample centre

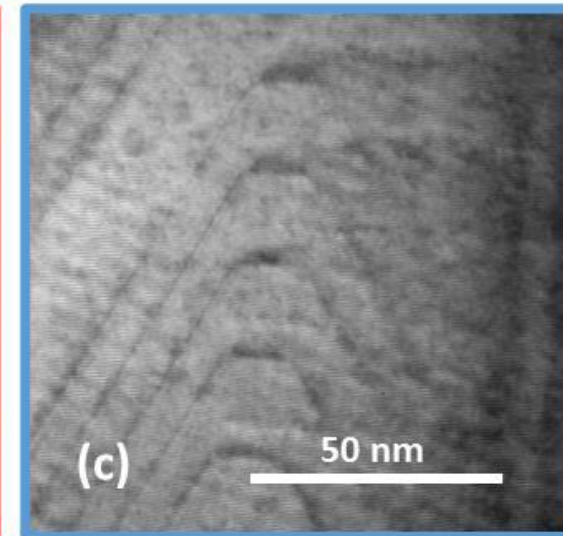
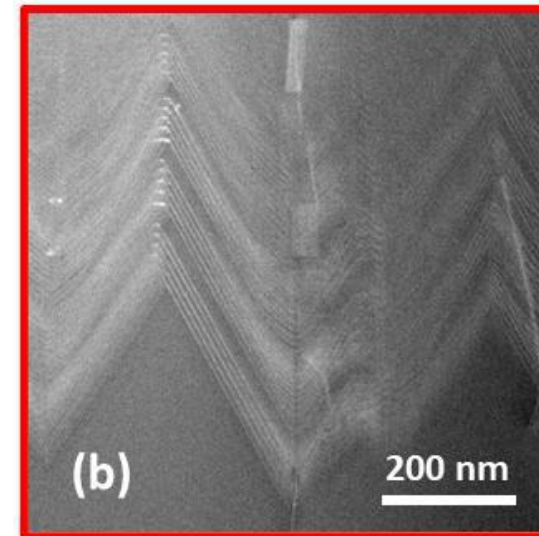
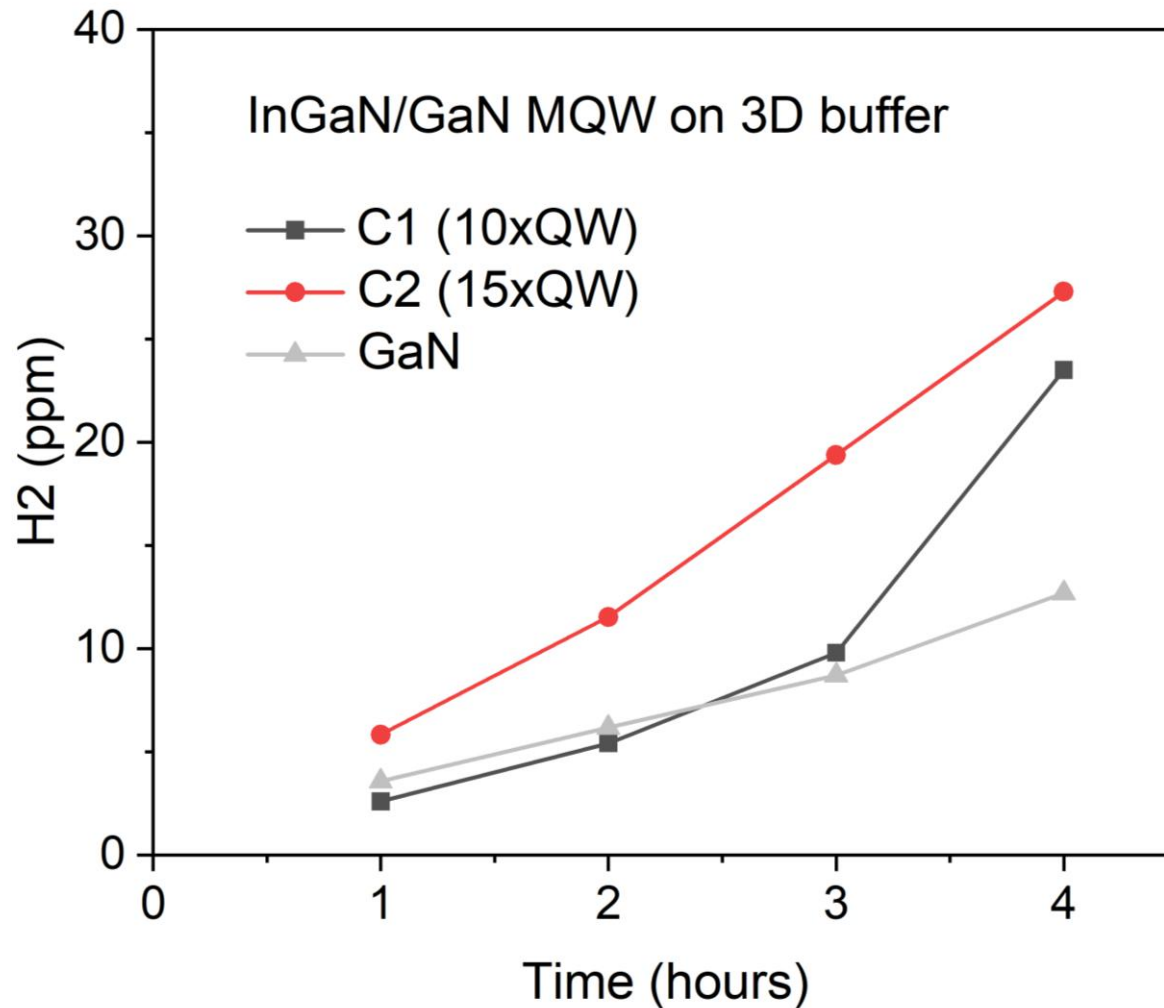


Semipolar InGaN/GaN MQW 3D structures

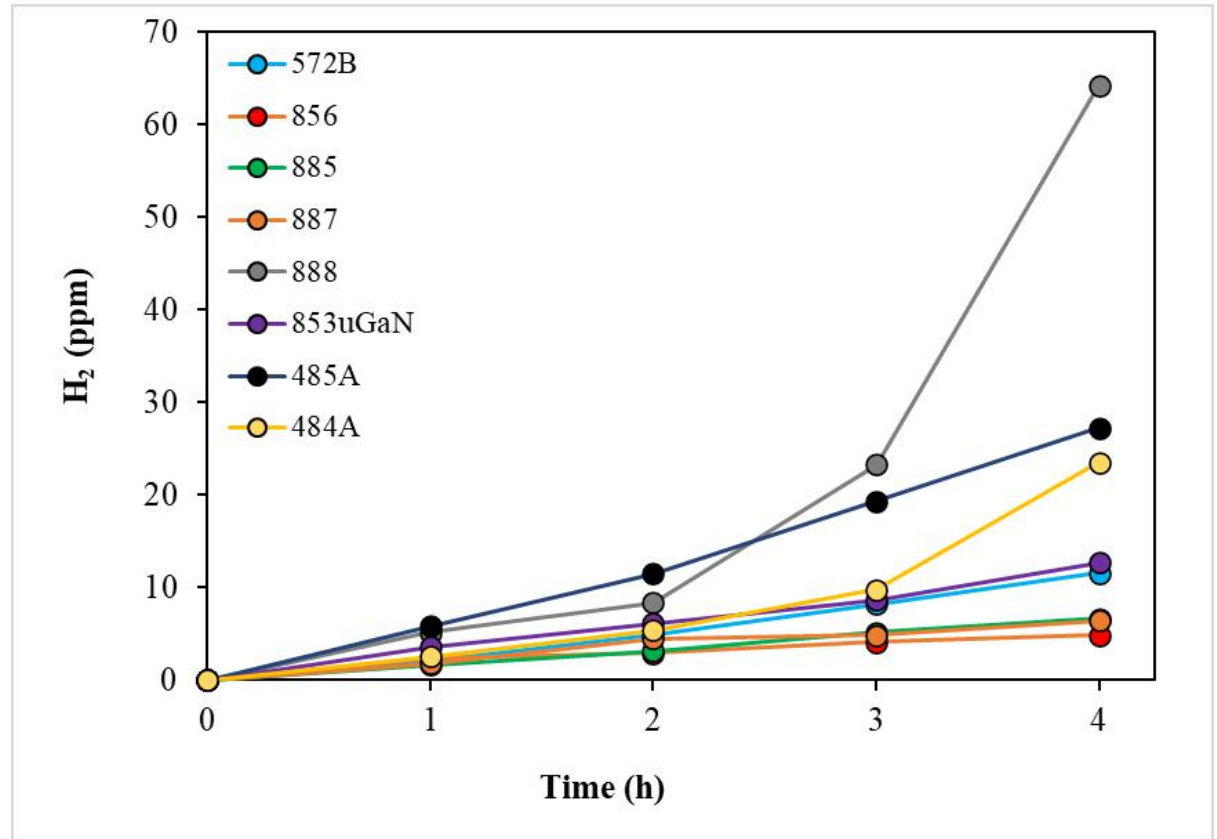
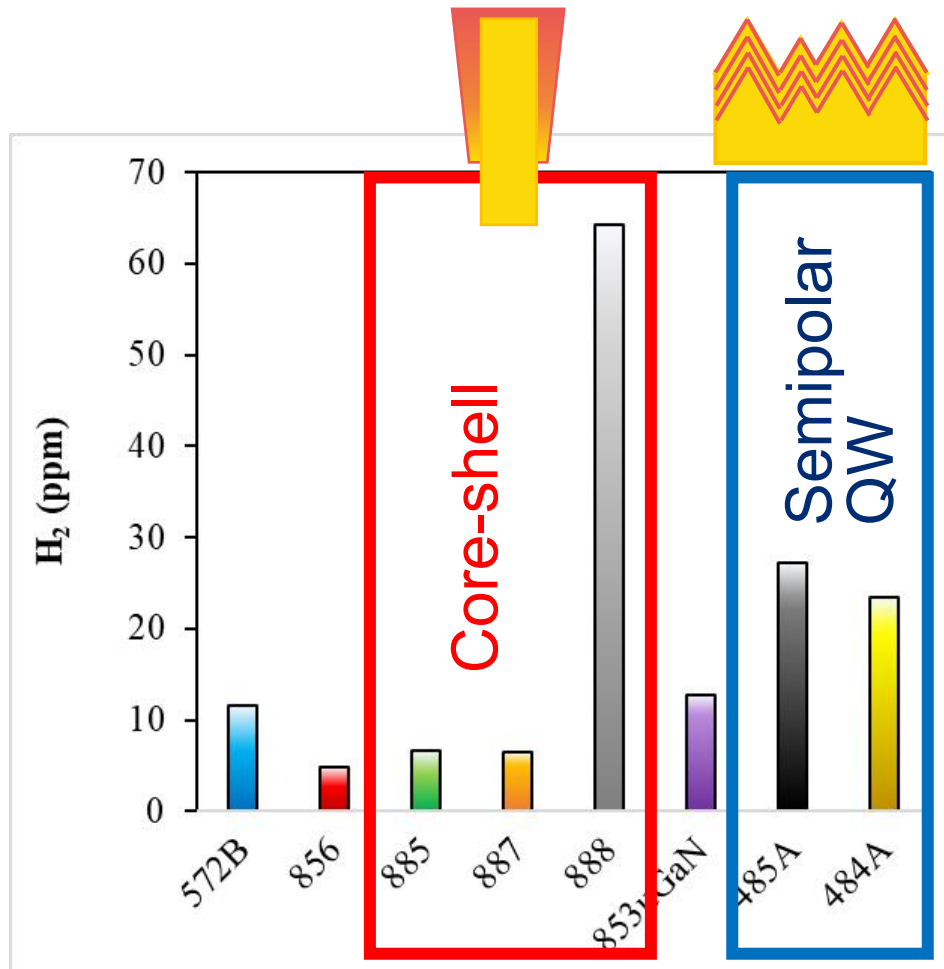
- Self assembled in nitrogen atmosphere



Semipolar InGaN/GaN MQW 3D structures

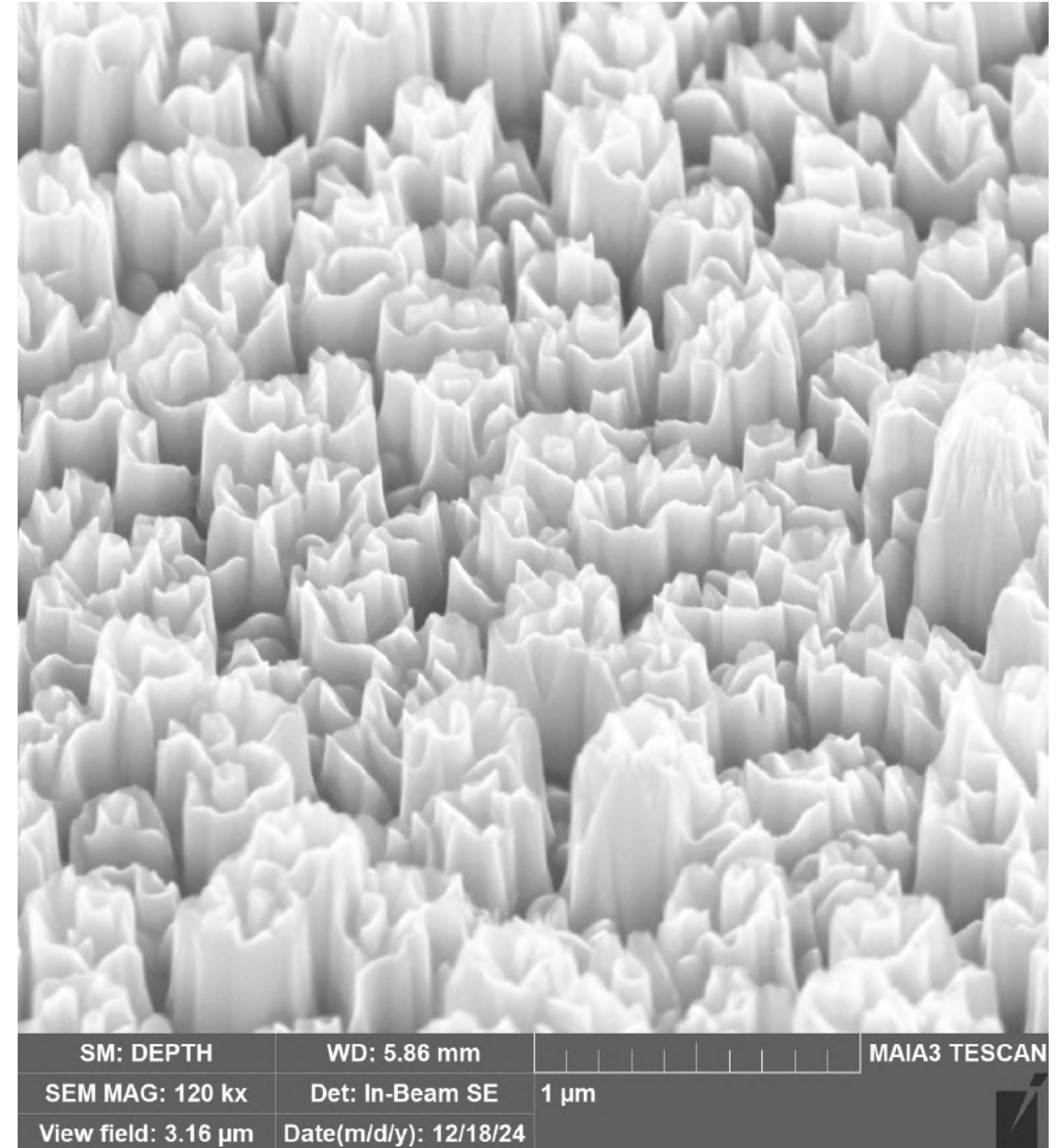
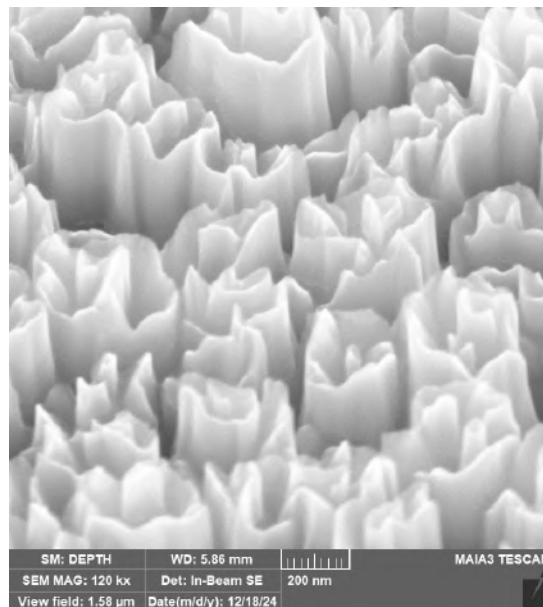
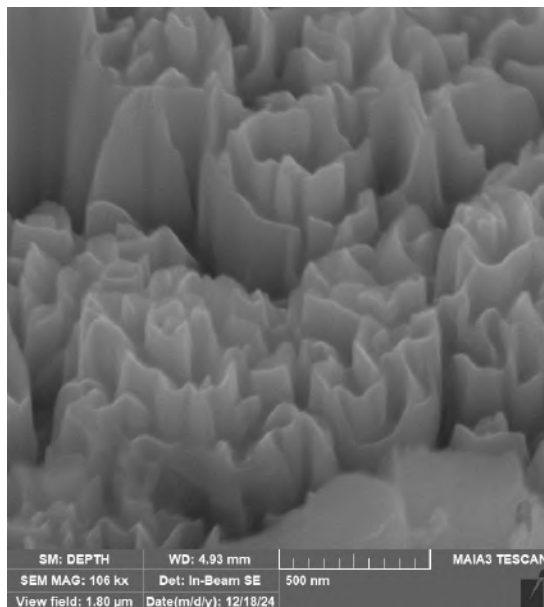
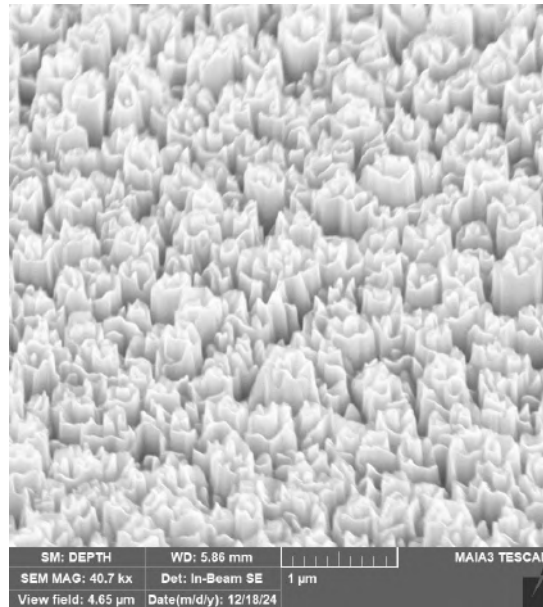
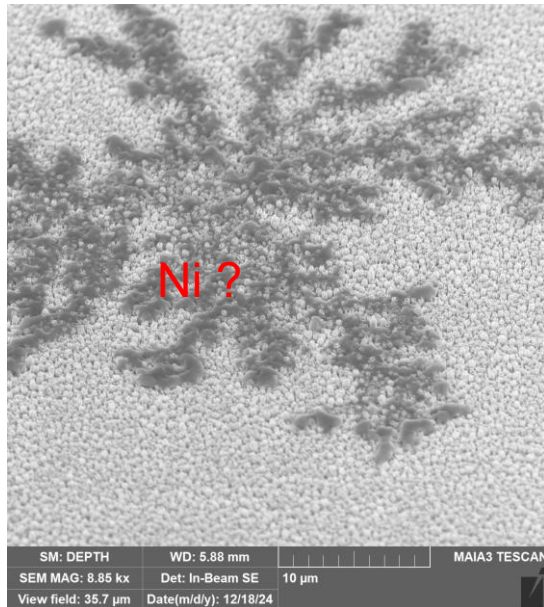


First results



Měřeno s excitací 365 nm!

SEM (45°): RR241220_GaN_Ni mask_etching in SiCl₄+Ar (30 min)



SiCl₄/Ar (19.6/12 sccm), 20 mTorr, RF power 75 W, ICP power 45 W, 30 min

Nanoheterostructures: QDs For fast scintillators



FZU

Fyzikální ústav
Akademie věd
České republiky

Data transfer through optical waveguides

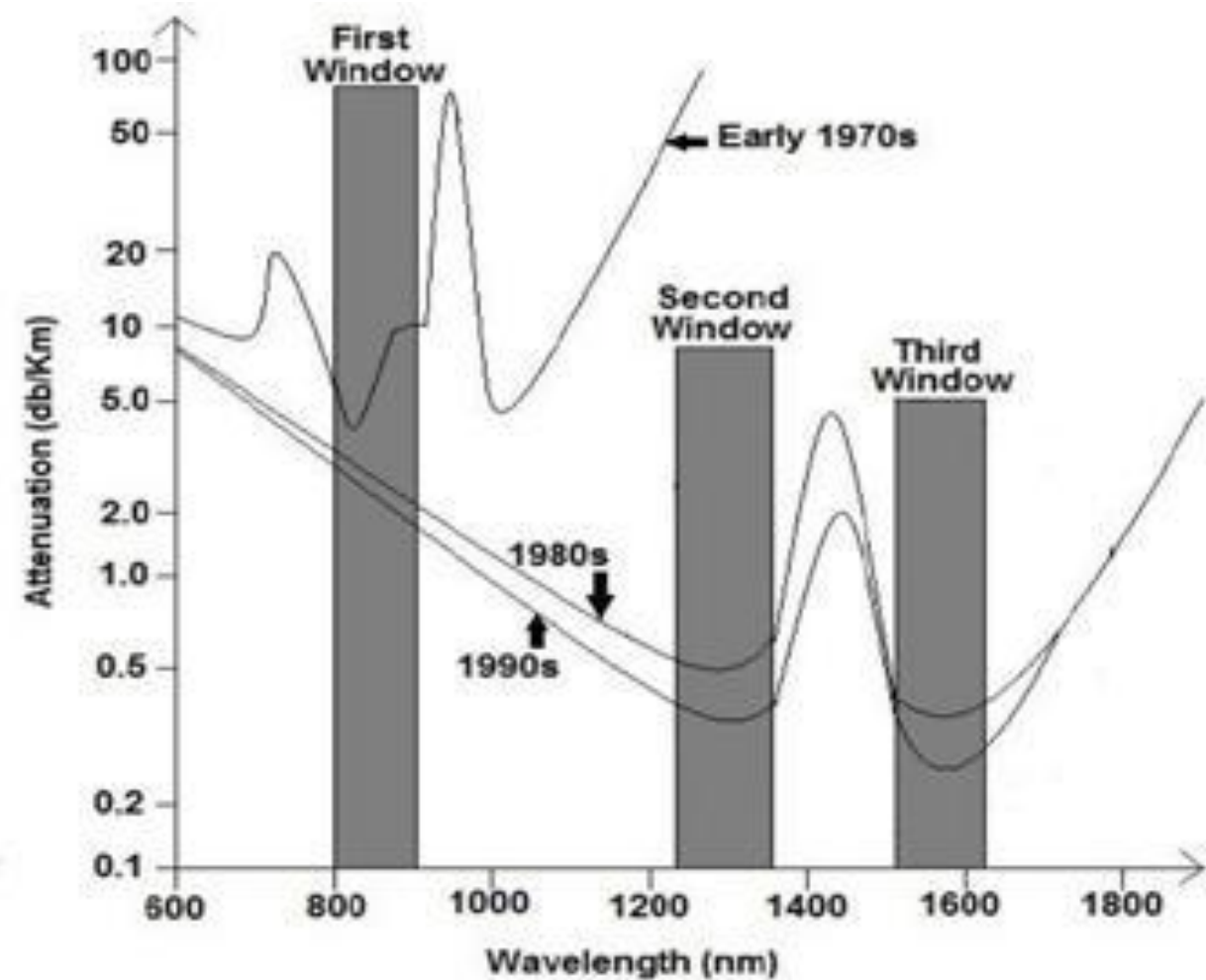


FZU

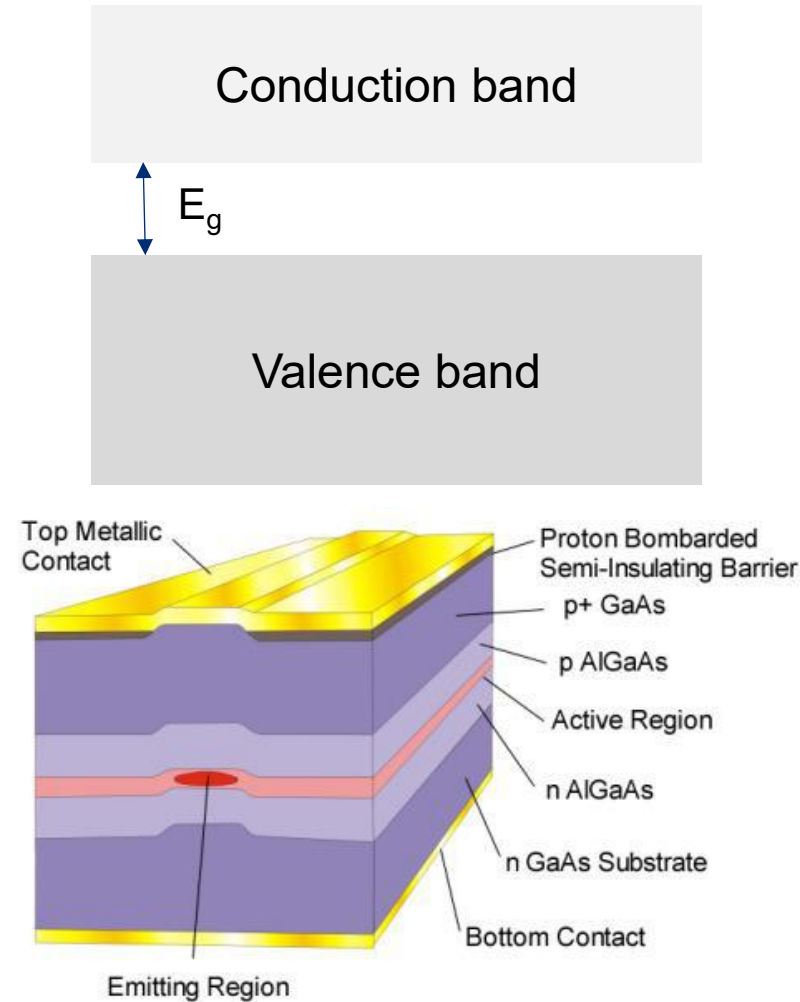
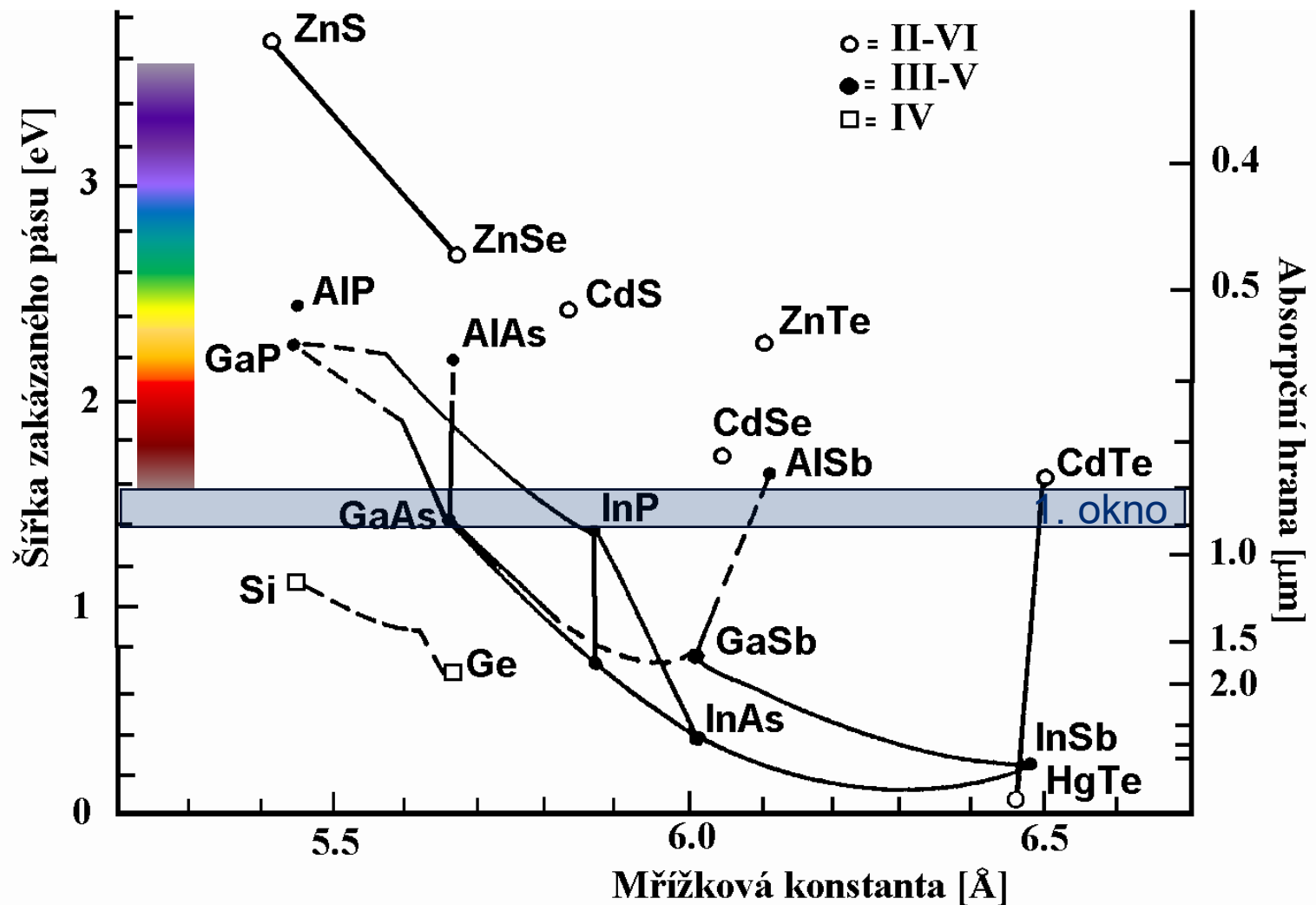
Fyzikální ústav
Akademie věd
České republiky

Attenuation in optical waveguides

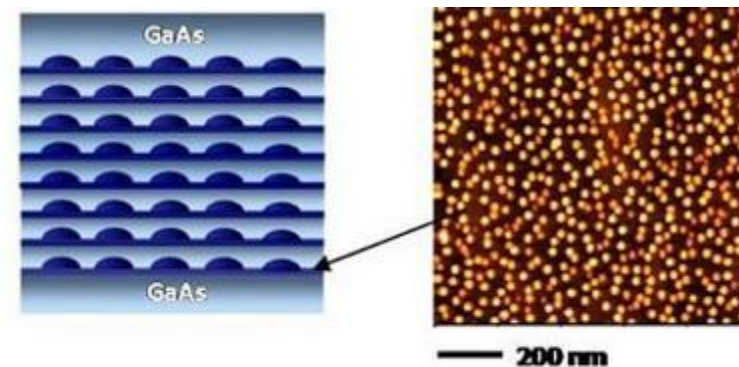
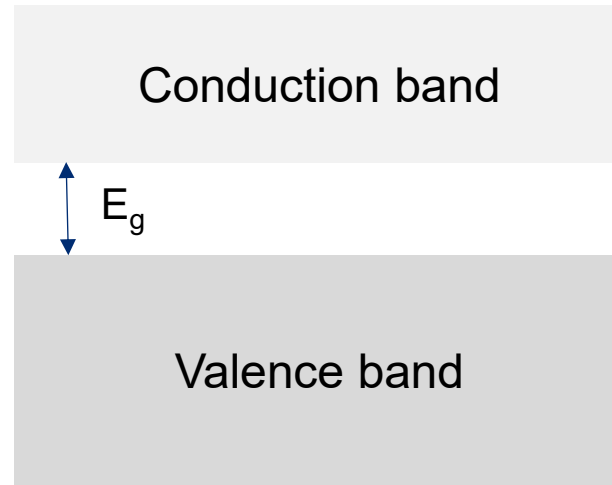
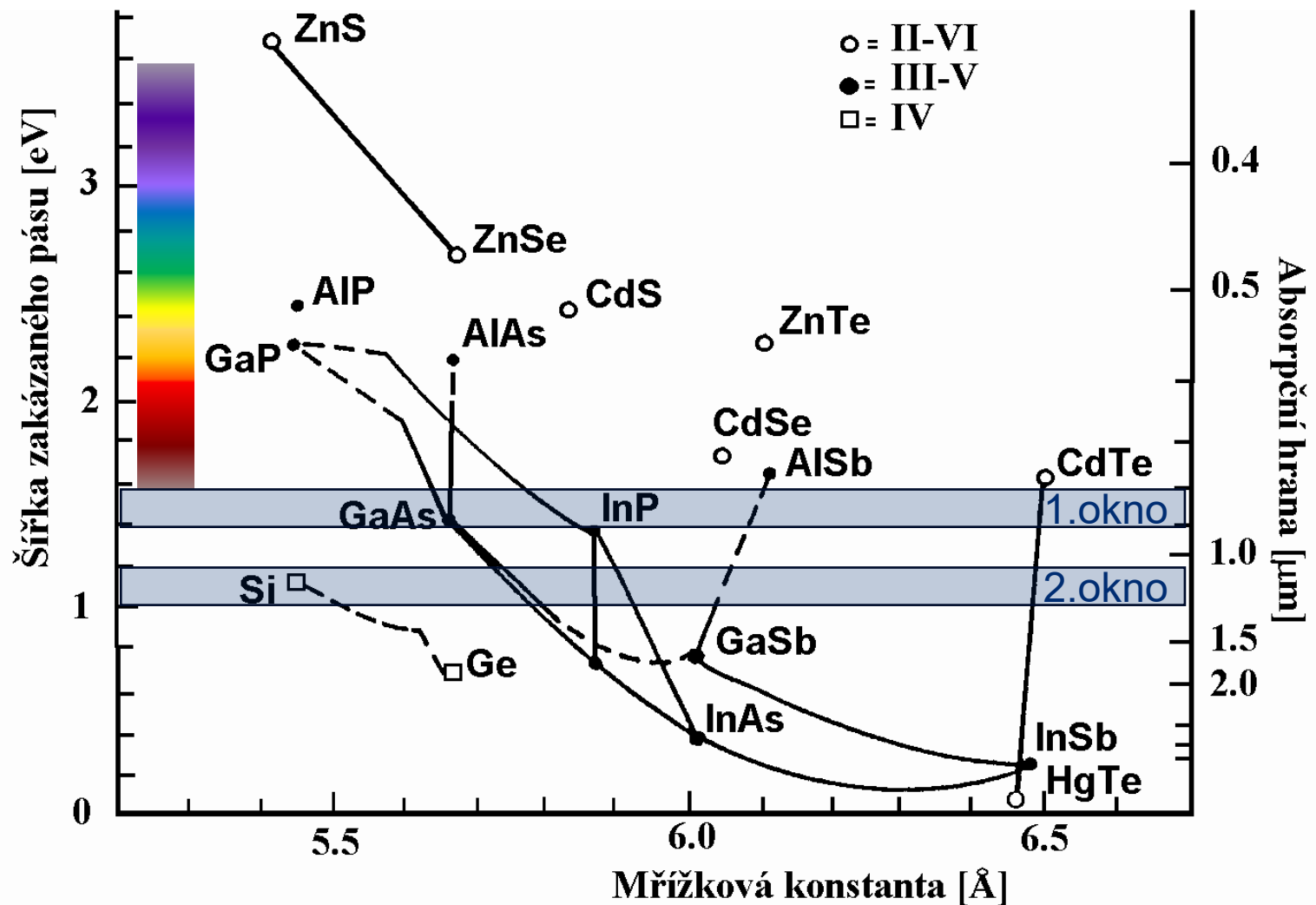
Three windows suitable for data transfer



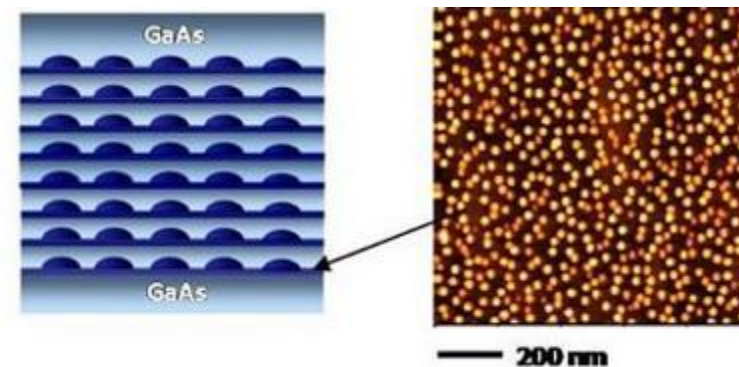
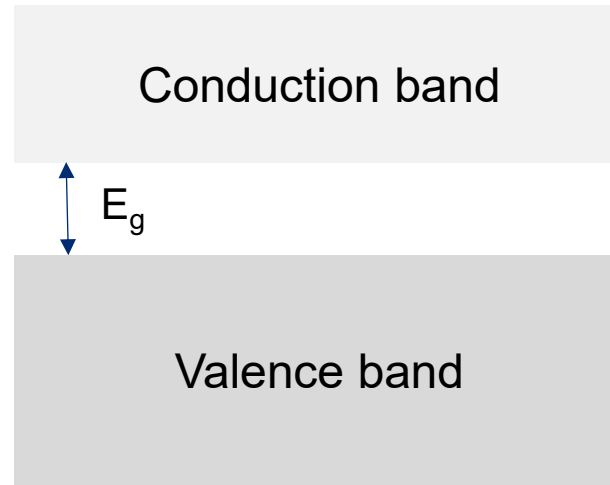
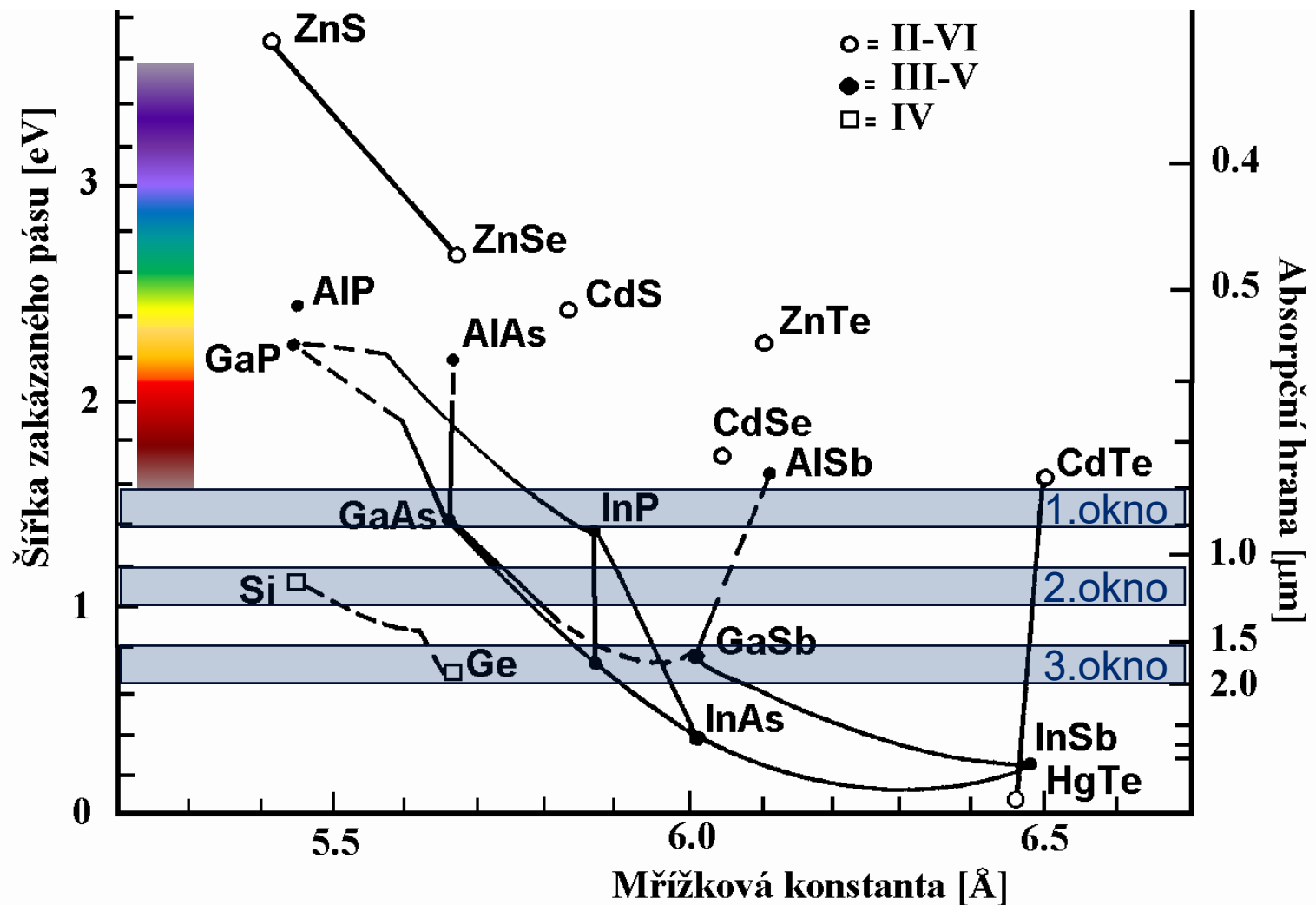
Different semiconductor structures suitable for 4 windows



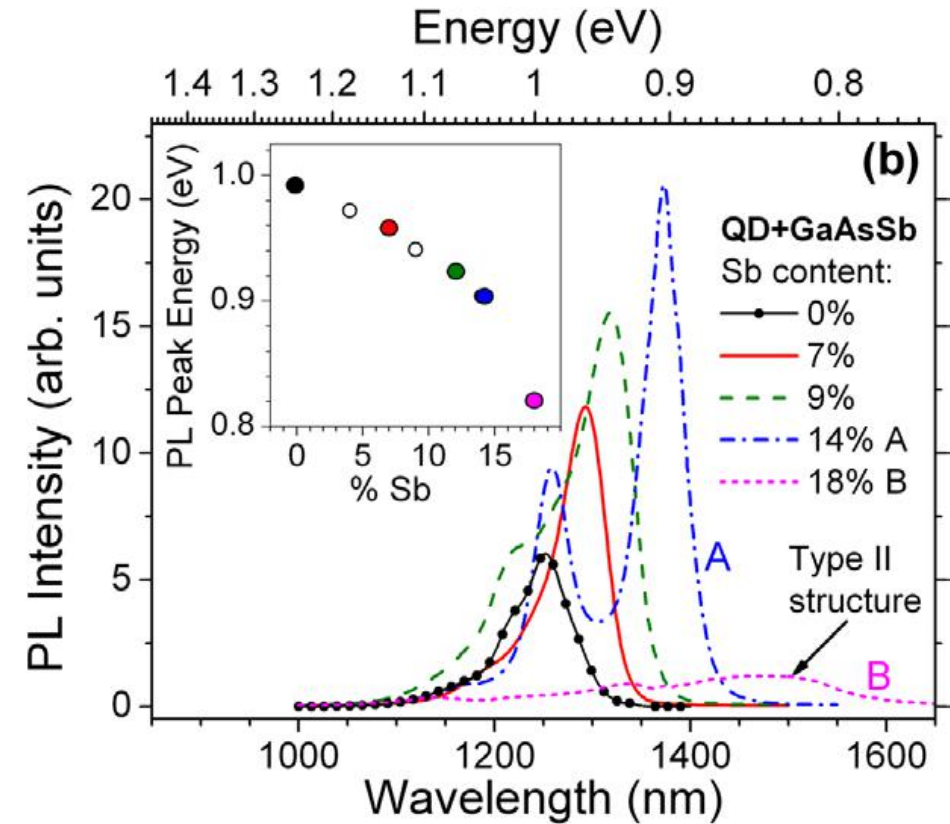
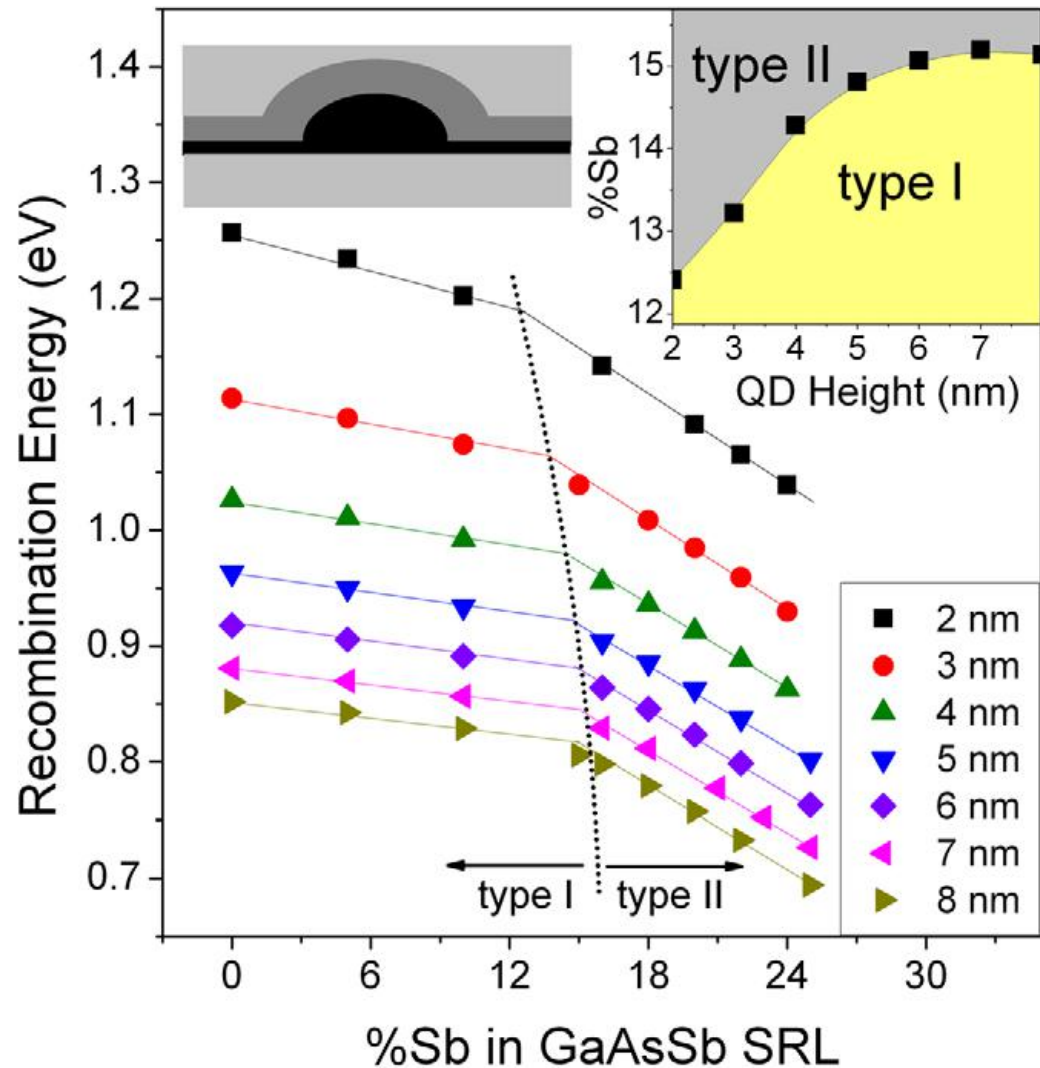
Different semiconductor structures suitable for 4 windows



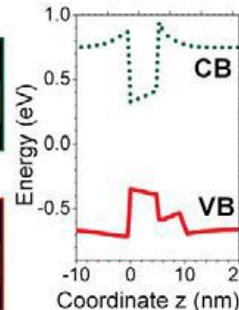
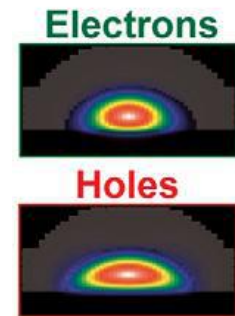
Different semiconductor structures suitable for 4 windows



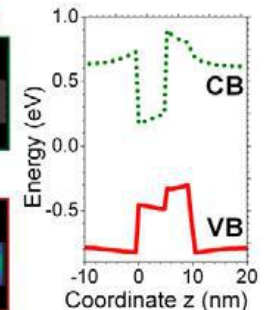
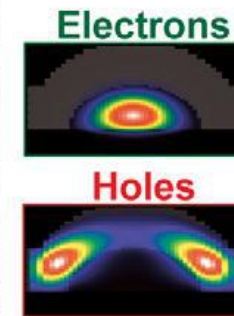
GaAsSb/InAs/GaAs QDs



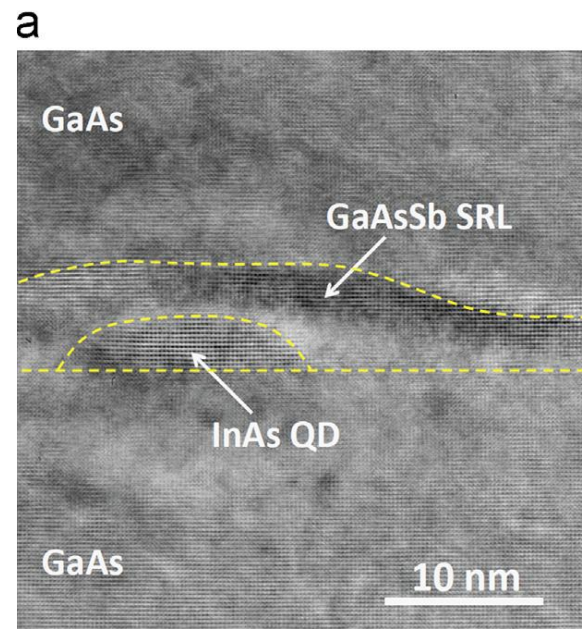
Type I heterojunction



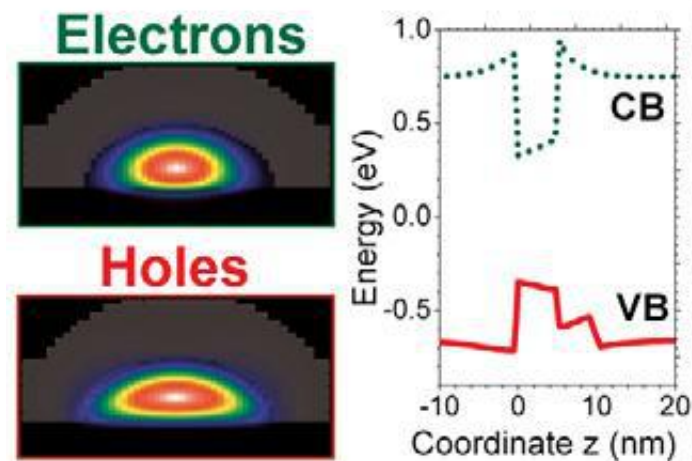
Type II heterojunction



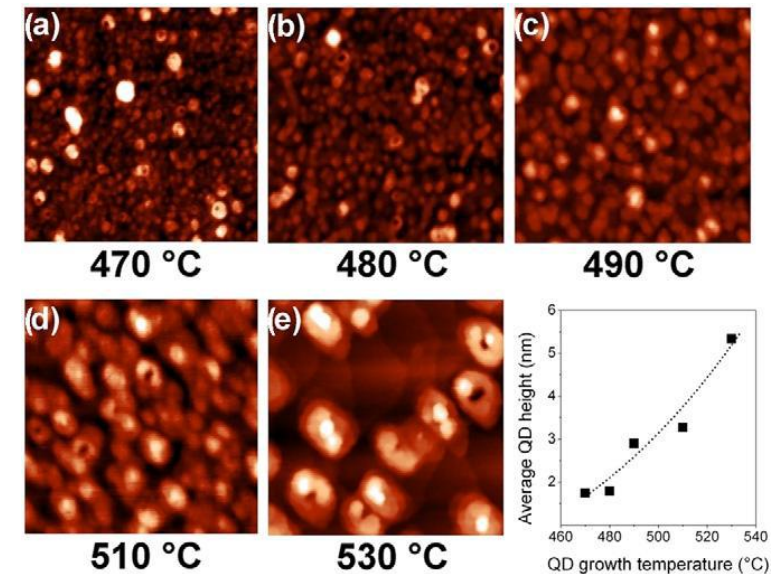
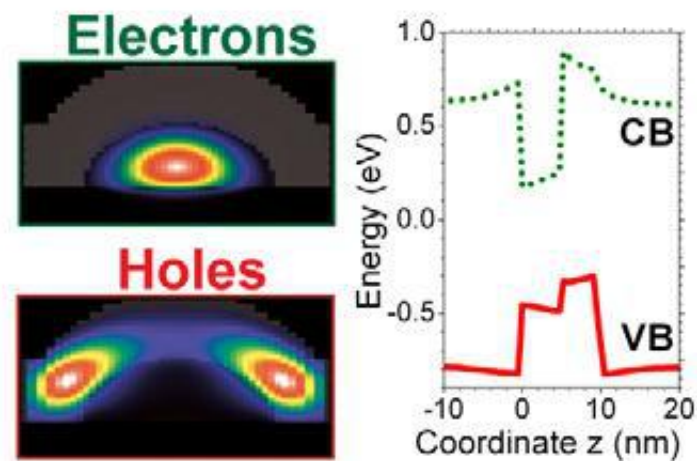
GaAsSb/InAs QDs



Type I heterojunction



Type II heterojunction



Summary

- Epitaxy of Heterostructures
- MOVPE – industrial epitaxy
- Reactor types: horizontal (planetary) and vertical (CCS)
- In situ monitoring (Reflectance, curvature, TT, RAS)
- GaN epitaxy challenges (substrates, doping, polarization)
- Nanoheterostructure for applications – QW, NR, QDs (in FZU)